

DLPC230-Q1 for light control applications

Programmer's Guide



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Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from May 25, 2018 to March 12, 2019 (from C Revision (May 2018) to D Revision) | Page |
|--|------|
| • Changed CRCZ_CHKSUM_SEL signal description. Starting in software v1.2.0.1 this signal now selects CRC or checksum for diagnostic control interface in addition to host interface. | 18 |
| • Changed flash program flow in <i>Flash Program - Boot Application</i> section | 53 |
| • Changed feature description in <i>Temperature Management</i> section | 58 |
| • Changed test configuration in <i>DMD Temperature Monitor</i> section..... | 84 |
| • Added command <i>Execution Delay - Write</i> | 120 |
| • Corrected equation in <i>TPS99000-Q1 TIA1 Dark Offsets - Write</i> section | 137 |
| • Added data types 0x40, 0x48, 0x50, 0x58 to Table 8-84 in <i>Flash Data Size - Read</i> section..... | 155 |
| • Changed command in <i>System Software Version - Read</i> section to include Branch field | 156 |
| • Added Error 34 to Table A-1 | 179 |
| • Added Error 201 to Table A-2 | 181 |

Introduction

1.1 Document Overview

This guide is intended for software programmers developing host software to control the DLP5531-Q1 chipset through the DLPC230-Q1 in light control applications such as high resolution headlight. It includes communication protocols, command descriptions, and DLPC230-Q1 hardware pins that relate to software functionality. Additional use-case information is provided to explain general command usage scenarios and how software settings can be modified to meet necessary product goals.

1.2 Software Overview

DLPC230-Q1 software is comprised of two components: a boot application and a main application. The purpose of the boot application is to load the main application from flash, verify its contents, and store it in DLPC230-Q1 internal memory at system startup. The boot application also allows programming of an empty or corrupted flash, during which the main application would not be available. The majority of system functionality resides in the main application. Both applications share a common hardware-supported SPI and I²C communication protocol to allow control from a host processor, but each application includes a different set of command definitions to support their functionality.

External SPI flash memory is used to configure all functions of the DLPC230-Q1 software. The flash data contains information including default settings, DMD sequencer instructions, splash image data, and batch command sets.

1.3 Headlight Overview

The following section describes the software-related components and interfaces of the headlight application of the DLP5531-Q1 chipset. More detail on the hardware interfaces can be found in the DLPC230-Q1 Data Sheet and TPS99000-Q1 Data Sheet.

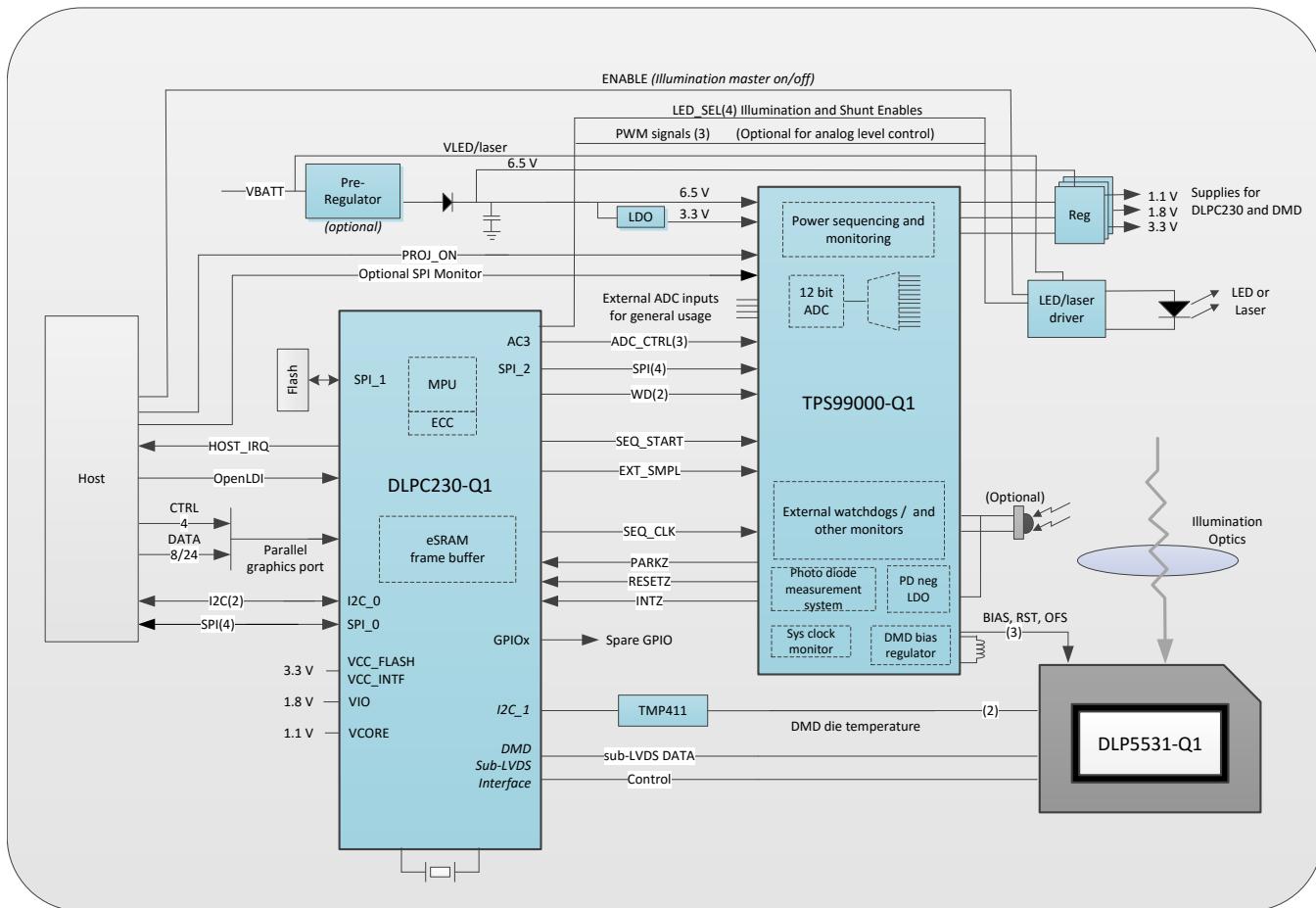


Figure 1-1. Headlight System Block Diagram

SPI DLPC230-Q1 Host Interface - An SPI communication interface that allows the host master to communicate with the DLPC230-Q1 using the commands described in this guide. If the I²C interface is used as the host interface, this interface will be configured as a read-only interface to a DLPC230-Q1 diagnostic memory for third-party verification of system data.

I²C DLPC230-Q1 Host Interface - An I²C communication interface that allows the host master to communicate with the DLPC230-Q1 using the commands described in this guide. If the SPI interface is used as the host interface, this interface will be configured as a read-only interface to a DLPC230-Q1 diagnostic memory for third-party verification of system data.

SPI DLPC230-Q1 to TPS99000-Q1 Interface - An SPI communication interface between the DLPC230-Q1 (master) and TPS99000-Q1 (slave). Note that the TPS99000-Q1 is not directly controlled by the host processor during operation.

SPI TPS99000-Q1 Host Interface - An SPI communication interface between the host (master) and TPS99000-Q1 (slave). This is a read-only interface to allow a host to confirm TPS99000-Q1 status during operation.

OpenLDI and Parallel Video Interfaces - Either OpenLDI or parallel video may be provided for video input. The DLPC230-Q1 Data Sheet defines supported resolutions and frame rates on these interfaces.

SPI Flash - Contains the main application software as well as all necessary data for the main application to operate. Programming the SPI flash is performed through DLPC230-Q1 commands sent to the DLPC230-Q1 boot application or main application.

TMP411 - Reads the DMD temperature from a temperature sensing diode built into the DMD. The DLPC230-Q1 continuously polls the TMP411 remote channel temperature during operation to take action to park the DMD at extreme temperatures. The DMD temperature may also be read from the DLPC230-Q1.

HOST_IRQ - An interrupt signal that alerts the host that an error caused the DLPC230-Q1 software to switch to Standby Mode and park the DMD. More information on this signal can be found in [Section 2.2.1](#).

PROJ_ON - Host-controlled reset signal for the entire chipset. More information on this signal can be found in the DLPC230-Q1 Data Sheet.

GPIO - The DLPC230-Q1 includes several unused GPIO that may be controlled by the host processor using SPI or I²C commands.

PWM - The DLPC230-Q1 includes three PWM channels that may be controlled by the host processor using SPI or I²C commands for various purposes such as illumination control.

Electrical Interface

2.1 Power-Up Signals

The DLPC230-Q1 includes hardware pins to modify software and hardware functionality. DLPC230-Q1 software reads the value of these pins during its startup procedure to configure communication interfaces and software startup behavior.

2.1.1 STAY-IN-BOOT (TSTPT_0)

The STAY-IN-BOOT signal is used by the boot application to determine whether the system should remain in boot execution or attempt to load and transition to the main application during power-up.

Remaining in the boot application may be desirable for re-programming the SPI flash, including the main application, if any system-level issue prevents re-programming during the execution of the main application.

Table 2-1. STAY-IN-BOOT Configuration

| VALUE AT SYSTEM POWER-UP | SYSTEM ACTION |
|--------------------------|---|
| 0 | Load main application from flash. Normal operation. |
| 1 | Stay in boot application and wait for command instructions. |

2.1.2 HOST_IF_SEL

The HOST_IF_SEL signal is used by the DLPC230-Q1 hardware during system power-up to determine which interface (SPI or I²C) is to be used for host control of the system. The interface that is not selected for host control will be configured as a diagnostic interface which can be used to read diagnostic memory information.

Table 2-2. HOST_IF_SEL Configuration

| VALUE AT SYSTEM POWER-UP | SYSTEM ACTION |
|--------------------------|---|
| 0 | SPI = Host Control Interface, I ² C = Diagnostic Interface |
| 1 | SPI = Diagnostic Interface, I ² C = Host Control Interface |

2.1.3 CRCZ_CHKSUM_SEL

The CRCZ_CHKSUM_SEL signal is used by the boot application during system power-up to determine whether the host will use an 8-bit CRC or 8-bit checksum to verify command transactions. The main application will also use this value during power-up to determine whether the diagnostic control interface will use an 8-bit CRC or 8-bit checksum.

Table 2-3. CRCZ_CHKSUM_SEL Configuration

| VALUE AT SYSTEM POWER-UP | SYSTEM ACTION |
|--------------------------|--|
| 0 | Host Control Interface uses CRC on all transactions Diagnostic Control Interface uses CRC on all transactions |
| 1 | Host Control Interface uses checksum on all transactions Diagnostic Control Interface uses checksum on all transactions |

2.1.4 HOST_SPI_MODE

The HOST-SPI-MODE signal is used by the boot application during system power-up to determine what SPI mode (clock polarity and phase) is to be used for Host SPI communications. After the value of this signal is read by the boot application, it is configured as an output and toggled during stages of software initialization for debug usage. This debug usage is described in [Section 2.1.4.1](#).

Table 2-4. HOST_SPI_MODE Configuration

| VALUE AT SYSTEM POWER-UP | SYSTEM ACTION |
|--------------------------|---------------------------------------|
| 0 | Host SPI port may use SPI mode 0 or 3 |
| 1 | Host SPI port may use SPI mode 1 or 2 |

The SPI modes are defined in [Table 2-5](#).

Table 2-5. SPI Mode Definitions

| MODE | CLOCK POLARITY | CLOCK PHASE |
|------|----------------|-------------|
| 0 | 0 | 0 |
| 1 | 0 | 1 |
| 2 | 1 | 0 |
| 3 | 1 | 1 |

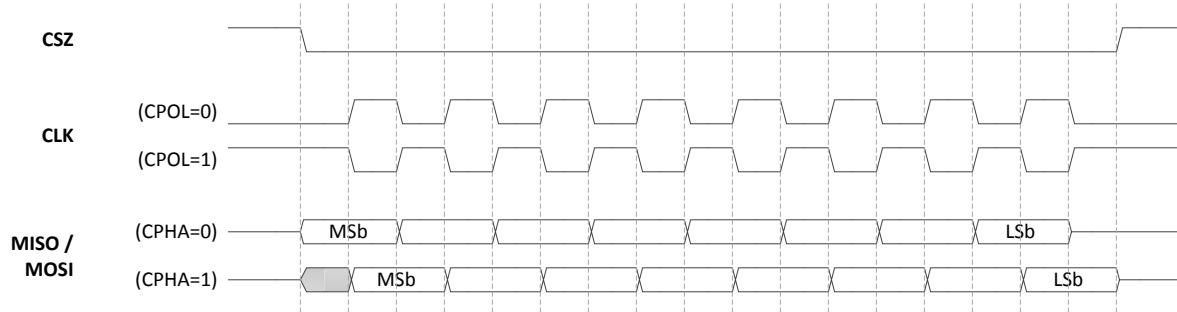


Figure 2-1. SPI Mode Timing

2.1.4.1 Boot Flow Debug

HOST_SPI_MODE is configured as an output and toggled during DLPC230-Q1 software initialization to aid in debug. This begins immediately after the value is read as an input. Figure 2-2 shows the initialization events and the associated HOST_SPI_MODE signal. A toggle will occur for optional events regardless of whether they are enabled or disabled so that events following can still be properly identified.

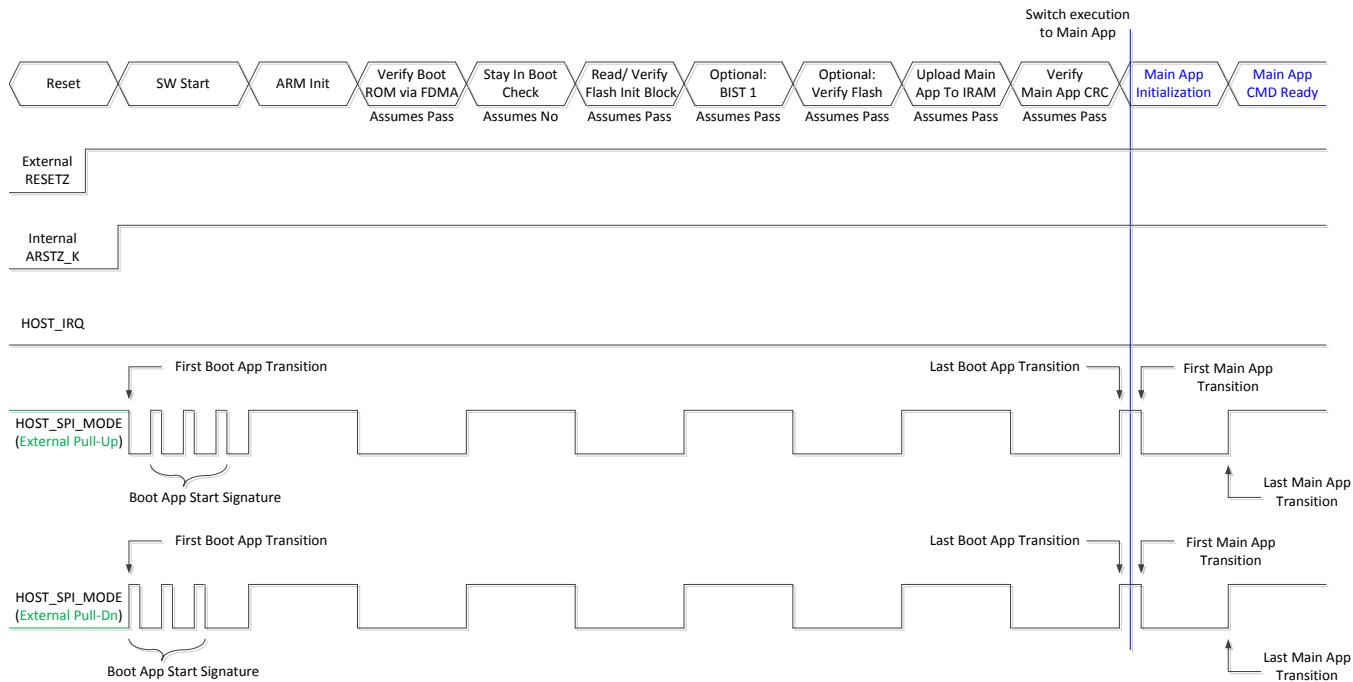


Figure 2-2. Boot Flow Debug

The tests are described in [Section 6.4.2](#). BIST 1 is the DLPC230-Q1 Command and Flash Interface Memory Test.

2.1.5 SPREAD-SPECTRUM-DISABLE (TSTPT_5)

SPREAD-SPECTRUM-DISABLE is controlled by the state of the TSTPT_5 DLPC230-Q1 pin. This can be considered a hardware override of the spread spectrum function. If this is set HIGH, the spread spectrum settings will be read from flash memory. If this is set LOW, the spread spectrum settings will be ignored and spread spectrum will always remain disabled.

Note that a HIGH on this signal does not necessarily enable spread spectrum since the flash settings can also disable it.

Table 2-6. SPREAD-SPECTRUM-DISABLE Configuration

| VALUE AT SYSTEM POWER-UP | SYSTEM ACTION |
|--------------------------|---|
| 0 | Spread spectrum disabled |
| 1 | Software will read spread spectrum settings from flash memory |

2.2 System Signals

This section describes hardware signals related to software operation.

2.2.1 HOST_IRQ

The HOST_IRQ signal is an interrupt from the DLPC230-Q1 that is used to notify the host that a serious system error has occurred. This would generally result in an emergency shutdown. The HOST_IRQ signal will be set HIGH in this situation. Additional information on emergency shutdown can be found in [Section 6.2](#).

2.2.2 GPIO

The DLPC230-Q1 has 32 GPIO. Some of these GPIO are reserved per product configuration, but the non-reserved pins are available for the host to control based on system needs. The reserved and available GPIO per product are described in the DLPC230-Q1 Data Sheet.

The following commands are used for GPIO control:

- [GPIO Configure - Write](#) - Configures each GPIO pin as an input or output.
- [GPIO Configure - Read](#) - Returns whether each GPIO is set as an input, output, or alternate function.
- [GPIO Outputs - Write](#) - Sets the value of each GPIO.
- [GPIO Outputs - Read](#) - Reads the value of each GPIO.
- [GPIO Reserved - Read](#) - Returns whether each GPIO is reserved or available for host use.

During development, the reserved GPIO can be determined by reading the [GPIO Reserved](#) command. The available GPIO can be configured as inputs or outputs through flash configuration or by sending the [GPIO Configure](#) command.

The [GPIO Outputs](#) command should be sent to change the HIGH/LOW state of any GPIOs during system operation. This command includes mask bits for each GPIO so that only the desired GPIO values will be set.

2.2.3 PWM Control

The DLPC230-Q1 includes 3 general purpose PWM signals for use in headlight applications. Example use-cases include illumination magnitude control or thermo-electric cooler control.

These PWM signals operate at 136.7kHz. The duty cycle of each PWM signal can be controlled using the [PWM Control](#) command.

Communication Protocol

3.1 Command Protocol

The DLPC230-Q1 may be controlled by a host processor using either SPI or I²C. The general command structure is identical for either communication type. The following sections provide an overview of the command protocol and byte diagrams for read and write commands.

Each command transaction is bounded by an SPI chip select or I²C Start/Stop condition.

The transmitted command data includes a command op-code, a command tag, the payload length, the payload data, and a CRC or checksum byte. The tag and CRC/checksum are used for error checking on the communication interface for added robustness.

- The command tag is a unique value that can be traced through system execution in the Short Status and Error History to determine whether the command was successful or whether any errors occurred. More information on command tags can be found in [Section 3.7](#).
- The CRC or checksum byte ensures integrity of the data being transmitted in case of electrical noise on the data lines or other byte-level corruption.

The received command data includes the repeated command op-code, repeated command tag, the return payload length, the return payload data, and a CRC or checksum for the returned bytes.

The state of the external signal [CRCZ-CHKSUM-SEL](#) at system initialization will dictate whether commands require a CRC or checksum of the payload data.

3.2 SPI Specifications

The SPI signal specifications are as follows:

Table 3-1. SPI Configuration

| PARAMETER | VALUE |
|---------------------------------|---|
| Clock Frequency | 10 MHz maximum |
| Mode (Clock Phase and Polarity) | All 4 combinations of clock phase and polarity are supported. The external signal HOST-SPI-MODE must be configured properly at startup to set the desired mode. |
| Data Word Length | 8-bit |
| Bit Order | Most significant bit first within a byte |
| Byte Order | Least significant byte first |
| Chip Select Polarity | Active low |
| Dummy Byte | From master: 0x00. From slave: 0xFF |

3.3 I²C Specifications

The I²C signal specifications are as follows:

Table 3-2. I²C Configuration

| PARAMETER | VALUE |
|---|--|
| Clock Frequency | 100 kHz, 400 kHz (Fast Mode) |
| Device Address (Slave address and write/read bit) | 36/37h |
| Data Word Length | 8-bit |
| Bit Order | Most significant bit first within a byte |
| Byte Order | Least significant byte first |

3.4 Write

There are two types of write transaction protocols: a short write and a bulk write. The short write is used for data payloads of 64 bytes or less. This is used for almost all boot and main application commands. The bulk write is used for data payloads of 65 bytes to 256 bytes. Bulk write is only used for programming flash data.

[Section 3.4.3](#) defines a command handling flow for writing any data to the DLPC230-Q1.

3.4.1 Short Write

The Short Write protocol is used for write commands with a data payload of 64 bytes or less. Typical operating commands use this protocol.

3.4.1.1 SPI Short Write

[Table 3-3](#), [Table 3-4](#), and [Figure 3-1](#) describe the SPI short write protocol.

MOSI (Master Output, Slave Input):

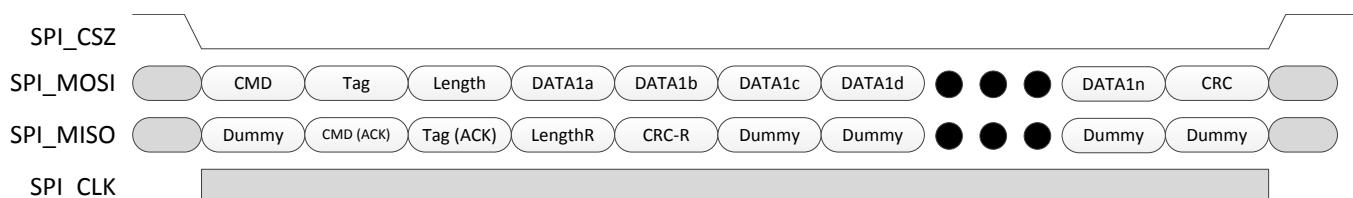
Table 3-3. SPI Short Write MOSI Bytes

| DATA BYTE | DESCRIPTION |
|------------|--|
| CMD | 1-byte write command op-code |
| Tag | 1-byte identifier used to uniquely mark each command sent by host. |
| Length | Length of the payload data. |
| Data1(a:n) | Payload data to be sent. Length and content varies based on the command op-code, up to 64 bytes. |
| CRC | CRC or checksum for the write bytes. This value must cover all bytes including op-code, tag, length, and data bytes. |

MISO (Master Input, Slave Output):

Table 3-4. SPI Short Write MISO Bytes

| DATA BYTE | DESCRIPTION |
|-----------|---|
| CMD (ACK) | Echo of the received command op-code from the master. |
| Tag (ACK) | Echo of the received tag from the master. |
| LengthR | Length of the return data. This is always zero for a short write. |
| CRC-R | CRC or checksum for the response bytes. This value covers op-code, tag, and length. |


Figure 3-1. SPI Short Write

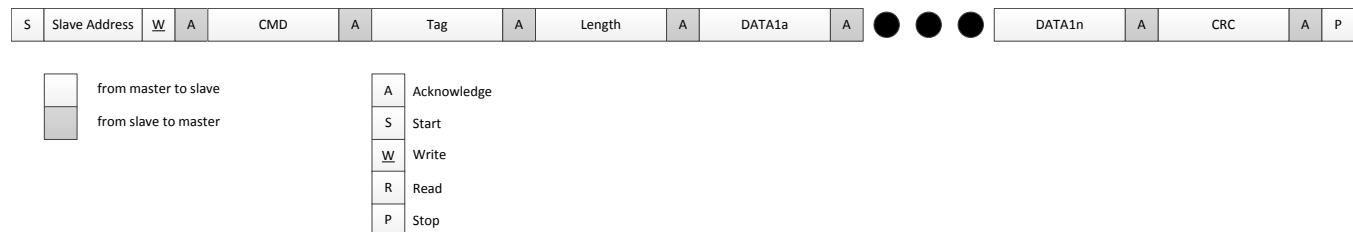
3.4.1.2 I²C Short Write

Table 3-5 and Figure 3-2 describe the I²C short write protocol.

Data:

Table 3-5. I²C Short Write Bytes

| DATA BYTE | DESCRIPTION |
|------------|--|
| CMD | 1-byte write command op-code |
| Tag | 1-byte identifier used to uniquely mark each command sent by host. |
| Length | Length of the payload data. |
| Data1(a:n) | Payload data to be sent. Length and content varies based on the command op-code, up to 64 bytes. |
| CRC | CRC or checksum for the write bytes. This value must cover all bytes including op-code, tag, length, and data bytes. |


Figure 3-2. I²C Short Write

3.4.2 Bulk Write

The “Bulk Write” protocol is used for write commands with a data payload greater than 64 bytes up to and including 256 bytes.

3.4.2.1 SPI Bulk Write

[Table 3-6](#), [Table 3-7](#), and [Figure 3-3](#) describe the SPI bulk write protocol.

MOSI (Master Output, Slave Input):

Table 3-6. SPI Bulk Write MOSI Bytes

| DATA BYTE | DESCRIPTION |
|------------|--|
| CMD | 1-byte write command op-code |
| Tag | 1-byte identifier used to uniquely mark each command sent by host. |
| Length | Length of the bulk header data (Data 1a, Data 1b). This is always 2 for a bulk write. |
| Data1(a:b) | Bulk header data. The value specifies the length of the bulk payload (1-256 bytes). LSByte = "a". |
| CRC1 | CRC or checksum for the write header. Includes op-code, tag, length, and header data bytes. |
| Data2(a:n) | Bulk write payload data. The number of bytes will vary, and should match the value stored in Data1(a:b). |
| CRC2 | CRC or checksum for the bulk payload. This only includes the bulk payload (Data2). |

MISO (Master Input, Slave Output):

Table 3-7. SPI Bulk Write MISO Bytes

| DATA BYTE | DESCRIPTION |
|-----------|---|
| CMD (ACK) | Echo of the received command op-code from the master. |
| Tag (ACK) | Echo of the received tag from the master. |
| LengthR | Length of the return data. This is always zero for a bulk write. |
| CRC-R | CRC or checksum for the response bytes. This value covers op-code, tag, and length. |

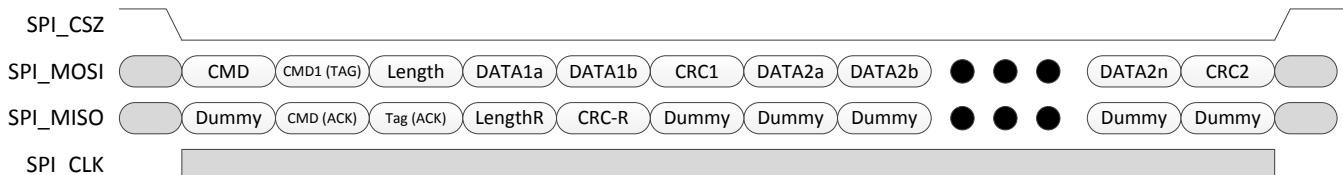


Figure 3-3. SPI Bulk Write

3.4.2.2 I²C Bulk Write

Table 3-8 and Figure 3-4 describe the I²C bulk write protocol.

Data:

Table 3-8. I²C Bulk Write Bytes

| DATA BYTE | DESCRIPTION |
|------------|--|
| CMD | 1-byte write command op-code |
| Tag | 1-byte identifier used to uniquely mark each command sent by host. |
| Length | Length of the bulk header data (Data 1a, Data 1b). This is always 2 for a bulk write. |
| Data1(a:b) | Bulk header data. The value specifies the length of the bulk payload (1-256 bytes). |
| CRC1 | CRC or checksum for the write header. Includes op-code, tag, length, and header data bytes (Data1). |
| Data2(a:n) | Bulk write payload data. The number of bytes will vary, and should match the value stored in Data1(a:b). |
| CRC2 | CRC or checksum for the bulk payload. This only includes the bulk payload (Data2). |

| | | | | | | | | | | | | | | | | |
|---|---------------|----------|---|-----|---|-----|---|--------|---|--------|---|--------|---|------|---|--------------------------|
| S | Slave Address | <u>W</u> | A | CMD | A | Tag | A | Length | A | DATA1a | A | DATA1b | A | CRC1 | A | (continued on next line) |
|---|---------------|----------|---|-----|---|-----|---|--------|---|--------|---|--------|---|------|---|--------------------------|

| | | | | | | | | | |
|--------------------------------|--------|---|--------|---|--------|---|------|---|---|
| (continued from previous line) | DATA2a | A | DATA2b | A | DATA2n | A | CRC2 | A | P |
|--------------------------------|--------|---|--------|---|--------|---|------|---|---|

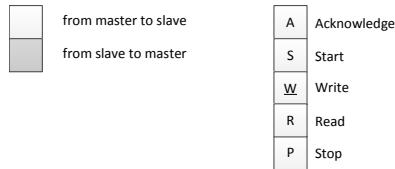


Figure 3-4. I²C Bulk Write

3.4.3 Write Command Handling

A write command handler must check the *Short Status* to ensure that the system is no longer busy from prior transactions and to check whether any errors have occurred. Errors could be related to the current command transaction or other background system processes. [Figure 3-5](#) describes the flow of a command handler for any write command using either short or bulk write protocols.

More detail on the Short Status can be found in [Section 8.2.80](#) (Main Application) and [Section 7.2.6](#) (Boot Application). This command handler flow is valid for both applications.

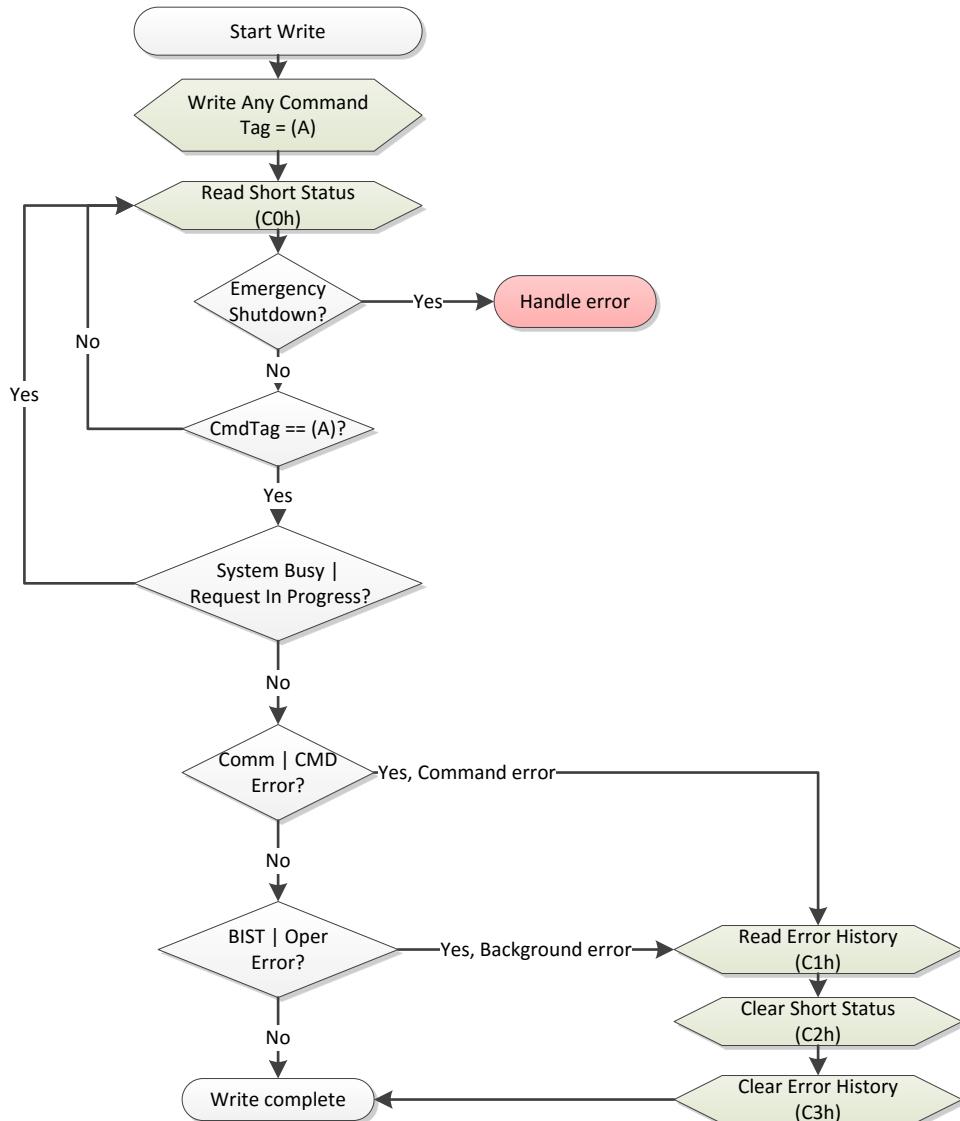


Figure 3-5. Write Command Handler

- **Write Any Command** - Write the desired command using the [Short Write Protocol](#) or [Bulk Write Protocol](#) as required for the specific command. Record the tag that was selected for this command (A).
- **Read Short Status** - Read the Short Status using the [Short Status Read Protocol](#).
- **Emergency Shutdown?** - This Short Status bit indicates whether an emergency shutdown condition occurred. If this occurs, command handling should cease in order to handle the emergency shutdown. The *HOST_IRQ* signal will also trigger if this occurs. Refer to [Section 6.2](#) for more information on emergency shutdown.

- **CmdTag == (A)?** - Check whether the Short Status contains the tag that was sent with the write command. This indicates that the command was executed by the software, regardless of whether it was successful or not. If this does not match the desired tag (A), continue polling the Short Status until the tag matches.
- **System Busy | Request In Progress?** - Check whether the *System Busy* or *Request In Progress* Short Status bits are set. If these are set, the system is still working on the write command and new commands should not be sent. If one of these bits is set, continue polling the Short Status until both are cleared.
- **COMM | CMD Error?** - Check for *Communication Error* or *Command Error* Short Status bits. If either are set, the write command has failed. In this situation, the [Error History](#) should be read to determine the specific error details. Once the Error History is read, the Error History and Short Status should be cleared of previous errors prior to the next transaction. The host can then determine what action to take such as re-sending the command or restarting the system.
- **BIST | Oper Error?** - Check for *BIST Error* or *Operational Error* Short Status bits. If either bit is set, a background process has encountered an error. If either error bit is set without the CMD error bit being set, the error is not related to the current command transaction. An example of this is a temperature sensor failure during regular main application polling. In this situation, the Error History should still be read to determine the cause of the error, but it does not mean that the current write command transaction has failed.

Note that only *Command Error* and *Communication Error* Short Status bits should be considered a command failure. If *BIST Error* or *Operational Error* bits are set without Command or Communication error bits, another process received an error but the command was still completed.

3.5 Read

Reading data is accomplished using two primary transactions: a *Read Pre-Fetch* command and a *Read Activate* command. The reason for this two-command read is to prevent the host from being tied to command execution. The host can request data, handle other processes while DLPC230-Q1 embedded software executes the request, and later read the requested data. [Section 3.5.4](#) defines a command handling flow for reading any data from the DLPC230-Q1 using these two transactions and the Short Status.

3.5.1 Read Pre-Fetch

Read Pre-Fetch is a Short Write command used to request a read of a specific command op-code. A successful write of *Read Pre-Fetch* will initiate the read data process. The transmitted data payload is the desired read command op-code and its associated command parameters. The command parameters vary per command and are described in [Section 7.2](#) (Boot Application) and [Section 8.2](#) (Main Application). No read payload is received from this read pre-fetch step.

3.5.1.1 SPI Read Pre-Fetch

[Figure 3-6](#) describes the SPI Read Pre-Fetch protocol.

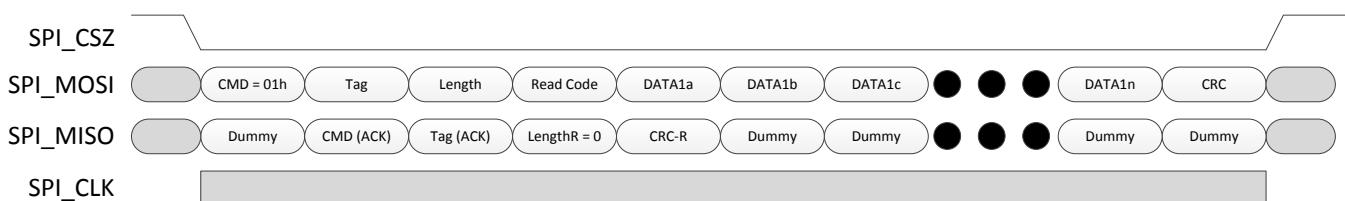


Figure 3-6. SPI Read Pre-Fetch

3.5.1.2 I²C Read Pre-Fetch

[Figure 3-7](#) describes the I²C Read Pre-Fetch protocol.

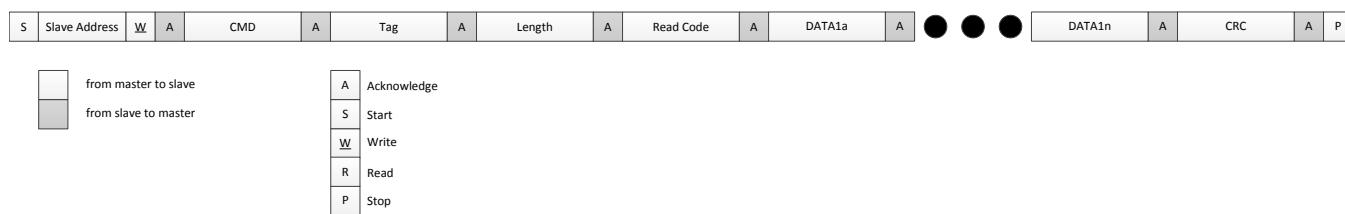


Figure 3-7. I²C Read Pre-Fetch

3.5.2 Read Activate

The *Read Activate* command reads the data that was requested by the *Read Pre-Fetch* command. The same op-code is used regardless of the data that is being read, but the read data length will vary depending on the requested data.

3.5.2.1 SPI Read Activate

[Table 3-9](#), [Table 3-10](#), and [Figure 3-8](#) describe the SPI Read Activate protocol.

MOSI (Master Output, Slave Input):

Table 3-9. SPI Read Activate MOSI Bytes

| DATA BYTE | DESCRIPTION |
|-----------|---|
| CMD | 1-byte write command op-code. This is 02h for Read Activate. |
| Tag | 1-byte identifier used to uniquely mark each command sent by host. |
| Length | Length of the transmitted data payload. This is always 0 for read activate. |
| CRC | CRC or checksum for the read header data. This includes the op-code, tag, and length. |

MISO (Master Input, Slave Output):

Table 3-10. SPI Read Activate MISO Bytes

| DATA BYTE | DESCRIPTION |
|------------|---|
| CMD (ACK) | Echo of the received command op-code from the master. |
| Tag (ACK) | Echo of the received tag from the master. |
| LengthR | Length of the read header data (Data1a, Data1b). The value is always 2 for read activate. |
| Data1(a:b) | Read header data. Specifies the length of the read return payload (0-256 bytes). LSByte = "a". |
| CRC-R1 | CRC or checksum for the header response bytes. This includes the op-code, tag, length, and read return header data (Data1). |
| Data2(a:n) | Read return payload. The number of bytes varies depending on the read command and is specified by the value in Data1(a:b). |
| CRC-R2 | CRC or checksum for the read return payload. This only includes the read return payload (Data2) bytes. |

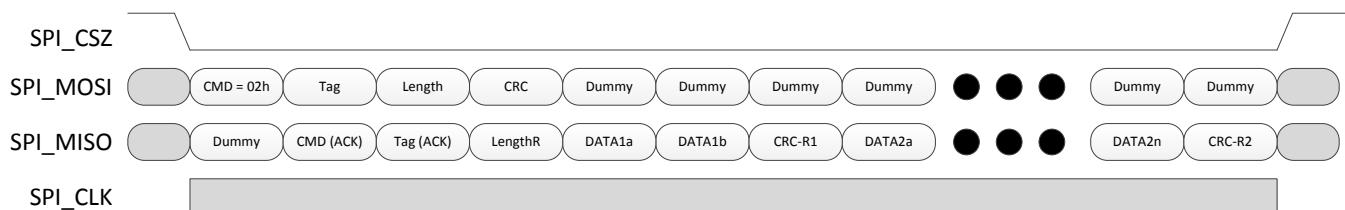


Figure 3-8. SPI Read Activate

3.5.2.2 I²C Read Activate

[Table 3-11](#), [Table 3-12](#), and [Figure 3-9](#) describe the I²C Read Activate protocol.

Data Write:

Table 3-11. I²C Read Activate Write Bytes

| DATA BYTE | DESCRIPTION |
|-----------|---|
| CMD | 1-byte write command op-code |
| Tag | 1-byte identifier used to uniquely mark each command sent by host. |
| Length | Length of the transmitted data payload. This is always 0 for read activate. |
| CRC | CRC or checksum for the read header data. This includes the op-code, tag, and length. |

Data Read:

Table 3-12. I²C Read Activate Read Bytes

| DATA BYTE | DESCRIPTION |
|------------|--|
| CMD (ACK) | Echo of the received op-code from the master. |
| Tag (ACK) | Echo of the received tag from the master. |
| LengthR1 | Length of the read header data (Data1a, Data1b). This is always 2 for read activate. |
| Data1(a:b) | Read header data. Specifies the length of the read return payload (0-256 bytes). |
| CRC-R1 | CRC or checksum for the read header data. This includes the op-code, tag, length, and read return header data (Data1). |
| Data2(a:n) | Read return payload. |
| CRC-R2 | CRC or checksum for the read return payload. This only includes the read return payload (Data2). |

S Slave Address W A CMD A Tag A Length A CRC A P S Sr Slave Address R A CMD (ACK) A Tag (ACK) A LengthR A (continued on next line)

(continued from previous line) DATA1a A DATA1b A CRC-R1 A DATA2a A ● ● ● DATA2n A CRC-R2 A P

from master to slave
from slave to master

| | |
|---|-------------|
| A | Acknowledge |
| S | Start |
| W | Write |
| R | Read |
| P | Stop |

Sr Repeated Start

Figure 3-9. I²C Read Activate

3.5.3 Short Status Read

Short Status is a unique read transaction that is hardware supported and does not require embedded software intervention. This means that the status data can be received in one transaction in a fixed amount of time unlike typical read transactions which require two transactions. More details about the contents of the *Short Status* can be found in [Section 8.2.80](#) (Main Application) and [Section 7.2.6](#) (Boot Application). The protocol is similar to a *Read Activate* command, and is shown in [Section 3.5.3.1](#):

3.5.3.1 SPI Short Status Read

[Table 3-13](#), [Table 3-14](#), and [Figure 3-10](#) describe the SPI Short Status read protocol.

MOSI (Master Output, Slave Input):

Table 3-13. SPI Short Status MOSI Bytes

| DATA BYTE | DESCRIPTION |
|-----------|---|
| CMD1 | 1-byte write command op-code. This is C0h for Short Status. |
| Tag | 1-byte identifier used to uniquely mark each command sent by host. |
| Length1 | Length of the transmitted data payload. This is always 0 for short status. |
| CRC1 | CRC or checksum for the read header data. This includes the op-code, tag, and length. |

MISO (Master Input, Slave Output):

Table 3-14. SPI Short Status MISO Bytes

| DATA BYTE | DESCRIPTION |
|------------|--|
| CMD1 | Echo of the received command op-code from the master. |
| Tag | Echo of the received tag from the master. |
| LengthR1 | Length of the short status. The value is always 4 bytes. |
| Data1(a:d) | Short status data. This data is defined in Section 8.2.80 (Main Application) and Section 7.2.6 (Boot Application). |
| CRC-R1 | CRC or checksum for the read data. This includes the op-code, tag, length, and short status data. |

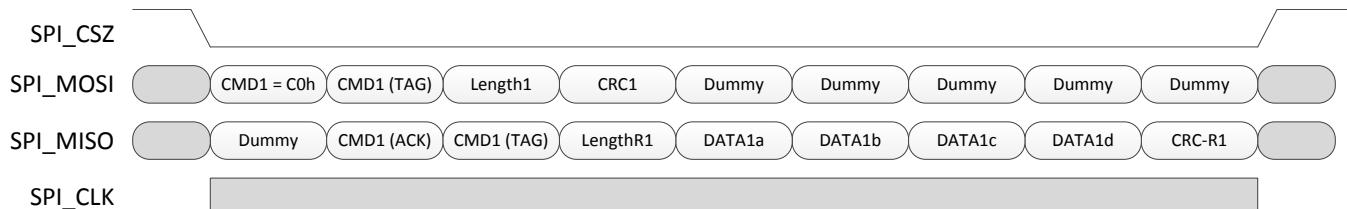


Figure 3-10. SPI Short Status

3.5.3.2 I²C Short Status Read

[Table 3-15](#), [Table 3-16](#), and [Figure 3-11](#) describe the I²C Short Status Read protocol.

Data Write:

Table 3-15. I²C Short Status Write Bytes

| DATA BYTE | DESCRIPTION |
|-----------|---|
| CMD | 1-byte write command op-code. This is C0h for Short Status. |
| Tag | 1-byte identifier used to uniquely mark each command sent by host. |
| Length | Length of the transmitted data payload. This is always 0 for Short Status. |
| CRC | CRC or checksum for the read header data. This includes the op-code, tag, and length. |

Data Read:

Table 3-16. I²C Short Status Read Bytes

| DATA BYTE | DESCRIPTION |
|------------|--|
| CMD (ACK) | Echo of the received op-code from the master. |
| Tag (ACK) | Echo of the received tag from the master. |
| LengthR | Length of the short status data. (Data1a, Data1b). This is always 4 for Short Status. |
| Data1(a:d) | Short Status data. This data is defined in Section 8.2.80 (Main Application) and Section 7.2.6 (Boot Application). |
| CRC-R | CRC or checksum for the read header data. This includes the op-code, tag, length, and Short Status data. |

S Slave Address | W A CMD = C0h | A Tag | A Length = 0 | A CRC | A P S Sr Slave Address | R A CMD (ACK) | A Tag (ACK) | A LengthR = 4 | A (continued on next line)

(continued from previous line) DATA1a | A | DATA1b | A | DATA1c | A | DATA1d | A | CRC-R | A

from master to slave
from slave to master

| | |
|----|----------------|
| A | Acknowledge |
| S | Start |
| W | Write |
| R | Read |
| P | Stop |
| Sr | Repeated Start |

Figure 3-11. I²C Short Status

3.5.4 Read Command Handling

A read command handler must check the *Short Status* to determine whether read data is available and to check whether any errors have occurred. Errors could be related to the current command transaction or other background software processes. [Figure 3-12](#) describes the flow of a command handler for read commands.

More detail on the Short Status can be found in [Section 8.2.80](#) (Main Application) and [Section 7.2.6](#) (Boot Application). This command handler flow is valid for both applications.

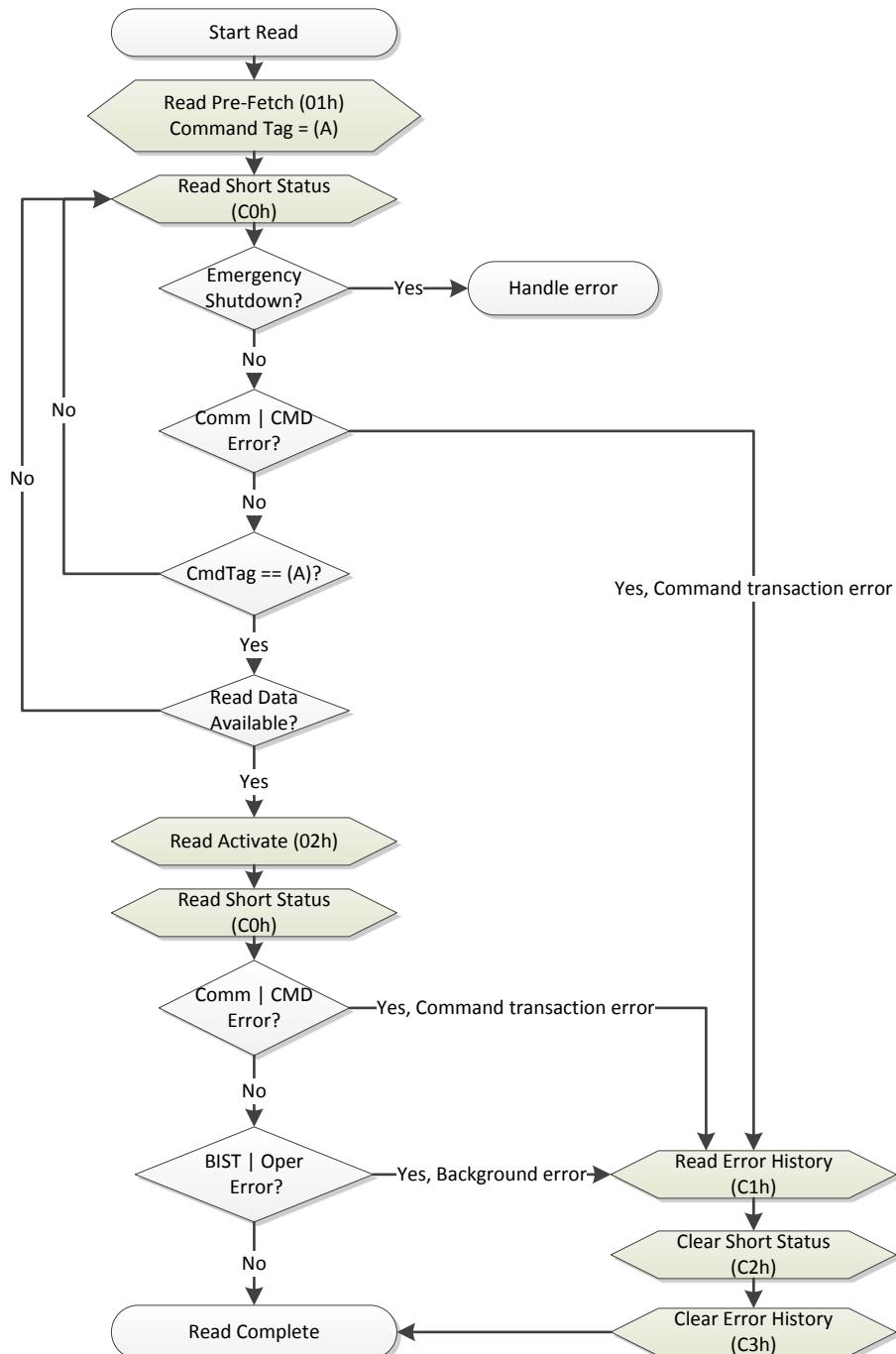


Figure 3-12. Read Command Handler

- **Read Pre-Fetch** - Send a read command op-code and its associated command parameters using the [Read Pre-Fetch Protocol](#). Record the tag that was selected for this command (A).
- **Read Short Status** - Read the Short Status using the [Short Status Read Protocol](#).
- **Emergency Shutdown?** - This Short Status bit indicates whether an emergency shutdown condition occurred. If this occurs, command handling should cease in order to handle the emergency shutdown. The *HOST_IRQ* signal will also trigger if this occurs. Refer to [Section 6.2](#) for more information on emergency shutdown.
- **COMM | CMD Error?** - Check for *Communication Error* or *Command Error* Short Status bits. If either are set, the Read Pre-Fetch command has failed. In this situation, the [Error History](#) should be read to determine the specific error details. Once the Error History is read, the Error History and Short Status should be cleared of previous errors prior to the next transaction. The host can then determine what action to take such as re-sending the Read Pre-Fetch command or restarting the system.
- **CmdTag == (A)?** - Check whether the Short Status contains the tag that was sent with the Read Pre-Fetch command. This indicates that the Read Pre-Fetch was executed by software. If this does not match the desired tag (A), continue polling the Short Status until the tag matches.
- **Read Data Available?** - Check whether the *Read Data Available* bit is set in Short Status. If it is set, the requested read data is available. If it is not set, continue polling the Short Status.
- **Read Activate** - Once the read data is available, a Read Activate command may be used to read the requested data using the [Read Activate Protocol](#).
- **Read Short Status** - Read the Short Status using the [Short Status Read Protocol](#) to check for any errors after the Read Activate.
- **COMM | CMD Error?** - Check for *Communication Error* or *Command Error* Short Status bits. If either are set, the read activate command has failed. In this situation, the Error History should be read to determine the specific error details.
- **BIST | Oper Error?** - Check for *BIST Error* or *Operational Error* Short Status bits. If either bit is set, a background process encountered an error. If these error bits are set without the CMD error bit being set, the error is not related to the current command transaction. An example of this is a temperature sensor failure during regular main application polling. In this situation, the Error History should still be read to determine the cause of the error, but it does not mean that the current read command transaction has failed.

Note that only *Command Error* and *Communication Error* Short Status bits should be considered a command failure. If *BIST Error* or *Operational Error* bits are set without Command or Communication error bits, another process received an error but the command still completed.

3.6 CRC and Checksum

The usage of CRC or checksum can be selected at startup based on the state of the external DLPC230-Q1 signal, [CRCZ_CHKSUM_SEL](#).

3.6.1 CRC Calculation

The CRC uses CRC-8 CCITT which has the following implementation:

- Polynomial $x^8 + x^2 + x + 1$ (normal polynomial representation = 0x07)
- Initial value is 0xFF

3.6.1.1 CRC Example Implementation

The following pseudo-code demonstrates one possible method for implementing the CRC calculation.

" \wedge " represents bitwise exclusive OR operator.

"IN" is the data byte that is being included in the CRC.

"CRC" is the CRC byte that is being calculated.

```
CRC(0)(7:0)=0xFF; # Initial seed value is 0xFF.
FOR x=1 to N; # Loop through all "N" data bytes that are included in the CRC.
  CRC(x)(0)=IN(x)(0)^IN(x)(6)^IN(x)(7)^CRC(x-1)(0)^CRC(x-1)(6)^CRC(x-1)(7);
  CRC(x)(1)=IN(x)(0)^IN(x)(1)^IN(x)(6)^CRC(x-1)(0)^CRC(x-1)(1)^CRC(x-1)(6);
  CRC(x)(2)=IN(x)(0)^IN(x)(1)^IN(x)(2)^IN(x)(6)^CRC(x-1)(0)^CRC(x-1)(1)^CRC(x-1)(2)^CRC(x-1)(6);
  CRC(x)(3)=IN(x)(1)^IN(x)(2)^IN(x)(3)^IN(x)(7)^CRC(x-1)(1)^CRC(x-1)(2)^CRC(x-1)(3)^CRC(x-1)(7);
  CRC(x)(4)=IN(x)(2)^IN(x)(3)^IN(x)(4)^CRC(x-1)(2)^CRC(x-1)(3)^CRC(x-1)(4);
  CRC(x)(5)=IN(x)(3)^IN(x)(4)^IN(x)(5)^CRC(x-1)(3)^CRC(x-1)(4)^CRC(x-1)(5);
  CRC(x)(6)=IN(x)(4)^IN(x)(5)^IN(x)(6)^CRC(x-1)(4)^CRC(x-1)(5)^CRC(x-1)(6);
  CRC(x)(7)=IN(x)(5)^IN(x)(6)^IN(x)(7)^CRC(x-1)(5)^CRC(x-1)(6)^CRC(x-1)(7);
END FOR;
```

3.6.1.2 CRC Example

This example demonstrates the values generated by the CRC calculation.

"IN" Data bytes = 0xC0, 0x3A, 0x04, 0x89, 0x39, 0x13, 0x30.

Table 3-17. CRC Example Calculation

| IN(x) | CRC(x) | COMMENTS |
|-------|--------|------------------------|
| | 0xFF | Initial seed CRC value |
| 0xC0 | 0xBD | CRC after byte 1 |
| 0x3A | 0x9C | CRC after byte 2 |
| 0x04 | 0xC1 | CRC after byte 3 |
| 0x89 | 0xFF | CRC after byte 4 |
| 0x39 | 0x5C | CRC after byte 5 |
| 0x13 | 0xEA | CRC after byte 6 |
| 0x30 | 0x08 | CRC after byte 7 |

The final CRC of this data is 0x08.

3.6.2 Checksum Calculation

Command checksums can be calculated by summing all of the bytes that are to be included in the checksum. This sum value should be masked with 0xFF to receive the checksum value.

Example checksum calculation of bytes: 0xA0, 0xBD, 0xCF, 0x85.

Sum = 0x2B1.

Checksum = 0xB1.

3.7 Command Tags

A command tag is required to be sent with each command in order to track command execution. The host command interface should only use a specific subset of the available byte values as shown in [Table 3-18](#). Other values are reserved for other system usages, such as commands that are executed from batch command sets stored in flash.

During typical usage, the host should increment the tags from 01h through CFh for each command sent and then loop back to 01h. This provides a unique identifying value for the command transaction so that the host can verify whether the command has completed.

Table 3-18. Command Tag Allocations

| TAG SOURCE | TAG RANGE | DESCRIPTION |
|-----------------------------------|-----------|--|
| Reserved | 00h | Default value at system initialization and when the Short Status is cleared. |
| Host | 01h - CFh | Host command interface |
| Batch Command Set | D0h - DFh | Batch command set from flash. These are automatically determined by embedded software. |
| Diagnostic Interface | E0h-EFh | Diagnostic read-only host interface |
| Reserved | F0h-FEh | Reserved |
| Null Tag Response in Short Status | FFh | Tag unknown or corrupted. Should not be used by host. |

System Operation

4.1 Operating Modes

The DLPC230-Q1 embedded software consists of two applications: the boot application and the main application. The main application includes several states, or modes, which determine the system's allowable commands and functionality at any point during operation. Typically, the *Operating Mode Select* command is used to transition between modes, but there are additional system conditions that can automatically trigger a mode transition. The modes and their interactions are described in the following sections.

The state diagram in [Figure 4-1](#) provides an overview of the DLPC230-Q1 power-up procedure and the various software state transitions.

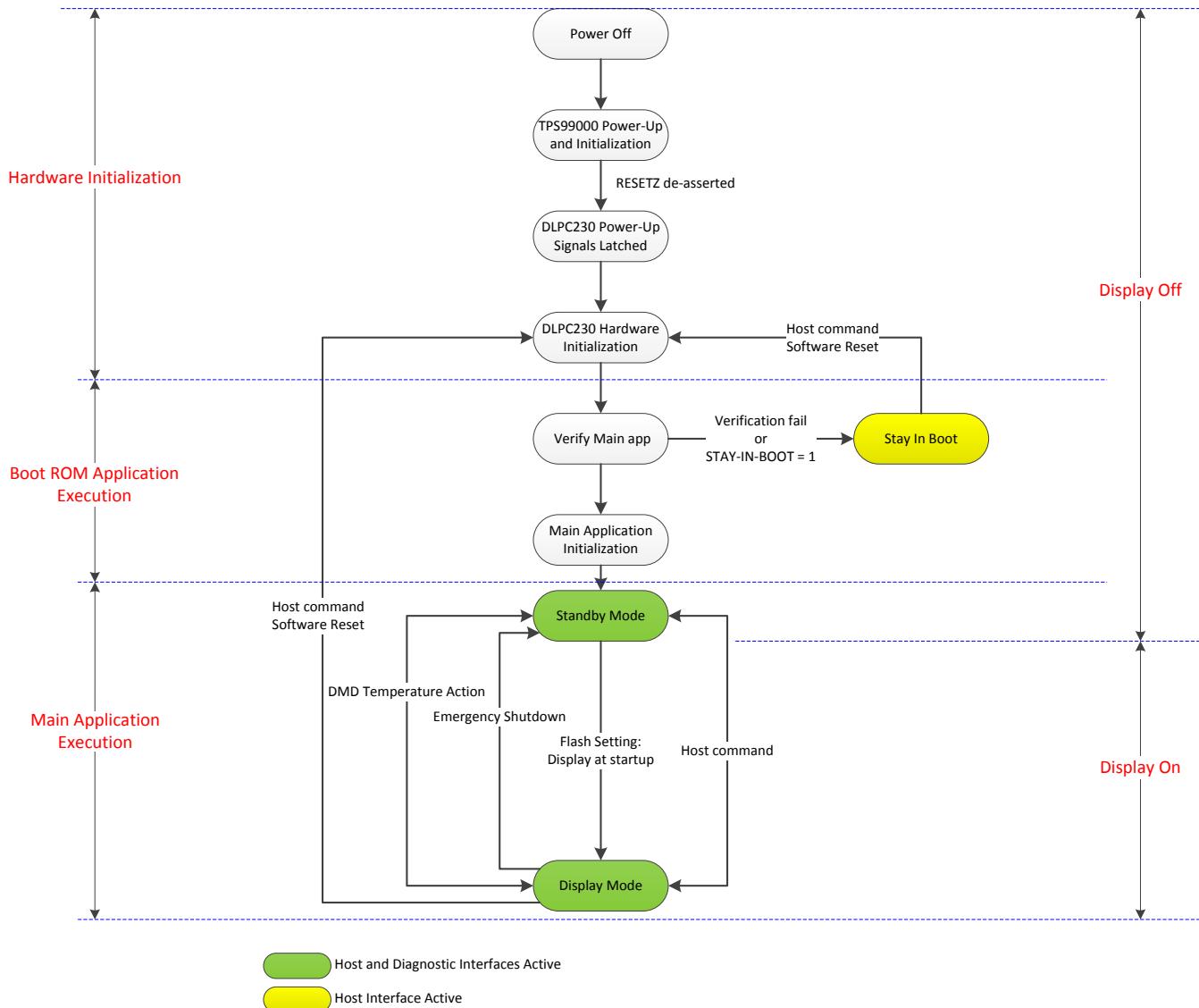


Figure 4-1. DLPC230-Q1 State Diagram

Table 4-1 summarizes general feature availability per software application and operating mode. This is not a full feature list and exceptions may exist. This is provided as an initial reference of the general purpose of each mode. The command availability tables in [Chapter 7](#) and [Chapter 8](#) provide more detail on the modes in which commands are available.

Table 4-1. Software Mode Feature Summary

| | Boot Application | Main Application - Standby | Main Application - Display |
|-------------------------------------|------------------|----------------------------|----------------------------|
| Short Status / Error History | Yes | Yes | Yes |
| Full Flash Program | Yes | Yes | No |
| Partial Flash Program | No | Yes | No |
| Non-Periodic BISTs | No | Yes | No |
| Source Display | No | No | Yes |
| Periodic BISTs | No | No | Yes |

4.1.1 Standby

Standby Mode is the first mode that the main application enters when the boot application transitions execution to the main application. No video is displayed, illumination is disabled, and the DMD remains parked. The primary features of Standby Mode are flash programming and non-periodic BIST execution, which cannot be executed in other operating modes.

When Standby Mode is entered, a selection of non-periodic BISTS can be automatically executed based on flash options. Once this is completed, a flash option determines whether the software will remain in Standby Mode or automatically transition to Display Mode. If the flash option to transition to Display Mode is not selected, the software will wait in Standby Mode until the host sends a command to transition to another mode.

4.1.2 Display

Display Mode is the primary mode of operation to display video data. Periodic BISTS, such as video source checks, will be executed in this mode. The following commands may not be executed in this mode:

- Flash programming
- Non-Periodic BISTS

4.2 Software Startup Procedure

At startup, the host may begin sending commands to control the device once the *System Initialized* flag has been set in the Short Status. This may be set by either the boot application or the main application. More detail on the Short Status can be found in [Section 8.2.80](#) (Main Application) and [Section 7.2.6](#) (Boot Application). The host should expect to receive NAKs (I²C) or invalid data (SPI) before the *System Initialized* flag is set. [Figure 4-2](#) demonstrates the actions that the host should take at startup. [Section 2.1.4.1](#) describes a hardware signal that can be used to debug startup timing and progress.

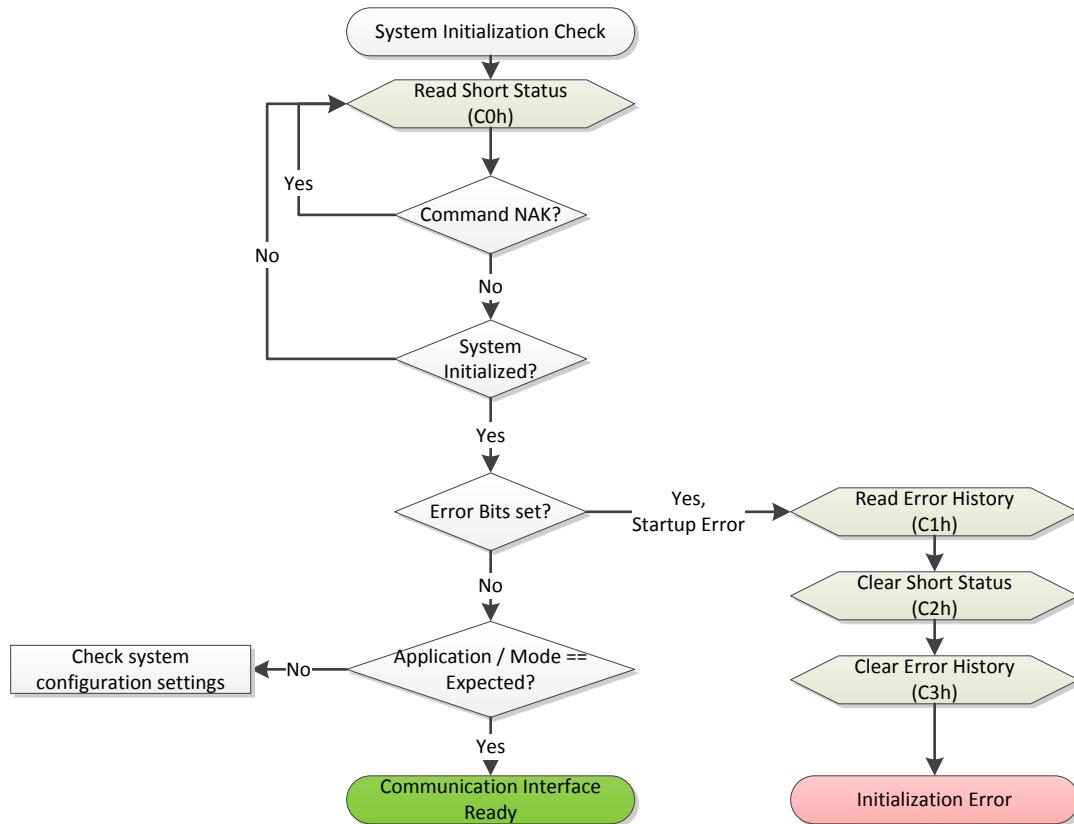


Figure 4-2. Communication Ready Check

- **Read Short Status** - Attempt to read the Short Status from hardware.

- **Command NAK?** - If communication hardware has not yet been initialized, a NAK or invalid data will be received.
- **System Initialized?** - If the Short Status was received successfully, check the *System Initialized* bit. If it is cleared, continue polling the Short Status until it is set.
- **Error Bits Set?** - If any of the Short Status error bits are set, a startup error occurred. Examples of possible startup errors include startup BIST failures or auto-initialization batch command set execution errors. The [Error History](#) should be read for details on the errors and then the Short Status and Error History should be cleared to clear the prior error flags. The host may then determine what action to take based on the error conditions.
- **Application / Mode == Expected?** - If no error bits are set, the application and operating mode should be checked to confirm that the software is in the expected state. If the application or mode are incorrect and no error is set, there are several system configuration parameters that can be checked. Check that the STAY-IN-BOOT signal is pulled to the desired state. This determines whether the main application is executed or if execution remains in the boot application. Check that the flash header file indicates that the correct main application operating mode (Standby or Display) is selected for the initial startup mode.

The boot application resides in boot ROM in the DLPC230-Q1. The boot application is executed after DLPC230-Q1 hardware has initialized at startup. The purpose of the boot application is to load the main application from flash and verify its contents during start-up. The boot application execution flow is shown in [Figure 4-3](#). It reads the hardware pin signals described in [Section 2.1](#) to configure the host communication interface and then it determines whether STAY-IN-BOOT has been set. If STAY-IN-BOOT is set, the boot application will enter a loop waiting for host-commanded instructions. If the STAY-IN-BOOT signal is not set, the boot application will load the main application from flash and verify it. If verification fails, an error will be recorded in the Error History and the boot application will enter the wait-for-command loop. If verification succeeds, the main application will be executed.

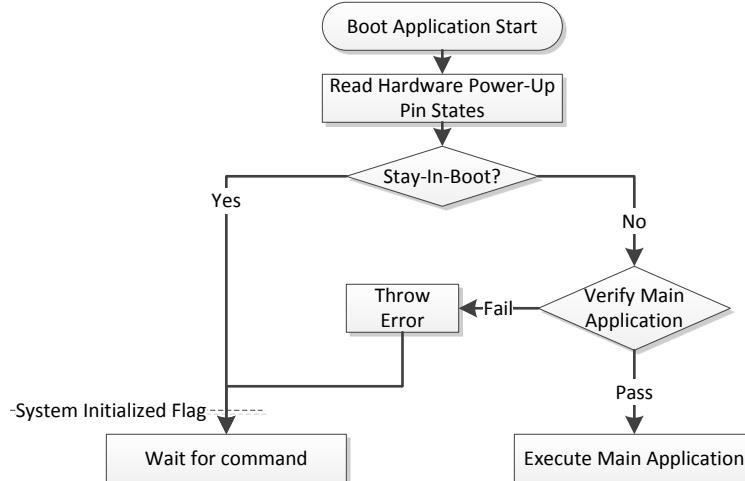


Figure 4-3. Boot Application Execution Flow

The main application execution flow is shown in [Figure 4-4](#). The main application begins by initializing clocks and then retrieves the cause of the last reset from hardware. It then executes any non-periodic BISTS that are selected through flash options. The main application will check a flash option to determine whether it should stay in Standby Mode or automatically switch to Display Mode. Once it has entered the desired mode, the auto-initialization batch command set will be run from flash memory. More information on batch command sets can be found in [Section 5.2](#). The auto-initialization batch command set can be empty if there are no commands to be executed during start-up. The auto-initialization batch command set can also change the operating mode. Once the auto-initialization batch command set is complete, the main application will set the *System Initialized* Short Status flag to indicate that command transactions may be sent from the host.

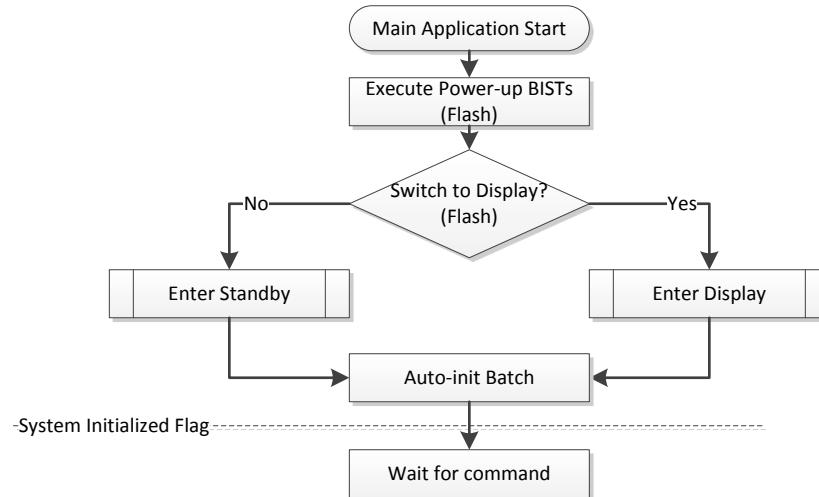


Figure 4-4. Main Application Execution Flow

Application and Use-Cases

5.1 Display and Source

The DLPC230-Q1 supports several video source types: external parallel and openLDI video interfaces, internal test pattern generation, and splash images stored in flash.

5.1.1 Displaying an Image

The parameters for the available source configurations are stored in batch command sets in flash. To configure a source, the desired batch command set index should be executed. Once the batch command set is executed, the *Prepare for Source Change* command will disable illumination and the software will hold the configuration parameters until the *Source Select* command is sent. This two-command process provides time to prepare the external video source signals without displaying corrupted video data and causing the software to throw video source detection errors. During normal operation, an external video source should be adjusted between these two commands.

An image may only be displayed in Display Mode.

The source change steps are summarized as follows:

1. *Execute Batch Command Set* command - Configures the desired display source parameters. This configuration will be held by software and will not be applied until the *Source Select* command is sent.
2. *Prepare For Source Change* command - Disables illumination and external source error-checking to transition without displaying corrupted video data.
3. Configure external video signals as needed if external source is being displayed. For example, adjust video resolution to match the new batch command set configuration.
4. *Source Select* command - Applies the source configuration. Illumination will then be re-enabled and the desired source will be visible on the display.

If multiple external video inputs are used, the following steps must be used to switch between them. This assumes source 1 is being displayed:

1. *Operating Mode* command - Transition to Standby Mode.
2. *Execute Batch Command Set* command - Configures the desired display source parameters for source 2.
3. Configure external video signals.
4. *Source Select* command - Holds the source configuration until operating mode select.
5. *Operating Mode* command - Transition to Display Mode. Illumination will then be re-enabled and the desired source will be visible on the display.

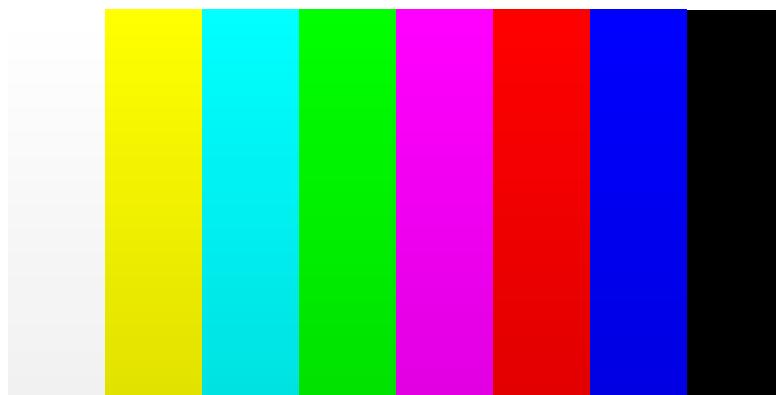
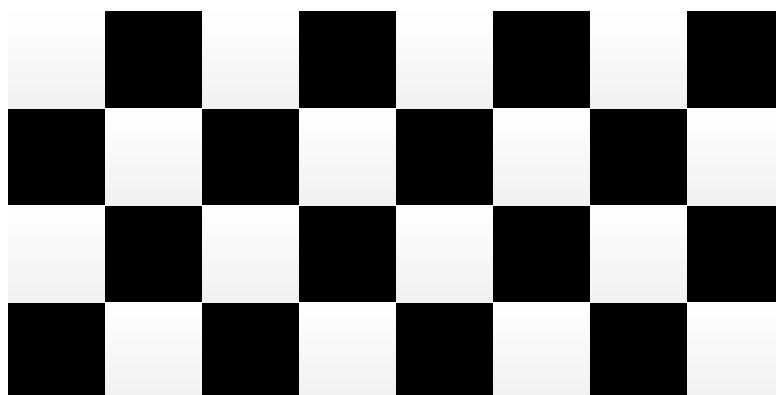
5.1.2 External Video

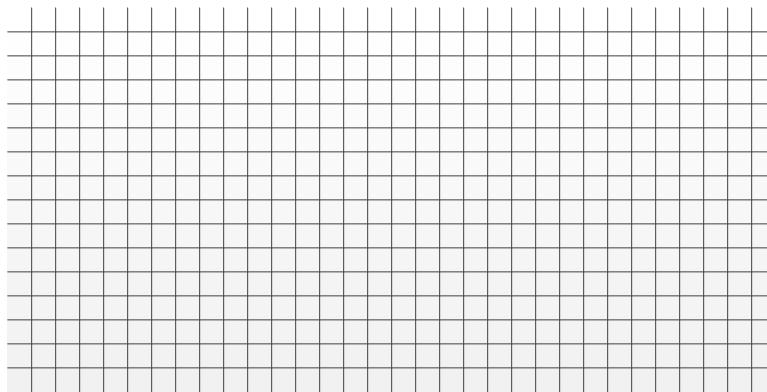
Parallel and openLDI interfaces can be configured at various resolutions. The supported resolutions are described in the DLPC230-Q1 Data Sheet.

5.1.3 Test Pattern

The DLPC230-Q1 includes an internal test pattern generator which can be used to display basic test images and verify system functionality without an external video source. [Figure 5-1](#) through [Figure 5-9](#) show the test patterns that may be generated.

Note that the test patterns below assume that the system uses red, green, and blue light sources. Test patterns displayed using single-color systems (including full-white light systems) may not appear as shown below.

Solid Color (White, Red, Green, Blue)**Figure 5-1. Test Pattern - Solid Color****Color Bars (8-color)****Figure 5-2. Test Pattern - Color Bars****Checkerboard (White/Black)****Figure 5-3. Test Pattern - Checkerboard**

Horizontal Ramp (White/Black)**Figure 5-4. Test Pattern - Horizontal Ramp****Vertical Ramp (White/Black)****Figure 5-5. Test Pattern - Vertical Ramp****Grid Lines (White, Black)****Figure 5-6. Test Pattern - Grid White**

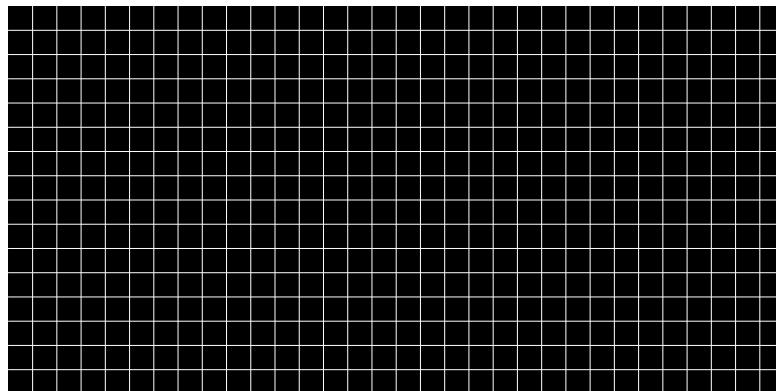


Figure 5-7. Test Pattern - Grid Black

Diagonal Lines (White, Black)

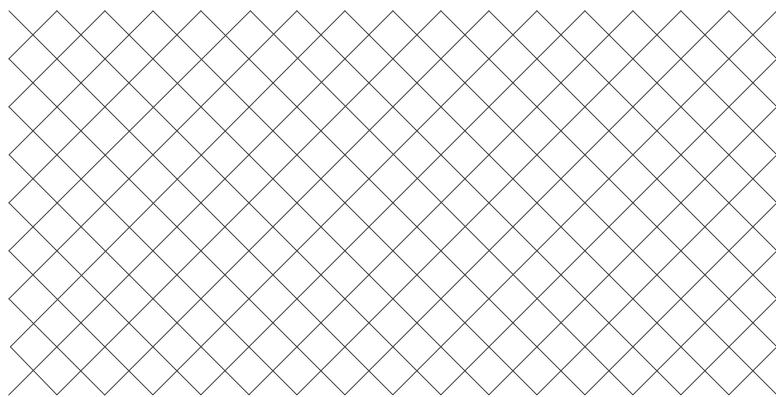


Figure 5-8. Test Pattern - Diagonal White

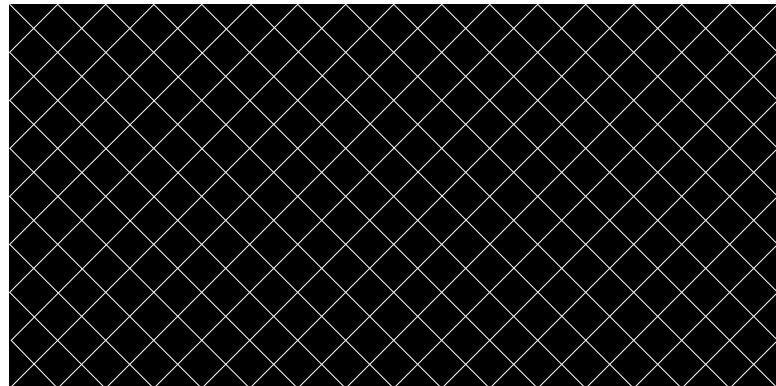


Figure 5-9. Test Pattern - Diagonal Black

5.1.4 Splash Image

Splash images are individual binary images stored in flash memory. A maximum of 8 splash images can be stored in flash if there is sufficient memory space. Splash images require slightly less than 0.5 seconds to load from flash when requested, during which illumination will be disabled.

Supported splash resolutions are:

- 1152 x 576
- 1152 x 1152 (No scaling. 1:1 aspect ratio input image will display with 2:1 aspect ratio on the DMD due to diamond pixel architecture)

Non-supported resolutions may be scaled to a supported resolution, cropped, or bordered with black pixels before being stored in flash memory.

Supported image formats are:

- RGB 888
- YCbCr 422

The YCbCr pixel format results in smaller binary sizes. This can reduce the flash size requirements and flash programming time, but the image conversion may reduce the image quality slightly.

5.1.5 Image Flip

Image flip can be used to compensate for folds in the optical path. The default image flip settings are stored in flash and the values are specified in the flash header file. Image flip values may also be set using the *Display Image Orientation* command. This command is a "Hold Source" command which means that changes will not be applied until the source is changed. To do this, the *Prepare for Source Change* command should be sent followed by the *Source Select* command in order to apply the source changes. These steps are shown as follows:

1. *Display Image Orientation* command - Set the new desired flip setting.
2. *Prepare For Source Change* command - Disable illumination to prepare for a source update without image artifacts.
3. *Source Select* command - Selects the desired source and displays the image with the updated flip setting.

Flip can be performed along two axes: a short axis flip and a long axis flip. Flips along both axes are shown in [Figure 5-10](#) and [Figure 5-11](#). Any combination of these two flip settings is permitted.



Figure 5-10. Short Axis Flip

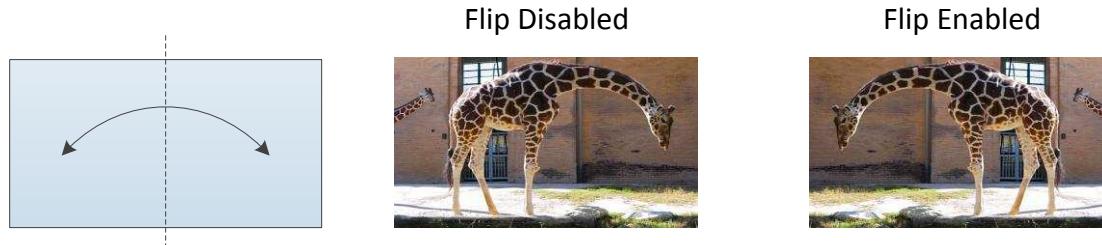


Figure 5-11. Long Axis Flip

5.2 Batch Command Sets

Batch command sets are groups of commands that are stored in flash. Executing a batch command set that is stored in flash requires one command to be sent from the host: the *Execute Batch Command Set* command. Once the host requests execution of a desired batch index, the DLPC230-Q1 software will loop through all of the instructions stored in that batch command set. During this execution time the *Request In Progress* flag will be set in the *Short Status* to indicate that the batch command set is executing and that no other commands should be sent from the host.

The primary use of batch command sets is to configure the video source to pre-configured parameters stored in flash. For example, one batch command set can configure 1152 x 576 parallel video, and another can configure a solid white test pattern. The available batch command sets and their indexes may change based on flash configuration.

Only main application write commands can be used for batch command sets. The boot application cannot execute batch command sets. Read commands are not possible through batch command sets. The table below describes commands that cannot be executed through batch command sets.

Table 5-1. Commands Excluded from Batch Use

| COMMAND | OP CODE |
|-------------------------------|---------|
| System Reset | 00h |
| Read Pre-Fetch | 01h |
| Read Activate | 02h |
| Execute Batch Command Set | 21h |
| Execute Non-Periodic BIST | 28h |
| Flash Data Type Select | A0h |
| Flash Erase Data | A1h |
| Flash Write Data | A2h |
| Flash Verify Data | A4h |
| All read commands | Various |
| All boot application commands | Various |

Batch index 0 is reserved for an auto-initialization batch command set that is automatically run by the software main application when it enters Standby Mode during the startup procedure.

The batch command sets that are available in a flash file can be found in the flash header file that is delivered along with the flash data.

5.3 Flash Programming

Flash programming can be performed by the boot application or the main application in Standby mode. Each application has its own procedure, and these are described in the following sections. Reading flash may only be accomplished using the main application in any mode.

5.3.1 Flash Program - Main Application

Flash programming may be performed by the main application in Standby mode. The entire flash may be programmed, or a flash block may be selected for partial flash updates. The main application determines whether each flash block is stored in flash or EEPROM, if it is in use. Therefore the procedure is identical for EEPROM programming.

The following commands are used to erase, program, and verify a flash block:

- *Flash Data Type Select*
- *Flash Erase Data*
- *Flash Write Data*
- *Flash Verify Data*

Figure 5-12 demonstrates the flash programming steps. The steps to write each command must follow the write command handler procedure described in Section 3.4.3.

1. Write *Flash Data Type Select* - Sets the desired flash block or blocks to be erased and re-programmed.
2. Write *Flash Erase Data* - Erases the selected flash block(s). This process may require significant time to complete. The *Write Command Handler* should expect additional time to poll the Short Status to confirm that the command tag has changed to the appropriate value and that the *Request In Progress* bit has been cleared before proceeding to the next step.
3. *Flash Write Data* - Repeatedly write up to a page (256 bytes) of flash data. The data size being written must be a multiple of 4. After each section of data is written, read the short status repeatedly until the write has completed. Continue until there is no remaining flash data.
4. *Flash Verify Data* - Begin verification of the flash. This process may require significant time to complete. The *Write Command Handler* should expect additional time to poll the Short Status to confirm that the command tag has changed to the appropriate value and that the *Request In Progress* bit has been cleared. A flash verification error will flag the *Command Error* bit in the Short Status. This should be detected in the write command handling procedure.

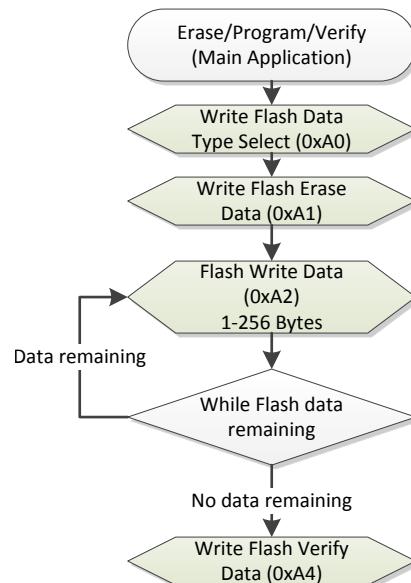


Figure 5-12. Flash Program Main Application

5.3.2 Flash Read - Main Application

Flash read may be performed by the main application in Standby mode. The entire flash may be read, or a flash block may be selected to be read. The main application determines whether each flash block is stored in flash or EEPROM, if it is in use. Therefore the procedure is identical for reading EEPROM.

The following commands are used to read flash data:

- *Flash Data Size*
- *Flash Read Data*
- *Read Pre-fetch*
- *Read Activate*

Figure 5-13 demonstrates the flash programming steps.

1. Read *Flash Data Size* - Read the size of the desired flash data type. This determines how many reads need to be performed.
2. *Flash Read Data* - Read up to a page (256 bytes) of flash data. Note that the data length is 0-based, so 0 = 1 byte. The length in bytes must be a multiple of 4.
3. Data read \geq Flash Data Size - Once the amount of data that has been read equals the flash data size, reading should terminate.

The read command handler flow described in [Section 3.5.4](#) should be used for each of these read command transactions to ensure that the read data is available prior to a retrieval attempt.

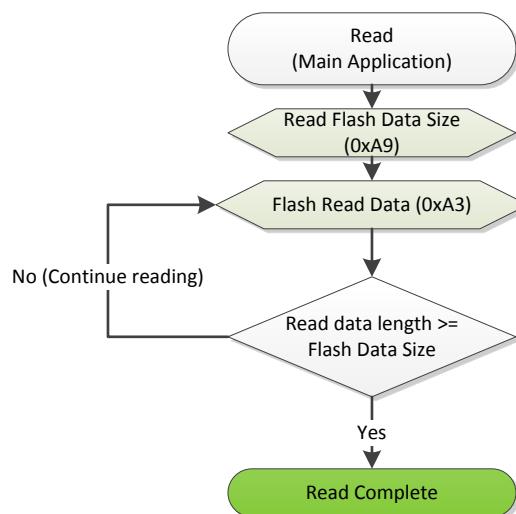


Figure 5-13. Flash Read Main Application

5.3.3 Flash Program - Boot Application

Flash programming may also be performed by the boot application. The boot application can only program the full flash; it is not capable of partial flash updating and it cannot program EEPROM data. The primary usage of boot flash programming is for situations when the system cannot transition to the main application, such as an empty or corrupted flash.

The following commands are used to erase, program, and verify flash:

- *Flash Interface Rate*
- *Flash Full Erase*
- *Flash Write Data*
- *Flash Verify Data*

Figure 5-14 demonstrates the flash programming steps.

1. Write *Flash Interface Rate* - Notifies the Boot Application of the maximum allowable flash interface speed and the read modes that the flash part supports. This is used to maximize flash SPI bandwidth in order to shorten flash programming time based on the selected flash part's capabilities. If this command is not sent prior to flash programming, a default speed of 10 MHz and only Fast Read will be used which may significantly slow programming operations. This default may also cause issues with the flash verification step since it does not meet the DLPC230 minimum flash bandwidth requirement.
2. Write *Flash Full Erase* - Erases the entire flash.
3. *Flash Write Data* - Repeatedly write a page (256 bytes) of flash data. If the desired data is less than 256 bytes, the remaining bytes should be set to 0xFF. After each section of data is written, read the short status repeatedly until the write has completed. Continue until there is no remaining flash data.
4. Write *Flash Interface Rate* - This step is required if a quad read mode is desired. The boot application will disable quad mode in some flash devices during write operations. This step ensures that quad mode is enabled in the flash device prior to flash verification. The same data may be written for this step and step 1.
5. *Flash Verify Data* - Begin verification of the flash data. This process may require significant time to complete. The *Write Command Handler* should expect additional time to poll the Short Status to confirm that the command tag has changed to the appropriate value and that the *Request In Progress* bit has been cleared. A flash verification error will flag the Command Error tag in the Short Status. This should be detected in the write command handling procedure.

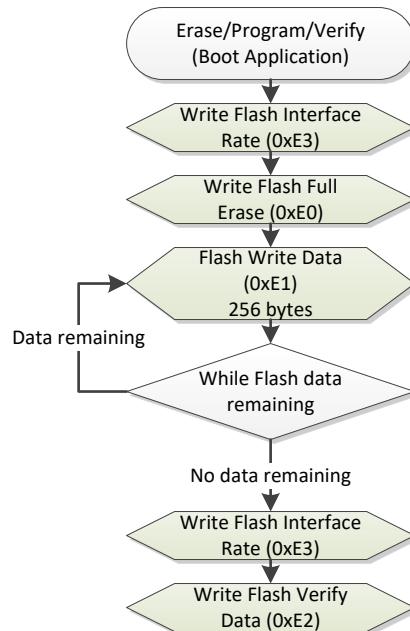


Figure 5-14. Flash Program Boot Application

5.4 Video Frame and Illumination Bin Delay

This section defines the input video delay and command processing delay for illumination bins while displaying external video.

The DLPC230-Q1 has a 1 frame processing delay between external input video data and displayed data.

The DLPC230-Q1 has a 3 frame delay between receiving an illumination bin index and applying the illumination bin. This delay only applies if the *Illumination Transition Rate* is set to 0, otherwise the transition rate will further delay the application of the illumination bin. Additionally, this delay only applies while displaying external video or a built-in test pattern. Displaying a splash image will extend the time taken to apply an illumination bin due to the time required to reload the splash image from flash.

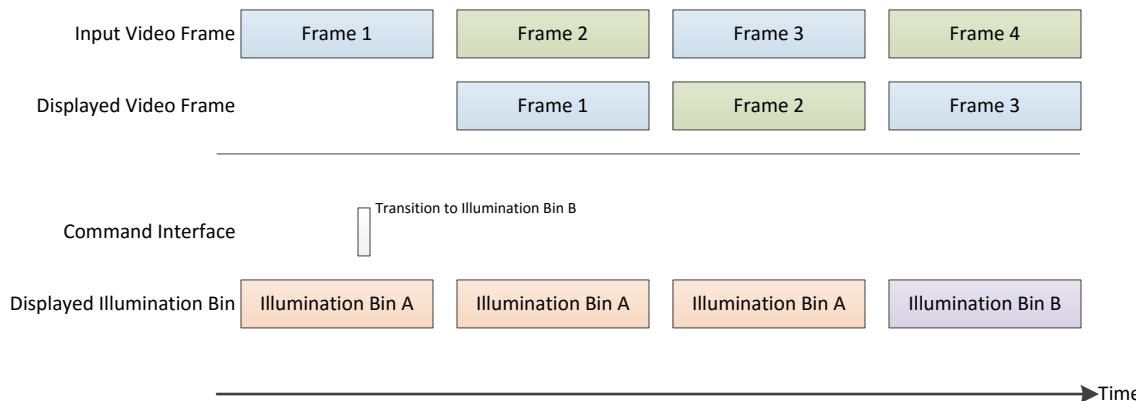


Figure 5-15. External Video Delay and Illumination Bin Delay

Figure 5-15 assumes that the illumination bin command is received during a specific window of time within the video frame. The write illumination bin command transaction must be complete within a specific time frame relative to the VSYNC active edge to ensure a consistent 3 frame delay. Table 5-2 defines these constraints. If the command is received outside of that time frame the illumination bin will still be applied, but the exact frame delay becomes uncertain (2-4 frames).

Table 5-2. Illumination Bin Synchronization Timing Parameters

| PARAMETER | | MIN | UNIT |
|-------------------|---|-----|------|
| t_{sync_open} | Minimum time between VSYNC active edge (polarity-dependent) and illumination bin command transaction completion. | 4 | ms |
| t_{sync_close} | Minimum time between illumination bin command transaction completion and next VSYNC active edge (polarity-dependent). | 1 | ms |

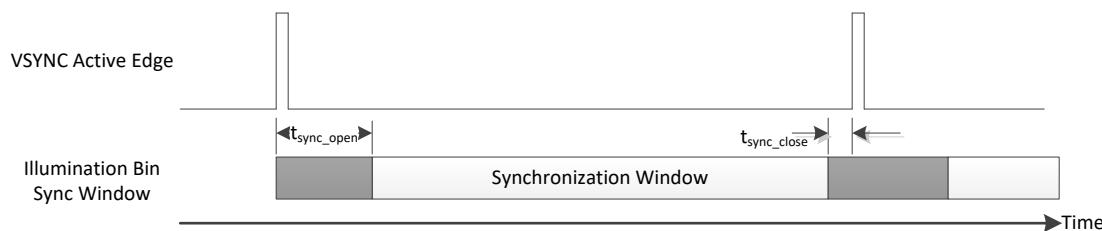


Figure 5-16. Illumination Bin Synchronization Window

5.5 Smooth Illumination Transition

The main application supports smooth transitions between sequences, or illumination bins, using digital contrast adjustments over a series of frames in order to attenuate the display brightness.

This feature prevents instantaneous changes in system brightness caused by large duty cycle differences in illumination bins. [Figure 5-17](#) demonstrates an instantaneous brightness change that would occur without the use of this feature.

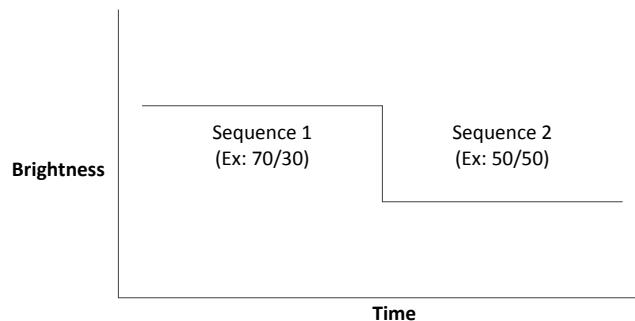


Figure 5-17. Instantaneous Duty Cycle Change

The following commands are used for this feature:

- [Illumination Transition Rate](#) - Specifies the number of frames over which the transition will occur. This effectively determines the time of transition based on the frame period multiplied by the number of frames. Changes to the brightness are calculated and applied each frame despite the step size allowed by this command.
- [Illumination Bin Select](#) - Specifies the illumination bin index that will be transitioned to. This command also triggers the start of the transition.

Note that this feature is only available while displaying external video or test patterns. It is not available while displaying splash images. While a splash image is displayed, the transition rate value is ignored and the commanded illumination bin will always be applied in one step.

When an [Illumination Bin Select](#) command is received, the main application begins transitioning brightness levels from the full digital brightness of the currently displayed illumination bin to the full digital brightness of the selected illumination bin. The main application uses the latest transition rate that was received prior to the start of the transition.

If an [Illumination Bin Select](#) command is received during an ongoing transition, the main application will terminate the ongoing transition by immediately switching to the last selected illumination bin. It will then start a new transition from the previously selected illumination bin to the newly selected illumination bin.

[Figure 5-18](#) demonstrates the procedure that the main application performs to transition from a high brightness sequence to a low brightness sequence across 8 frames. Initially the system remains in the high brightness sequence and the digital contrast is decreased each frame so that the contrast-adjusted brightness of sequence 1 approaches the full-contrast brightness of sequence 2. On the last transition frame the contrast is returned to 1x and the sequence is transitioned to sequence 2. [Figure 5-19](#) highlights the resulting total brightness of the combination of sequence and contrast brightness.

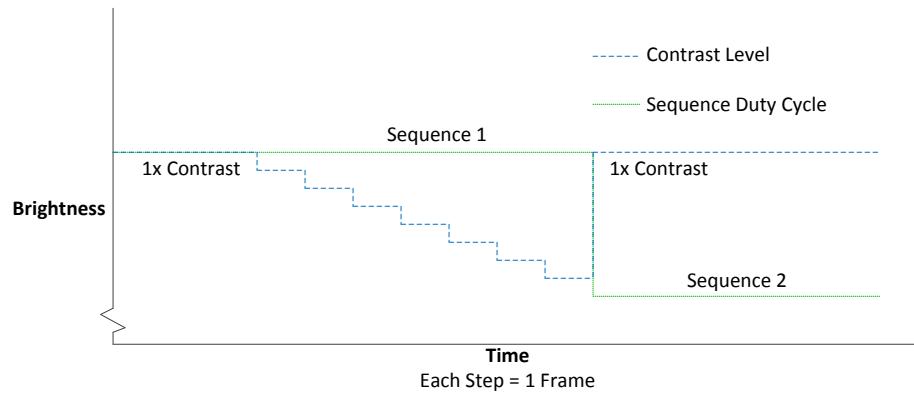


Figure 5-18. Duty Cycle Decrease

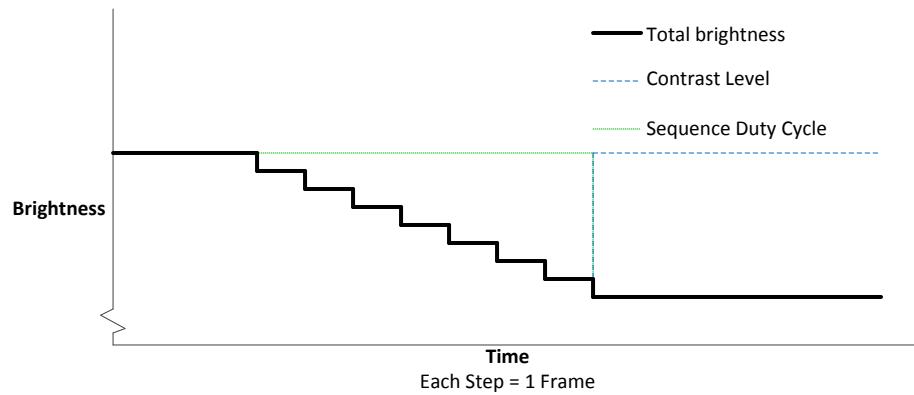


Figure 5-19. Duty Cycle Decrease Total Brightness

Figure 5-20 demonstrates the use of this function to transition from a low brightness sequence to a high brightness sequence across 8 frames. On the first transition frame, the sequence transitions to the high brightness sequence and the contrast is decreased to approximately match the low brightness sequence. Then the contrast is increased across the transition frames until the contrast returns to 1x. Figure 5-21 highlights the resulting total brightness of the combination of sequence and contrast brightness.

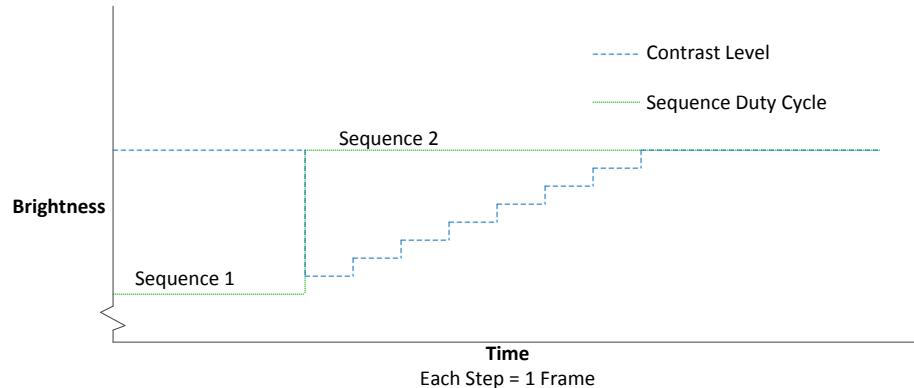


Figure 5-20. Duty Cycle Increase

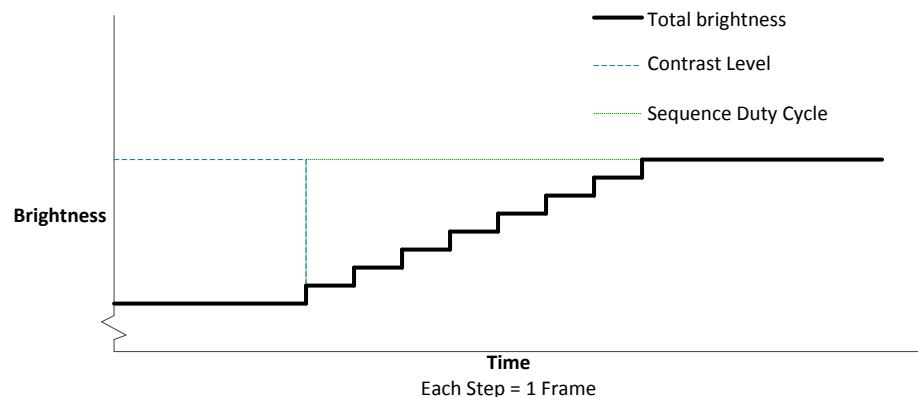


Figure 5-21. Duty Cycle Increase Total brightness

5.6 Temperature Management

The DLP553X-Q1 chipset supports a wide temperature operating range for automotive applications. The following command is used for temperature management:

- **System Temperatures - Read** - Read the DMD and system temperature. This command also notifies the host when the sequence park timer is active.

During system operation, the main application monitors the DMD temperature using I²C communication to an external TMP411 connected to a temperature sensing diode built into the DMD. This value is filtered using weighted averaging across multiple samples to reduce the impact of signal noise.

The flash header file provided along with the flash data define maximum and minimum park temperature conditions. If either the maximum or minimum park temperature condition is met, the main application will immediately enter Standby mode to park the DMD and disable illumination. The main application will remain in Standby mode until the host requests a transition to any other mode. The host will be unable to switch to Display mode until the DMD temperature has reached the related unpark temperature.

The DMD data sheet specifies the DMD operating temperature range. The maximum and minimum DMD park temperatures that are set in the flash project may not match the DMD operating temperature range if these threshold configurations are modified. The DMD must only operate within its data sheet specified temperature limits regardless of these threshold temperature settings.

[Figure 5-22](#) provides an overview of the full DMD temperature range and the actions taken by the main application.

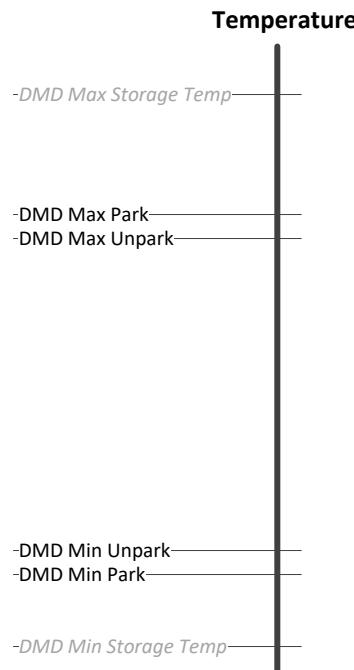


Figure 5-22. Temperature Actions

5.7 ADC Measurements

The TPS99000-Q1 includes an analog to digital converter block with a 32:1 input mux. The DLPC230-Q1 controls the timing of ADC measurements from this block using a dedicated high-speed serial control interface in order to capture up to 63 sequence-aligned samples per frame while an image is being displayed. From the command interface, there are two ADC read commands. The usage of these two commands is dependent on whether an image is being displayed or not:

- **ADC Measurements - Read** - Used while an image is displayed. This allows access to the last frame of sequence-aligned ADC measurement capture results. Measurement capture timing is not decided by the command itself, as the results were already captured during a previous video frame.
- **ADC Single Measurement - Read** - Used in Standby mode. This commands the DLPC230-Q1 main application software to read a single ADC measurement after the command has been received and return the result.

5.7.1 Sequence-Aligned ADC Measurements

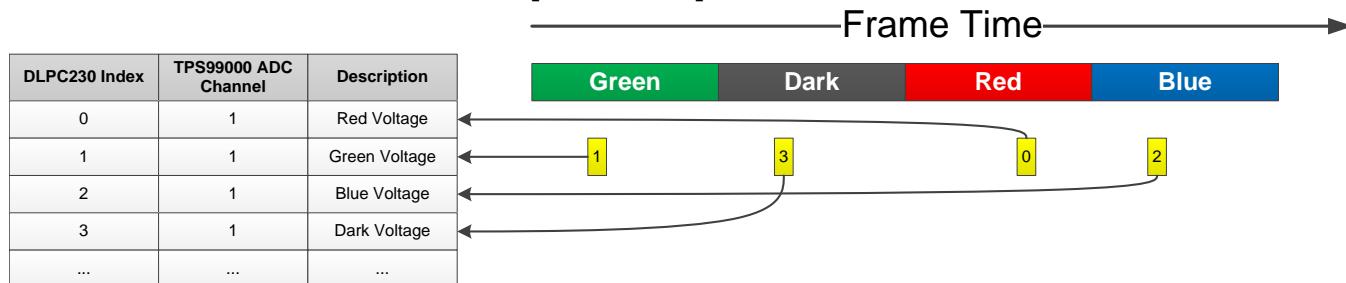
The DLPC230-Q1 continuously commands the TPS99000-Q1 to capture specific ADC measurements throughout each video frame. These measurements are aligned to events in the DMD sequence, such as illumination enables or dark time. DLPC230-Q1 hardware stores the ADC measurements in buffered memory. The memory buffer is swapped each video frame so that DLPC230-Q1 software is continuously reading the previous frame's ADC measurement data.

The order in which each ADC measurement is captured is dependent on the order of events in a given sequence. [Figure 5-23](#) demonstrates two example sequences with sequence-aligned ADC measurements to capture various illumination voltage levels. The same measurements are captured during each sequence and the results are placed in the same DLPC230-Q1 memory indexes, but the order in which the measurements are retrieved by the DLPC230-Q1 varies to accommodate the sequence timing.

The command parameters for the *ADC Measurements* command specify the desired measurement index range in DLPC230-Q1 memory from 0 to 63.

The flash header file defines the DLPC230-Q1 indexes and their associated TPS99000-Q1 ADC channels for a specific flash build.

Example Sequence 1



Example Sequence 2

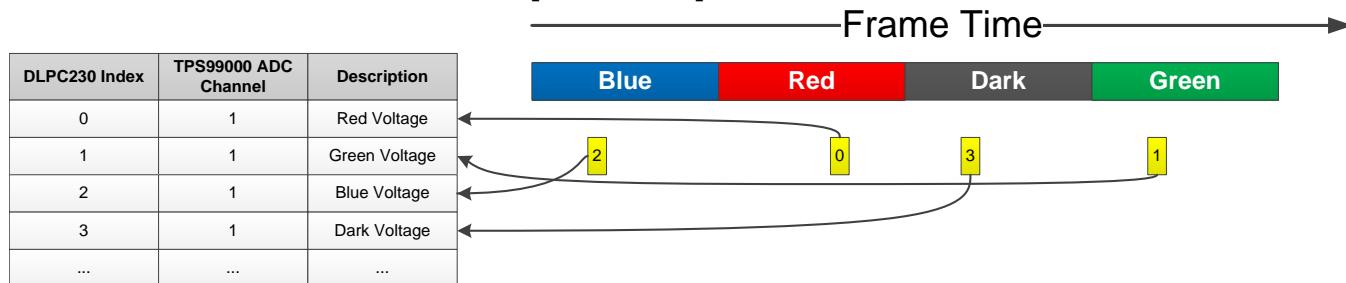


Figure 5-23. Sequence-Aligned ADC Example

5.7.2 Single ADC Measurements

When the *ADC Single Measurement* command is received by the DLPC230-Q1 main application, it will request an ADC capture from the TPS99000-Q1 for the specific ADC multiplexer index that is specified by the command, from 0 to 31. Note that this index is different than the DLPC230-Q1 memory index which is not relevant for a single ADC measurement.

Tests and Diagnostics

6.1 Overview

The DLP553X-Q1 chipset includes numerous test and diagnostic features to verify proper system operation such as video interface tests, communication interface tests, and self-tests. The following sections describe available features.

6.2 Emergency Shutdown

The DLPC230-Q1 main application performs an emergency shutdown when a serious system error occurs such as losing communication with a chipset signal interface. The specific errors that caused the shutdown can be retrieved from the *Error History* command unless the error has caused a system reset. If the error has caused a system reset, the *System Information* command can be used to read the cause of the last reset. If the error has not caused a system reset, other errors may occur as a side-effect of the failure mechanism that caused the emergency shutdown. These side-effect errors will also be included in the error history if possible.

The actions that are taken by the DLPC230-Q1 main application for an emergency shutdown are:

- LEDs disabled
- DMD parked and powered down
- Main application mode transitions to Standby Mode
- Errors captured in *Error History*
- *Emergency Shutdown* bit is set in the *Short Status*
- *HOST_IRQ* signal is set to HIGH state

To recover from an emergency shutdown, the system will require a full power cycle using the PROJ_ON signal to the TPS99000-Q1. Details on PROJ_ON signal timing requirements can be found in the DLPC230-Q1 Data Sheet and the TPS99000-Q1 Data Sheet. The host should attempt to obtain the *Error History* from the DLPC230-Q1 prior to this full reset.

[Section 6.4](#) defines tests performed and notes those that may result in an emergency shutdown. During operation, the *Short Status* should be checked periodically for any errors including those that cause emergency shutdown.

6.2.1 Emergency Shutdown Causes

Table 6-1. Emergency Shutdown Causes

| INDEX | DESCRIPTION |
|-------|-----------------------------------|
| 1 | Front End BIST failed |
| 2 | Back End BIST failed |
| 3 | DMD Memory BIST failed |
| 4 | TPS99000-Q1 Interface BIST failed |
| 5 | DLPC230-Q1 Memory BIST failed |
| 6 | DMD clock out of range |
| 7 | Video Tell-Tale Checksum failed |
| 8 | TPS99000-Q1 Watchdog 1 error |
| 9 | TPS99000-Q1 Watchdog 2 error |

Table 6-1. Emergency Shutdown Causes (continued)

| INDEX | DESCRIPTION |
|--------------|--|
| 10 | TPS99000-Q1 Clock Ratio Monitor error |
| 11 | Frame Memory Buffer Swap Watchdog error |
| 12 | Sequencer Instruction Watchdog error |
| 13 | DMD Reset Instruction Watchdog error |
| 14 | TPS99000-Q1 Register Checksum error |
| 16 | TPS99000-Q1 SPI Interface Parity error |
| 17 | TPS99000-Q1 ADC Interface Parity error |
| 18 | Multi-bit ECC error in DLPC230-Q1 memory |
| 19 | Multi-bit ECC error in DLPC230-Q1 memory |
| 20 | Temperature sensor remote channel open |
| 21 | Temperature sensor read errors |
| 22 | Average Picture Level error |
| 23 | DMD voltage out of range |

6.3 Diagnostic Memory Interface

The diagnostic interface provides access to a 64-byte memory that is updated by the DLPC230-Q1 main application during operation. This diagnostic memory information is intended to summarize operation and to allow the monitoring host to independently check operation of the system and the primary host controller.

The diagnostic memory is accessed through a separate port that is independent of the host command interface. The communication protocol for this interface is either I²C or SPI, and will always be the protocol that is not selected for use by the host command interface. The protocol selection is determined by the state of the *HOST_IF_SEL* hardware signal at power-up. Communication requests to the diagnostic interface to access and clear the memory contents are handled entirely by DLPC230-Q1 hardware. The values set in the memory are updated by the DLPC230-Q1 main application software. The diagnostic interface commands are described in [Chapter 9](#). Read and write protocols are identical to the host command interface.

The following commands are used for the diagnostic memory interface:

- *Diagnostic Interface Status - Read* - Read desired bytes from the diagnostic memory.
- *Diagnostic Interface Status Clear - Write* - Clear desired bytes in the diagnostic memory to 0. Any bytes may be cleared, but it is only critical to clear values if they have a risk of reaching a maximum value, such as a counter. All values will be updated at a specified rate, but clearing a value may also provide more confidence that the value is being updated in case the value does not change after a significant time interval.

The diagnostic memory contents may also be read through the host command interface by requesting the data from the DLPC230-Q1 main application software. Note that the host command interface has no command to clear the diagnostic memory. This memory may only be cleared through the dedicated diagnostic interface.

- *Diagnostic Interface Status - Read* - Read desired bytes from the diagnostic memory.

Table 6-2 defines the diagnostic memory content.

Table 6-2. Diagnostic Memory Definition

| BYTE | DESCRIPTION | UPDATE RATE | SHOULD BE CLEARED |
|------|---|-------------------------|-------------------|
| 0 | Operating Mode 0x0: Reserved for clear 0x1: Main application - Standby 0x2: Main application - Display | Mode change | No |
| 2:1 | Software Activity Counter Incrementing counter to confirm that the main application is still active. 0-65535, rolls over to 0. | Approximately 16ms | No |
| 3 | TPS99000-Q1 State 0 - 7: Off 8: Standby 9 - 11: Powering DMD 12: Display Ready 13: Display On 14 - 17: Parking | State change | No |
| 4 | Last Reset Cause 0x0: Power Cycle 0x1: PROJ_ON 0x2: TPS99000-Q1 Watchdog Software Error 0x3: TPS99000-Q1 Watchdog Sequence Error 0x4: TPS99000-Q1 Die Temperature Exceeded 0x5: Software commanded power cycle 0x7: Host commanded reset 0x8: Software commanded DLPC230-Q1-only reset 0x9 - 0xFF: Reserved | Software initialization | No |

Table 6-2. Diagnostic Memory Definition (continued)

| BYTE | DESCRIPTION | UPDATE RATE | SHOULD BE CLEARED |
|-------|---|---------------|-------------------|
| 10:5 | Reserved | | |
| 11 | Error History Count Number of errors received since the error history was last cleared through the host command interface. Note that clearing this diagnostic byte will not reset the count. Clearing this diagnostic byte will only set the value to 0 until the value is re-written by the main application. | On error | No |
| 13:12 | Last Error Code Latest error code that has occurred. Refer to Section A.2 for error code descriptions. Bits 15:12 - Unused Bits 11:0 - Error code. | On error | No |
| 14 | ECC Error Count Number of single-bit or multi-bit ECC errors received since the last system reset. | On error | No |
| 15 | Emergency Shutdown 0x0: No emergency shutdown has occurred 0x1: Emergency shutdown has occurred | On error | No |
| 19:16 | Reserved | | |
| 23:20 | External Video Checksum Result Last calculated external video checksum. | Per frame | No |
| 24 | Average Picture Level Result Last calculated average picture level. | Per frame | No |
| 25 | Source Type Bit 3 <ul style="list-style-type: none"> • 0x1: External source Lost Bits 2:0 <ul style="list-style-type: none"> • 0x0: Not Applicable (Standby mode or source transition) • 0x1: External Video Parallel • 0x2: External Video OpenLDI • 0x3: Test Pattern • 0x4: Splash | Source change | No |
| 27:26 | External Source - Total Pixels Per Line Set to 0 while splash or test pattern are in use. | Source change | No |
| 29:28 | External Source - Total Lines Per Frame Set to 0 while splash or test pattern are in use. | Source change | No |
| 31:30 | External Source - Active Pixels Per Line Set to 0 while splash or test pattern are in use. | Source change | No |
| 33:32 | External Source - Active Lines Per Frame Set to 0 while splash or test pattern are in use. | Source change | No |
| 35:34 | Sequence Maximum Temperature Maximum sequence temperature that is currently being enforced. Bits 15:8 - Two's complement integer portion of temperature in Celsius Bits 7:4 - 1/16 Celsius steps always added to the integer portion. Note that this fraction is still added even if the integer portion is negative. Bits 3:0 - Unused | Per frame | No |
| 37:36 | Reserved | | |

Table 6-2. Diagnostic Memory Definition (continued)

| BYTE | DESCRIPTION | UPDATE RATE | SHOULD BE CLEARED |
|-------|--|---|-------------------|
| 39:38 | DMD Filtered Temperature Bits 15:8 - Two's complement integer portion of temperature in Celsius Bits 7:4 - 1/16 Celsius steps always added to the integer portion. Note that this fraction is still added even if the integer portion is negative. Bits 3:0 - Unused | Temperature read Approximately 125ms | No |
| 41:40 | TMP411 Local Filtered Temperature Bits 15:8 - Two's complement integer portion of temperature in Celsius Bits 7:4 - 1/16 Celsius steps always added to the integer portion. Note that this fraction is still added even if the integer portion is negative. Bits 3:0 - Unused | Temperature read Approximately 125ms | No |
| 43:42 | DMD VBIAS ADC Value Bits 15:0 - Two's complement integer format. 1mV scale. | Per frame | No |
| 45:44 | DMD VRESET ADC Value Bits 15:0 - Two's complement integer format. 1mV scale. | Per frame | No |
| 47:46 | DMD VOFFSET ADC Value Bits 15:0 - Two's complement integer format. 1mV scale. | Per frame | No |
| 53:48 | Reserved | | |
| 55:54 | Reserved | | |
| 64:56 | Reserved | | |

6.4 Test Descriptions

The DLP553X-Q1 chipset includes diagnostic features to aid in the detection of potential failures. These features are grouped into two categories:

- Non-Periodic - Run while the system is not displaying an image, typically at power-up or power-down.
- Periodic - Execute continuously while an image is being displayed.

6.4.1 Periodic Tests

These tests can be executed continuously in certain modes. These tests do not corrupt or interfere with normal operation of the system. Some tests may be controlled by the host, but others will run continuously as functions are in use. For example, the frame memory buffer swap watchdog will always be enabled while the frame memory is being used.

Figure 6-1 shows a block diagram with labels on DLPC230-Q1 internal blocks and various system components. These labels are used in Table 6-3 to identify the coverage of each test.

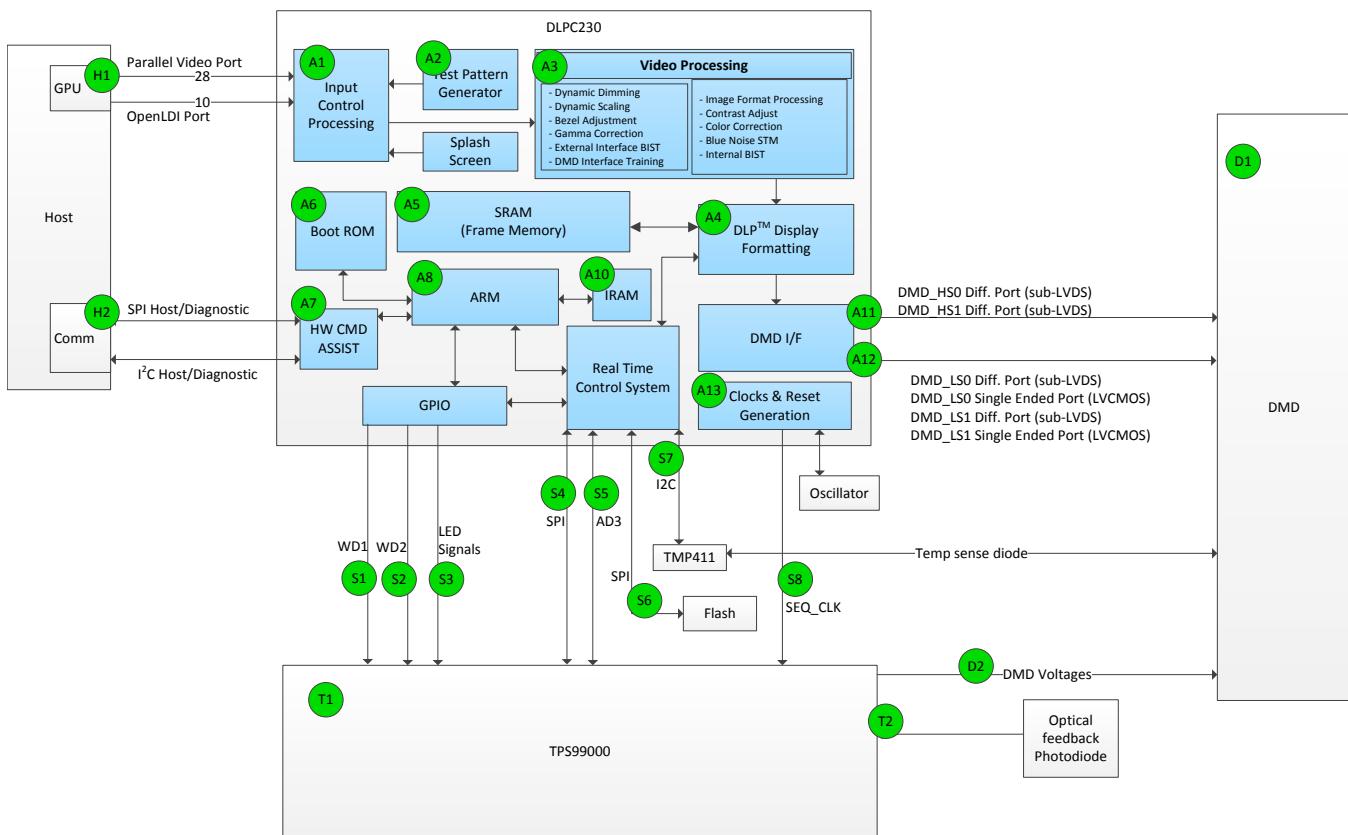


Figure 6-1. Test Coverage System Block Diagram

Table 6-3. Periodic Tests Overview

| TEST | COVERAGE | HOST-CONTROLLED | FAIL ACTION | SECTION |
|---|-------------------|------------------|---|----------------------------------|
| Video Source Loss | H1, A1, A3 | Continuously run | Alternate Source | Section 6.4.1.1 |
| Video Tell-Tale Checksum | H1, A1, A3 | Yes | Log error / Alternate Source / Emergency Shutdown | Section 6.4.1.2 |
| Video Frame Counter Checksum | H1, A1, A3 | Yes | Log error / Alternate Source / Emergency Shutdown | Section 6.4.1.2 |
| Average Picture Level | H1, A1, A3 | Yes | Log Error / Emergency Shutdown | Section 6.4.1.4 |
| Loss of Ping Command | H2 | Yes | Alternate Source | Section 6.4.1.5 |
| DLPC230-Q1 Processor Memory ECC | A10 | Continuously run | Emergency Shutdown | Section 6.4.1.6 |
| Flash Table Transport CRC | S6 | Continuously run | Log Error | Section 6.4.1.7 |
| Frame Buffer Swap Watchdog | A4, A5 | Continuously run | Emergency Shutdown | Section 6.4.1.8 |
| Sequencer Instruction Read Watchdog | A4 | Continuously run | Emergency Shutdown | Section 6.4.1.9 |
| DMD Reset Instruction Watchdog | A4, A11 | Continuously run | Emergency Shutdown | Section 6.4.1.10 |
| DLPC230-Q1 System Voltage Monitor | Voltage Rails, S5 | Continuously run | Log Error | Section 6.4.1.11 |
| DLPC230-Q1 DMD Voltage Monitor | D2, S5 | Continuously run | Emergency Shutdown | Section 6.4.1.12 |
| DLPC230-Q1 TPS99000-Q1 Bandgap Monitor | T1, S5 | Continuously run | Log Error | Section 6.4.1.13 |
| DMD Temperature Monitor | D1 | Continuously run | Standby mode | Section 6.4.1.14 |
| DMD Clock Monitor | A13 | Continuously run | Emergency Shutdown | Section 6.4.1.15 |
| DMD High Speed Interface Training | A11, A12, D1 | Continuously run | Log Error | Section 6.4.1.16 |
| DMD Low Speed Interface Test | A12, D1 | Continuously run | Log Error | Section 6.4.1.17 |
| TPS99000-Q1 DLPC230-Q1 Processor Watchdog (WD1) | A8, S1 | Continuously run | System Reset | Section 6.4.1.18 |
| TPS99000-Q1 DLPC230-Q1 Sequencer Watchdog (WD2) | A4, S2 | Continuously run | Attempt to correct Emergency Shutdown | Section 6.4.1.19 |
| TPS99000-Q1 Temperature Warning / Error | T1 | Continuously run | Log Error System Reset | Section 6.4.1.20 |
| TPS99000-Q1 Clock Ratio Monitor | A13, S8 | Continuously run | Log Error | Section 6.4.1.21 |
| TPS99000-Q1 Register Password Lock | T1 | Continuously run | | Section 6.4.1.22 |
| TPS99000-Q1 Register Checksum | T1 | Continuously run | Attempt to correct Emergency Shutdown | Section 6.4.1.23 |
| Software Monitor Thread | A8 | Continuously run | Log Error | Section 6.4.1.24 |

6.4.1.1 Video Source Loss Detection

While external video is being displayed, this test monitors the external source VSYNC, pixel clock, active lines per frame, and active pixels per line every frame to verify that the source signals are stable.

The test will take action if:

- VSYNC is out of range
- Pixel clock is out of range
- Active lines per frame does not match the expected value
- Active pixels per line does not match the expected value

6.4.1.1.1 Configuration

The following configuration options are set in flash. The value of these parameters can be found in the flash header file that is provided along with the flash binary file.

Table 6-4. Video Source Loss Parameters

| PARAMETER | DESCRIPTION |
|------------------------------|--|
| Alternate Source On Failure | Any test pattern or splash image to be displayed upon source loss. |
| Auto-recover | 0x0: Once the test fails, alternate source will continue to display even if the external source returns to a valid range. Host action is required to change to external source after failure. 0x1: If the test passes after failing, the system will return to displaying the external source. This does not require host action. |
| Pixel Clock maximum, minimum | Maximum and minimum allowable pixel clock frequency. This is generally set to $\pm 2\%$ of the nominal pixel clock. |
| VSYNC maximum, minimum | Maximum and minimum allowable VSYNC frequency. This is set to the VSYNC range specified in the DLPC230-Q1 data sheet. |
| Active Lines Per Frame | Vertical resolution of the external source. |
| Active Pixels Per Line | Horizontal resolution of the external source. |

6.4.1.1.2 Execution

This test is always executed when an external source is in use.

6.4.1.1.3 Failure Actions

If the source was initially in-range, a failure will trigger the display of an alternate internal video source. This can be configured as any test pattern or splash image stored in flash. If the source is initially out-of-range during configuration or during a transition to display, no image will be displayed.

Table 6-5 describes various source scenarios and the action that will be taken.

Table 6-5. Video Source Loss Failures

| CONFIGURATION | EVENT | ACTION |
|----------------|-------------------------------|---|
| Source valid | Standby to Display transition | Display external source |
| Source invalid | Standby to Display transition | Stay in standby Log Error |
| Source valid | Source select command | Display external source |
| Source invalid | Source select command | Illumination disabled Log error |
| Source valid | Source valid to invalid | Display alternate image Log error |
| Source invalid | Source invalid to valid | Display external source IF auto-recover |

6.4.1.1.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-6. Video Source Loss Detection Error Codes

| ERROR CODE | DESCRIPTION |
|------------|--|
| 665 | External source measured active lines per frame does not match source definition. |
| 666 | External source measured active pixels per line does not match source definition. |
| 671 | External source Open LDI port pixel clock frequency is not within the allowable range. |
| 674 | External source parallel port pixel clock frequency is not within the allowable range. |
| 676 | External source pixel clock above the allowable range. |
| 677 | External source pixel clock below the allowable range. |
| 678 | External source VSYNC frequency greater than defined maximum. |
| 679 | External source VSYNC frequency less than defined minimum. |
| 913 | External source has been lost. |
| 914 | External source has been lost and attempt to transition to alternate source failed. |
| 946 | Expected VSYNC signal did not arrive in the time allocated. |

6.4.1.2 Video Tell-Tale Checksum

This test performs a checksum of the pixels within a specified region of video pixel data that is expected to remain static across multiple frames. The host provides an expected checksum for the specified pixel region. DLPC230-Q1 hardware calculates the checksum of the specified region every frame and compares this to the host-specified checksum. If a mismatch is detected between the expected and calculated checksum after any video frame, the test will take action.

6.4.1.2.1 Configuration

External Video Checksum Settings command is used to specify the desired window of video pixels and the expected checksum. This command can also be read to confirm the actual checksum of the current video data.

Figure 6-2 demonstrates the checksum region configuration.

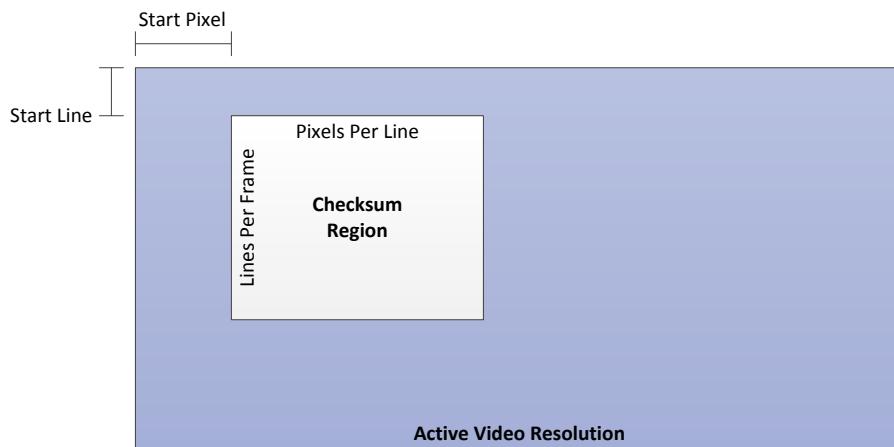


Figure 6-2. Video Tell-Tale Checksum Configuration

The following equation is used to calculate the checksum. For each pixel within the specified window, sum the red, green, and blue level and add it to the checksum. If the value exceeds 32-bits (0xFFFFFFFF), the checksum rolls over to 0.

$$CS(n) = (CS(n-1) + R(n) + G(n) + B(n)) \& 0xFFFFFFFF$$

Where:

- "n" is the current pixel that is being added to the checksum
- "CS(n)" is the current checksum
- "CS(n-1)" is the previous checksum. The initial value is 0.
- "R(n)", "G(n)", "B(n)" are the red, green, and blue components of the current pixel, each with a value of 0 to 255.

Settings should only be modified while the test is disabled. If changes need to be made to the settings, the test should be disabled and then re-enabled after settings have been applied.

6.4.1.2.2 Execution

External Video Checksum Control command is used to enable or disable the test. Note that video tell-tale and video frame counter cannot be executed at the same time.

6.4.1.2.3 Failure Actions

The failure action is flash-configurable. Software may log an error, switch to the alternate display source, or execute an emergency shutdown.

6.4.1.2.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-7. Video Tell-Tale Checksum Error Codes

| ERROR CODE | DESCRIPTION |
|------------|--|
| 238 | Command error: Attempted to change external video checksum settings, but external video checksum is enabled. |
| 535 | External video checksum failed due to checksum mismatch. |

6.4.1.3 Video Frame Counter Checksum

This test utilizes the video tell-tale checksum hardware to confirm that the video frame is being updated by the input graphics processor each frame. It cannot be executed at the same time as the video tell-tale checksum since they rely on the same hardware.

A pixel region is specified by host command and the checksum of the pixel data within that region must increment by 1 each frame until the value reaches its maximum value. Once the checksum has reached its maximum value, the value must roll over to 0 and the pattern repeats. If the value does not increment in a frame, the test will take action. The maximum and minimum frame count values are flash settings.

The following equation is used to calculate the checksum. For each pixel within the specified window, sum the red, green, and blue level and add it to the checksum.

$$CS(n) = (CS(n-1) + R(n) + G(n) + B(n)) \& 0xFFFFFFFF$$

Where:

- "n" is the current pixel that is being added to the checksum
- "CS(n)" is the current checksum
- "CS(n-1)" is the previous checksum. The initial value is 0.
- "R(n)", "G(n)", "B(n)" are the red, green, and blue components of the current pixel, each with a value of 0 to 255.

There are several possible implementations of this frame counter that can be used by a graphics processor to fulfill this test's requirements.

6.4.1.3.1 One-Pixel Frame Counter

This implementation uses one pixel in a corner of the active video. The red and green values of this pixel are set to 0, and the blue value is incremented from 0 to 7 each frame. This pixel remains effectively black across all frames due to the low maximum pixel value (R 0, G 0, B 7). The value of the frame counter checksum is equal to the blue value of this single pixel since it is the only pixel within the checksum region and its red and green values are 0.

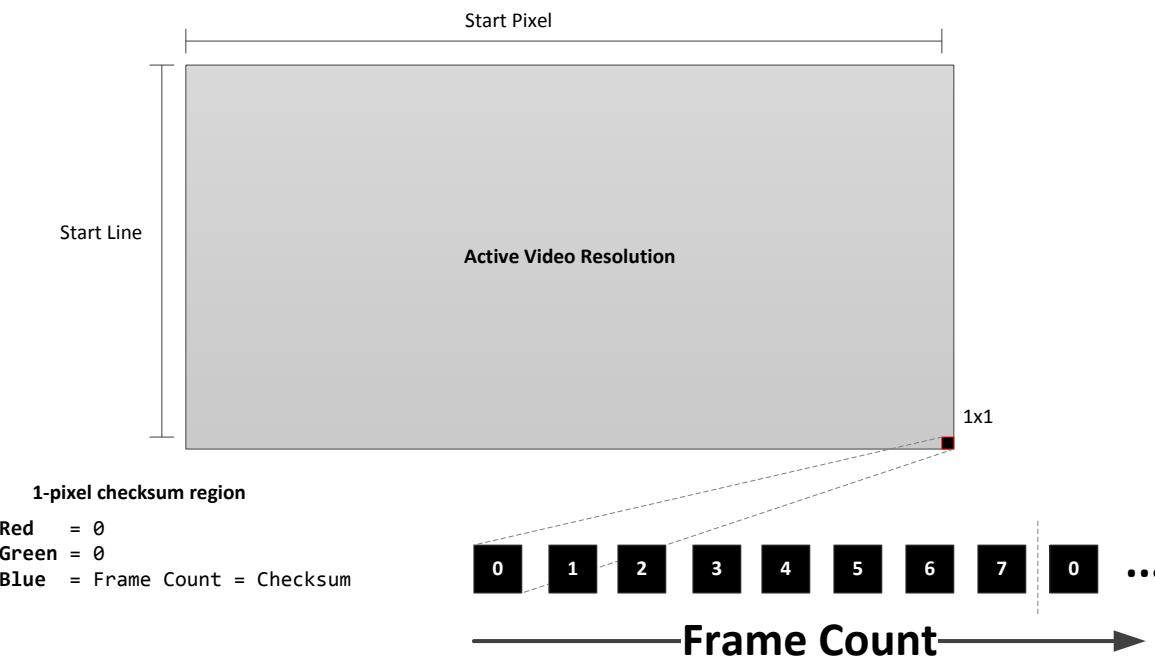


Figure 6-3. One-Pixel Frame Counter

6.4.1.3.2 Seven-Pixel Frame Counter

This implementation uses seven pixels in the corner of the active video. The red and green values of these pixels are set to 0, and the blue values are set to 0 or 1 each frame. Each frame an additional blue pixel within the region is set to 1 to increment the checksum from 0 to 7. The advantage of this implementation is that each pixel's maximum value is (R 0, G 0, B 1). The disadvantage is that it requires a larger checksum region where these pixels will effectively appear black and cannot be used for other video content.

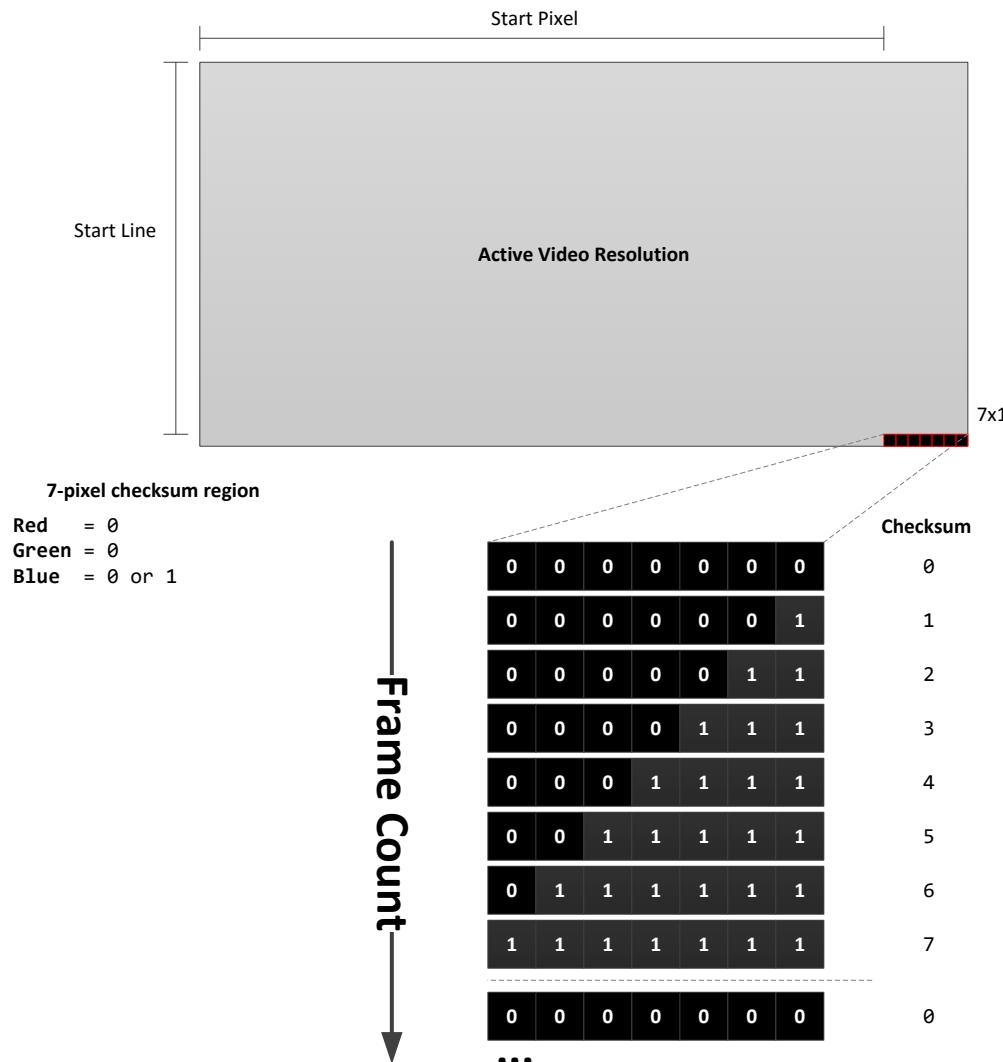


Figure 6-4. Seven-Pixel Frame Counter

6.4.1.3.3 Configuration

[External Video Checksum Settings](#) command is used to specify the desired window of video pixels. This command can also be read to confirm the actual checksum of the current video data.

[Figure 6-5](#) demonstrates the checksum region configuration.

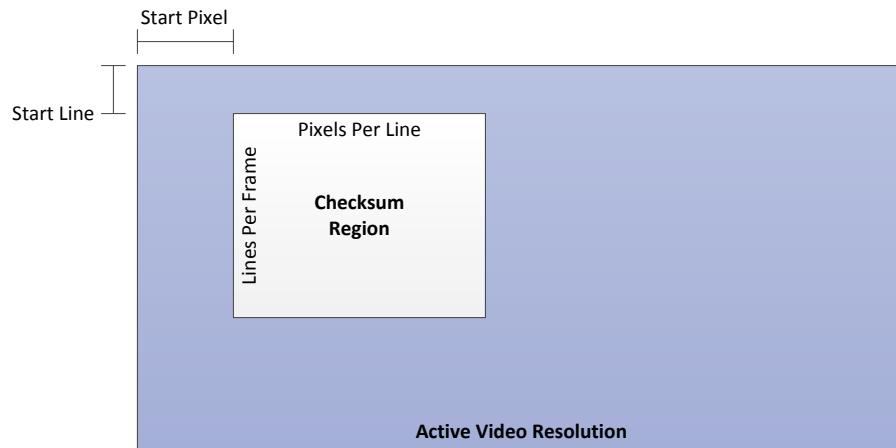


Figure 6-5. Video Frame Counter Checksum Configuration

Settings should only be modified while the test is disabled. If changes need to be made to the settings, the test should be disabled and then re-enabled after settings have been applied.

6.4.1.3.4 Execution

External Video Checksum Control command is used to enable or disable the test. Note that video tell-tale and video frame counter cannot be executed at the same time.

6.4.1.3.5 Failure Actions

The failure action is flash-configurable. Software may log an error, switch to the alternate display source, or execute an emergency shutdown.

6.4.1.3.6 Error Codes

The following error codes indicate a failure was detected:

Table 6-8. Video Frame Counter Checksum Error Codes

| ERROR CODE | DESCRIPTION |
|------------|---|
| 558 | External video frame count out of sequence. |
| 760 | Video frame counter failed to lock due to value out of range. |

6.4.1.4 Average Picture Level

This test checks the average level of the incoming video pixel data. The host specifies an expected maximum average level for the incoming data. The main application will compare this host-specified maximum to the actual level each frame. If the actual picture level exceeds the host-specified maximum, the test will take action.

6.4.1.4.1 Configuration

Average Picture Level Control command is used to configure this test.

The following procedure is used to calculate the average picture level for all active pixels in a video frame.

- Pixel_Brightness = Round((Red + Green + Blue) / 3)
 - Where Red, Green, Blue are 8-bit values from 0-255
- Line_Brightness = Round(Sum(Pixel_Brightness[0:Horizontal_Resolution]) / Horizontal_Resolution)
- Picture_Brightness = Round (Sum(Line_Brightness[0:Vertical_Resolution]) / Vertical_Resolution)

The resulting Picture_Brightness should be an 8-bit value from 0 to 255.

6.4.1.4.2 Execution

Average Picture Level Control command is used to enable or disable this test.

6.4.1.4.3 Failure Actions

This test can be configured to take two actions upon threshold exceeded:

- Log an error, but continue to display external source
- Execute emergency shutdown

6.4.1.4.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-9. Average Picture Level Error Codes

| ERROR CODE | DESCRIPTION |
|------------|---|
| 915 | Average Picture Level exceeded its specified limit. |

6.4.1.5 Loss of Ping Command

This test monitors for ping commands within a specified number of milliseconds. Each time a command is received the timer resets to zero. If the timer reaches the specified maximum time, the test will take action. This acts as a watchdog timeout on host communication.

6.4.1.5.1 Configuration

[Loss of Ping Control](#) command is used to specify a time period in which each command must be sent and enable or disable this test.

The time window can also be specified to a default value in flash.

6.4.1.5.2 Execution

[Loss of Ping Control](#) command is also used to enable or disable this test. The default enable or disable state can also be specified in flash.

[Headlight Ping - Write](#) command is used to periodically satisfy the timeout condition.

6.4.1.5.3 Failure Actions

An alternate source will be displayed on failure. This alternate source is the same source that [Video Source Loss Detection](#) uses on failure.

6.4.1.5.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-10. Loss of Ping Error Codes

| ERROR CODE | DESCRIPTION |
|------------|--|
| 222 | Loss of ping BIST failed. No dimming / ping command was received within the configured time frame. |

6.4.1.6 DLPC230-Q1 Processor Memory ECC

The DLPC230-Q1 ARM processor's memory includes ECC that hardware uses to detect multi-bit errors and correct 1-bit errors. If a multi-bit error occurs, the main application will attempt to take action.

6.4.1.6.1 Configuration

No configuration is required.

6.4.1.6.2 Execution

ECC detection is always run during operation.

6.4.1.6.3 Failure Actions

The main application will attempt to perform an emergency shutdown.

6.4.1.6.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-11. DLPC230-Q1 Processor Memory ECC Error Codes

| ERROR CODE | DESCRIPTION |
|------------|---------------------------------------|
| 954 | Multi-bit ECC memory error detected. |
| 955 | Single-bit ECC memory error detected. |

6.4.1.7 Flash Table Transport CRC

Look-up tables, such as sequences, are CRC-verified while being transferred from flash. Once the table is written to internal memory, hardware calculates a CRC of the data and compares it to the CRC value that was calculated while the table was being read from flash. If the CRC is incorrect, this test will take action.

6.4.1.7.1 Configuration

No configuration is required.

6.4.1.7.2 Execution

This test is always executed during table data transport.

6.4.1.7.3 Failure Actions

The table will be reloaded and the main application will log the error.

6.4.1.7.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-12. Flash Table Transport CRC Error Codes

| ERROR CODE | DESCRIPTION |
|------------|--|
| 526 | Flash Table Transport CRC failed. CRC error while transferring the table from flash. |
| 653 | Flash Table Type 1 CRC failed. |
| 658 | Flash Table Type 5 memory access failed. |
| 659 | Flash Table Type 5 CRC failed. |
| 660 | Flash Table Type 6 CRC failed. |
| 661 | Flash Table Type 7 CRC failed. |
| 663 | Flash Table Type 8 CRC failed. |
| 664 | Flash Table Type 9 access failed. |

6.4.1.8 Frame Buffer Swap Watchdog

The DLPC230-Q1 video frame memory is double-buffered. The main application configures a watchdog timer for the buffer swap and each buffer swap event resets the timer. If the timer expires, the buffers did not swap as expected and the main application takes action. The timer is configured to be approximately 9 frame times in length.

6.4.1.8.1 Configuration

No configuration is required.

6.4.1.8.2 Execution

This test is always executed while displaying external source and test pattern. The test is not executed while displaying splash images because of the longer buffer swap time required for splash images.

6.4.1.8.3 Failure Actions

Emergency shutdown will be performed on failure.

6.4.1.8.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-13. Frame Buffer Swap Watchdog Error Codes

| ERROR CODE | DESCRIPTION |
|------------|--|
| 969 | Frame memory buffer swap watchdog error. |

6.4.1.9 Sequencer Instruction Read Watchdog

This test monitors video sequencer instruction processing. The main application sets up a hardware timer and each sequencer instructions will reset this timer. The timer is configured to be approximately 9 frame times in length.

6.4.1.9.1 Configuration

No configuration is required.

6.4.1.9.2 Execution

This test is always executed while displaying an image.

6.4.1.9.3 Failure Actions

Emergency shutdown will be performed on failure.

6.4.1.9.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-14. Sequencer Instruction Read Watchdog Error Codes

| ERROR CODE | DESCRIPTION |
|------------|---------------------------------------|
| 968 | Sequencer instruction watchdog error. |

6.4.1.10 DMD Reset Instruction Watchdog

This test monitors for DMD bias and reset instructions sent from the DLPC230-Q1 to the DMD while displaying an image. Failure indicates that the DMD mirrors may not be moving as intended since no reset instructions are being sent.

6.4.1.10.1 Configuration

No configuration is required.

6.4.1.10.2 Execution

This test is always executed while displaying an image.

6.4.1.10.3 Failure Actions

Emergency shutdown will be performed on failure.

6.4.1.10.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-15. Sequencer Instruction Read Watchdog Error Codes

| ERROR CODE | DESCRIPTION |
|------------|---------------------------------------|
| 967 | DMD reset instruction watchdog error. |

6.4.1.11 DLPC230-Q1 System Voltage Monitor

This test monitors system voltage levels each frame using TPS99000-Q1 ADC measurements. The following voltages are monitored:

- P1P1V
- P1P8V
- P3P3V
- VMAIN
- DVDD
- LDOT_M8
- ADC_VREF
- DRVR_PWR

If any of these voltages are measured outside of a specified maximum and minimum value, the test will take action. The monitor ranges are specified in the flash header file provided along with the flash binary file. The true voltage operating ranges are specified in the DLPC230-Q1 Data Sheet and TPS99000-Q1 Data Sheet. The monitor ranges used for this test are set wider than the true voltage operating ranges to account for measurement tolerances.

6.4.1.11.1 Configuration

No configuration is required.

6.4.1.11.2 Execution

This test is always executed during display mode.

6.4.1.11.3 Failure Actions

An error will be logged on failure.

6.4.1.11.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-16. DLPC230-Q1 System Voltage Monitor Error Codes

| ERROR CODE | DESCRIPTION |
|------------|---|
| 843 | System 1.1V rail out of range. |
| 844 | System 1.8V rail out of range. |
| 845 | System 3.3V rail out of range. |
| 846 | ADC external VREF voltage out of range. |
| 847 | DVDD voltage out of range. |
| 848 | LDOT_M8 voltage out of range. |
| 849 | VMAIN voltage out of range. |
| 1015 | Driver power voltage out of range. |

6.4.1.12 DLPC230-Q1 DMD Voltage Monitor

This test monitors the DMD reset voltage levels each frame using TPS99000-Q1 ADC measurements. The following voltages are monitored:

- VBIAS
- VRESET
- VOFFSET

If any of these voltages are measured outside of a specified maximum and minimum value, the test will take action. The allowable ranges are specified in the flash header file provided along with the flash binary file.

6.4.1.12.1 Configuration

No configuration is required.

6.4.1.12.2 Execution

This test is always executed during display mode.

6.4.1.12.3 Failure Actions

Emergency shutdown will be performed on failure.

6.4.1.12.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-17. DLPC230-Q1 DMD Voltage Monitor Error Codes

| ERROR CODE | DESCRIPTION |
|------------|--|
| 949 | DMD VRESET voltage reading is out of range. |
| 950 | DMD VOFFSET voltage reading is out of range. |
| 951 | DMD VBIAS voltage reading is out of range. |

6.4.1.13 DLPC230-Q1 TPS99000-Q1 Bandgap Monitor

The TPS99000-Q1 includes two bandgap voltage references: one is used in the ADC measurement system and one is used in the control systems. The ADC measures the scaled voltage of the control bandgap reference. Using the ADC system to measure the control bandgap ensures that the two bandgap references match. The DLPC230-Q1 reads this ADC measurement each frame. If this bandgap reference voltage is measured outside of a specified maximum and minimum value, the test will take action. The monitor ranges are specified in the flash header file provided along with the flash binary file.

6.4.1.13.1 Configuration

No configuration is required.

6.4.1.13.2 Execution

This test is always executed during display mode.

6.4.1.13.3 Failure Actions

An error will be logged on failure.

6.4.1.13.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-18. DLPC230-Q1 TPS99000-Q1 Bandgap Monitor Error Codes

| ERROR CODE | DESCRIPTION |
|------------|--|
| 1008 | External bandgap voltage out of range. |

6.4.1.14 DMD Temperature Monitor

The DLPC230-Q1 uses an external TMP411 to periodically read the DMD temperature using a temperature sensing diode built into the DMD. The main application monitors for the following conditions to take action:

- DMD over maximum park temperature
- DMD below minimum park temperature

[Section 5.6](#) further describes temperature management.

6.4.1.14.1 Configuration

The maximum and minimum threshold temperature are set in flash.

6.4.1.14.2 Execution

This test is always executed.

6.4.1.14.3 Failure Actions

The main application will enter Standby mode to park the DMD. The main application will stay in Standby until the host requests a different operating mode. The operating mode command may receive an error if the respective DMD un-park temperature has not yet been reached. This is intended to avoid repeated temperature-related failures that may be caused by DMD temperature variation when illumination is enabled and disabled. If the DMD maximum threshold temperature is reached, the DMD voltages will be turned off in Standby mode.

6.4.1.14.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-19. DMD Temperature Monitor Error Codes

| ERROR CODE | DESCRIPTION |
|------------|--|
| 895 | Temperature is lower than the minimum DMD park temperature. |
| 896 | Temperature is higher than the maximum DMD park temperature. |

6.4.1.15 DMD Clock Monitor

The DMD clock generator is monitored to ensure that it continually operates within a specified frequency range. The main application sets up a hardware monitor upper and lower frequency limit. Hardware will flag an error if the clock frequency leaves this specified window.

6.4.1.15.1 Configuration

No configuration is required.

6.4.1.15.2 Execution

This test is always executed while the high-speed DMD interface is in use.

6.4.1.15.3 Failure Actions

Emergency shutdown will be performed on failure.

6.4.1.15.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-20. DMD Clock Monitor Error Codes

| ERROR CODE | DESCRIPTION |
|------------|-------------------------|
| 898 | DMD clock out of range. |

6.4.1.16 DMD High Speed Interface Training

The main application performs training of the high speed sub-LVDS data eye while the DMD high-speed interface is in use. This maintains optimized clock alignment over environmental conditions such as temperature. Every pin on the high-speed and low-speed bus is exercised during this tuning process, so any connection faults should be detected by the training. The training results are read back on the low-speed bus. If no valid training data is found for one or more lanes, the main application will take action.

6.4.1.16.1 Configuration

No configuration is required.

6.4.1.16.2 Execution

This test is always executed during display mode.

6.4.1.16.3 Failure Actions

An error will be logged on failure.

6.4.1.16.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-21. DMD High Speed Interface Training Error Codes

| ERROR CODE | DESCRIPTION |
|------------|---|
| 556 | DMD HS training failed: returned invalid results. |
| 573 | DMD HS training failed: real-time test controller HS training error 1. |
| 574 | DMD HS training failed: real-time test controller HS training error 2. |
| 575 | DMD HS training failed: real-time test controller HS training error 3. |
| 576 | DMD HS training failed: real-time test controller HS training processing error. |

6.4.1.17 DMD Low Speed Interface Test

The main application writes data to a reserved DMD register and then reads the value from the same register to confirm that the value matches the written value. The main application also periodically reads the DMD configuration registers to verify that the DMD register content remains correctly programmed. If an incorrect value is detected in any of these registers, the main application will take action.

6.4.1.17.1 Configuration

No configuration is required.

6.4.1.17.2 Execution

This test is always executed while the DMD low-speed interface is in use (Display mode).

6.4.1.17.3 Failure Actions

The register values will be re-written and the error will be logged.

6.4.1.17.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-22. DMD Low Speed Interface Test Error Codes

| ERROR CODE | DESCRIPTION |
|------------|--|
| 577 | DMD Low Speed validation failed: processing error. |

6.4.1.18 TPS99000-Q1 DLPC230-Q1 Processor Watchdog (WD1)

The TPS99000-Q1 includes a watchdog that monitors a periodic pulse generated by the DLPC230-Q1 using a DLPC230-Q1 GPIO pin. This is used to confirm that the DLPC230-Q1 main application is functional. The main application configures the watchdog window during system initialization. If the pulse is not detected within the specified window, the TPS99000-Q1 will take action.

6.4.1.18.1 Configuration

A DLPC230-Q1 GPIO connects to TPS99000-Q1 WD1 signal for this monitoring. Refer to DLPC230-Q1 Data Sheet GPIO configuration for the specific GPIO.

6.4.1.18.2 Execution

This test is always executed.

6.4.1.18.3 Failure Actions

The TPS99000-Q1 will signal a park of the DMD and reset the chipset. The main application will read the reset cause from the TPS99000-Q1 and assert HOST_IRQ during reset initialization.

6.4.1.18.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-23. TPS99000-Q1 DLPC230-Q1 Processor Watchdog Error Codes

| ERROR CODE | DESCRIPTION |
|------------|---|
| 1011 | TPS99000-Q1 watchdog 1 did not detect a rising edge within the expected trigger window. |

6.4.1.19 TPS99000-Q1 DLPC230-Q1 Sequencer Watchdog (WD2)

The TPS99000-Q1 includes a watchdog that monitors DLPC230-Q1 sequencer operation. The main application configures the TPS99000-Q1 watchdog window to approximately 7 frame times in length. If the SEQ_START pulse is not detected within the specified window, the TPS99000-Q1 will interrupt the DLPC230-Q1 main application to take action.

6.4.1.19.1 Configuration

SEQ_START from the DLPC230-Q1 connects to TPS99000-Q1 WD2 signal for this monitoring.

6.4.1.19.2 Execution

This test is always executed while displaying an image.

6.4.1.19.3 Failure Actions

The sequencer will attempt to disable and re-enable the sequencer for 3 consecutive failures. On the fourth failure, an emergency shutdown will be performed. When the sequencer is disabled, the display will be lost momentarily.

6.4.1.19.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-24. TPS99000-Q1 DLPC230-Q1 Sequencer Watchdog Error Codes

| ERROR CODE | DESCRIPTION |
|------------|---|
| 1012 | TPS99000-Q1 watchdog 2 did not detect a rising edge within the expected trigger window. |

6.4.1.20 TPS99000-Q1 Temperature Warning / Error

The TPS99000-Q1 includes temperature detection for a warning and error threshold temperature. A temperature warning will set a status register and notify the DLPC230-Q1 main application which will take an initial warning action. If the error threshold is exceeded, the TPS99000-Q1 will take an error action. The TPS99000-Q1 Data Sheet specifies the warning and error threshold temperature levels.

6.4.1.20.1 Configuration

No configuration is required.

6.4.1.20.2 Execution

This test is always executed.

6.4.1.20.3 Failure Actions

Warning: An error will be logged to notify of the TPS99000-Q1 temperature warning.

Error: The TPS99000-Q1 will park the DMD and enter an off state. The TPS99000-Q1 will not exit this state until the temperature returns to a valid operating temperature.

6.4.1.20.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-25. TPS99000-Q1 Temperature Warning/Error Error Codes

| ERROR CODE | DESCRIPTION |
|------------|--|
| 890 | TPS99000-Q1 thermal conditions on chip have reached the warning level. If temperature continues to rise, system will reach die over-temp error temperature and emergency actions will be taken by TPS99000-Q1. |

6.4.1.21 TPS99000-Q1 Clock Ratio Monitor

The TPS99000-Q1 calculates a ratio between its internal clock and the external DLPC230-Q1 clock input in order to validate proper frequency operation of the main DLPC230-Q1 clock source. The DLPC230-Q1 main application periodically reads this ratio and takes action if the ratio is outside of the expected range.

6.4.1.21.1 Configuration

No configuration is required.

6.4.1.21.2 Execution

This test is always executed.

6.4.1.21.3 Failure Actions

The error is logged if the ratio is out of range.

6.4.1.21.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-26. TPS99000-Q1 Clock Ratio Monitor Error Codes

| ERROR CODE | DESCRIPTION |
|------------|--|
| 961 | Sequence clock ratio is not within the specified limits. |

6.4.1.22 TPS99000-Q1 Register Password Lock

The TPS99000-Q1 includes a password lock on register banks to prevent unexpected register changes. During operation the main application writes register values to the TPS99000-Q1 and then sets the password lock until the next register update must be performed.

6.4.1.22.1 Configuration

No configuration is required.

6.4.1.22.2 Execution

This function is always performed while TPS99000-Q1 registers are written.

6.4.1.22.3 Failure Actions

No failure action.

6.4.1.22.4 Error Codes

No associated error codes.

6.4.1.23 TPS99000-Q1 Register Checksum

The TPS99000-Q1 includes checksum coverage of critical illumination-related registers. During operation the main application writes register values to the TPS99000-Q1 and then updates the checksum values to match the newly written values. If a checksum error is detected and reported by the TPS99000-Q1, the main application will take action.

6.4.1.23.1 Configuration

No configuration is required.

6.4.1.23.2 Execution

This test is always executed while TPS99000-Q1 registers are written.

6.4.1.23.3 Failure Actions

The main application will attempt to re-write all registers 3 times. If the failure persists, the main application will execute an emergency shutdown.

6.4.1.23.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-27. TPS99000-Q1 Register Checksum Error Codes

| ERROR CODE | DESCRIPTION |
|------------|---|
| 938 | TPS99000-Q1 checksum error in group 1 register set. |
| 939 | TPS99000-Q1 checksum error in group 2 register set. |
| 940 | TPS99000-Q1 checksum error in group 3 register set. |

6.4.1.24 Software Monitor Thread

The main application uses a real-time operating system (RTOS), and threads are created to support various aspects of functionality. A monitoring thread is also created with the purpose of checking that other threads are functioning as expected. Each thread must check in with the monitoring thread within a specified amount of time, or failure action will be taken.

6.4.1.24.1 Configuration

No configuration is required.

6.4.1.24.2 Execution

This test is always executed.

6.4.1.24.3 Failure Actions

The main application will log an error.

6.4.1.24.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-28. Software Monitor Thread Error Codes

| ERROR CODE | DESCRIPTION |
|------------|--|
| 634 | Thread is non-responsive within timeout. |

6.4.2 Non-Periodic Tests

Non-periodic tests are run while the system is not displaying an image, typically once at power-up or power-down. Non-periodic tests that can be commanded by the host must be executed while the main application is in Standby mode. The coverage of these tests requires full usage of data paths and specific internal configuration that cannot be accomplished while displaying an image. Optional tests can be setup through flash settings or host commands. Non-optional BISTs will always be performed.

Figure 6-6 shows a block diagram with numbering on DLPC230-Q1 internal blocks and various system components. The numbering is used in **Table 6-29** to identify the coverage of each test.

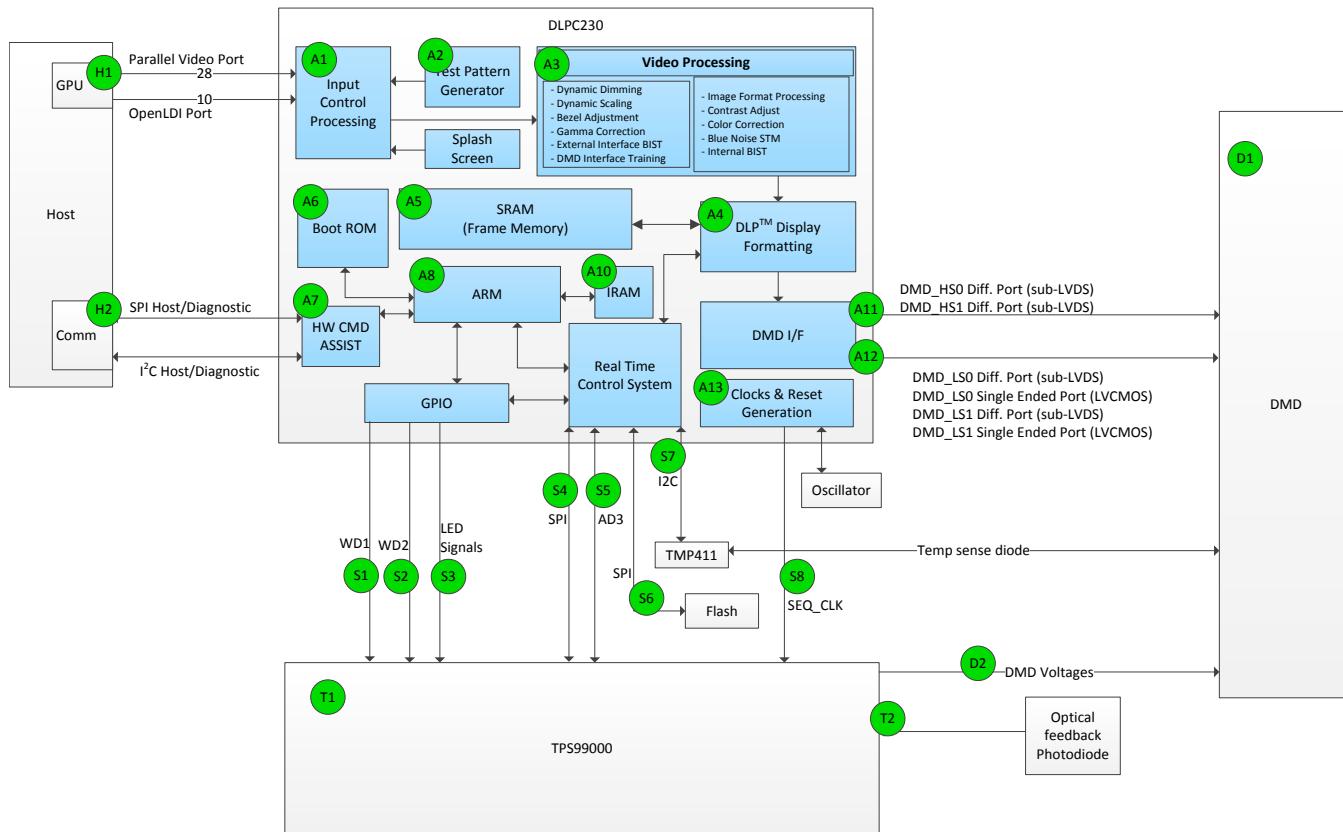


Figure 6-6. Test Coverage System Block Diagram

Table 6-29. Non-Periodic Tests Overview

| TEST | COVERAGE | APPLICATION | COMMAND | FLASH OPTION | FAIL ACTION | SECTION |
|--------------------------------------|------------|-------------|-----------------|-----------------|---|---------------------------------|
| DLPC230-Q1 Front End Functional Test | A1, A2, A3 | Main | Yes | Yes | Hold in Standby | Section 6.4.2.2 |
| DLPC230-Q1 Back End Functional Test | A3, A4 | Main | Yes | Yes | Hold in Standby | Section 6.4.2.3 |
| DLPC230-Q1 Memory BISTs | A3, A4, A5 | Main | Yes | Yes | Hold in Standby | Section 6.4.2.4 |
| TPS99000-Q1 Signal Interface Test | S3 | Main | No | Always Executed | Hold in Standby | Section 6.4.2.5 |
| DMD Memory Test | A12, D1 | Main | Yes | Yes | Hold in Standby | Section 6.4.2.6 |
| Flash Data Verification | S6 | Main / Boot | Yes | Yes | Hold in Standby (Main) Stay in Boot (Boot) | Section 6.4.2.7 |
| DLPC230-Q1 Boot ROM CRC | A6 | Boot | Always executed | | Stay in Boot | Section 6.4.2.8 |

Table 6-29. Non-Periodic Tests Overview (continued)

| TEST | COVERAGE | APPLICATION | COMMAND | FLASH OPTION | FAIL ACTION | SECTION |
|--|----------|-------------|-----------------|--------------|--------------|----------------------------------|
| DLPC230-Q1 Flash Table CRC | S6 | Boot | Always executed | | Stay in Boot | Section 6.4.2.9 |
| DLPC230-Q1 Main Application CRC | A10, A6 | Boot | Always executed | | Stay in Boot | Section 6.4.2.10 |
| DLPC230-Q1 Command and Flash Interface Memory Test | A7 | Boot | No | Yes | Stay in Boot | Section 6.4.2.11 |

6.4.2.1 Execution Time

Optional non-periodic tests will impact power-up time, and therefore the time to display image content. [Table 6-30](#) provides approximate execution times of non-periodic tests for design consideration. These values are not specifications, and actual execution times will vary.

Flash bandwidth will impact test speed since test data is stored in flash. Bandwidth is calculated as number of read lines multiplied by SPI data rate. For example, quad I/O SPI at 49.41MHz has a bandwidth of 197.64 Mbps.

A test setup time must be accounted for once if any number of tests are performed. Refer to [Table 6-31](#). The formula for execution time is $t_{\text{Test_Setup}} + \sum t_{\text{Test}}$. Test setup time does not apply to Boot Application tests.

Table 6-30. Non-Periodic Test Execution Time

| TEST | TIME (ms) | |
|---|-------------------------------------|---------------------------------------|
| | LOW FLASH BANDWIDTH (50.92 Mbps) | HIGH FLASH BANDWIDTH (197.64 Mbps) |
| DLPC230-Q1 Front End Functional Test | 20 | 18 |
| DLPC230-Q1 Back End Functional Test | 10 | 7 |
| DLPC230-Q1 Memory BISTs | 47 | 28 |
| TPS99000-Q1 Signal Interface Test | 3 | 2 |
| DMD Memory Test | 42 | 38 |
| Flash Data Verification (Boot) | | 180 |
| DLPC230-Q1 Command and Flash Interface Memory Test (Boot) | | 1 |

Table 6-31. Non-Periodic Test Setup Times

| TEST | TIME (ms) | |
|------------|-------------------------------------|---------------------------------------|
| | LOW FLASH BANDWIDTH (50.92 Mbps) | HIGH FLASH BANDWIDTH (197.64 Mbps) |
| Test Setup | 2 | 1 |

6.4.2.2 DLPC230-Q1 Front End Functional BIST (Main)

This set of tests generates test patterns and runs them through the entire video processing block. For each frame of data a CRC is generated and compared to the expected value. If any of the CRC values do not match the expected value, the main application will take action.

6.4.2.2.1 Configuration

No configuration is required.

6.4.2.2.2 Execution

A flash option determines whether this test is executed during initialization, prior to displaying an image. The value of this flash option is specified in the flash header file that is provided along with the flash data.

Execute Non-Periodic BIST command can be used to execute this test while in Standby mode.

6.4.2.2.3 Failure Actions

The main application will stay in Standby mode even if it receives a host command to transition to another mode.

6.4.2.2.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-32. DLPC230-Q1 Front End Functional BIST Error Codes

| ERROR CODE | DESCRIPTION |
|------------|------------------------|
| 524 | Front end BIST failed. |

6.4.2.3 DLPC230-Q1 Back End Functional BIST (Main)

This set of tests uses the video processing block to output test data through the entire back end formatting block. For each frame of data a CRC is generated and compared to the expected value. If any of the CRC values do not match the expected value, the main application will take action.

6.4.2.3.1 Configuration

No configuration is required.

6.4.2.3.2 Execution

A flash option determines whether this test is executed during initialization, prior to displaying an image. The value of this flash option is specified in the flash header file that is provided along with the flash data.

Execute Non-Periodic BIST command can be used to execute this test while in Standby mode.

6.4.2.3.3 Failure Actions

The main application will stay in Standby mode even if it receives a host command to transition to another mode.

6.4.2.3.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-33. DLPC230-Q1 Back End Functional BIST Error Codes

| ERROR CODE | DESCRIPTION |
|------------|-----------------------|
| 512 | Back end BIST failed. |

6.4.2.4 DLPC230-Q1 Memory BISTS (Main)

These tests are a series of writes, delays, and reads to most internal memories. If any of the read values do not match the expected result, the main application will take action.

6.4.2.4.1 Configuration

No configuration is required.

6.4.2.4.2 Execution

A flash option determines whether this test is executed during initialization, prior to displaying an image. The value of this flash option is specified in the flash header file that is provided along with the flash data.

[Execute Non-Periodic BIST](#) command can be used to execute this test while in Standby mode.

6.4.2.4.3 Failure Actions

The main application will stay in Standby mode even if it receives a host command to transition to another mode.

6.4.2.4.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-34. DLPC230-Q1 Memory BISTs Error Codes

| ERROR CODE | DESCRIPTION |
|------------|------------------------|
| 519 | Memory BIST 17 failed. |
| 520 | Memory BIST 18 failed. |
| 521 | Memory BIST 19 failed. |
| 522 | Memory BIST 20 failed. |
| 523 | Memory BIST 21 failed. |
| 530 | Memory BIST 1 failed. |
| 531 | Memory BIST 2 failed. |
| 533 | Memory BIST 22 failed. |
| 536 | Memory BIST 23 failed. |
| 537 | Memory BIST 24 failed. |
| 538 | Memory BIST 26 failed. |
| 539 | Memory BIST 25 failed. |
| 540 | Memory BIST 3 failed. |
| 541 | Memory BIST 12 failed. |
| 542 | Memory BIST 13 failed. |
| 543 | Memory BIST 14 failed. |
| 544 | Memory BIST 15 failed. |
| 545 | Memory BIST 16 failed. |
| 546 | Memory BIST 4 failed. |
| 547 | Memory BIST 5 failed. |
| 548 | Memory BIST 6 failed. |
| 549 | Memory BIST 7 failed. |
| 550 | Memory BIST 8 failed. |
| 551 | Memory BIST 9 failed. |
| 552 | Memory BIST 10 failed. |
| 553 | Memory BIST 11 failed. |

6.4.2.5 TPS99000-Q1 Interface Signal Connection Test (Main)

The DLPC230-Q1 main application forces values on each LEDSEL, SEN, and DEN signals to the TPS99000-Q1. It then reads back the signal states from the TPS99000-Q1 using SPI.

The test is considered a pass if the values of the signals that are read back do **not** match, since these signals are not intended to be connected between the DLPC230-Q1 and TPS99000-Q1 for headlight applications. If the signals are read back with the correct values, the test is considered a fail. A fail suggests that the hardware configuration may not match the flash data's expected product configuration.

6.4.2.5.1 Configuration

No configuration is required.

6.4.2.5.2 Execution

This test is always executed during main application initialization.

6.4.2.5.3 Failure Actions

The main application will stay in Standby mode even if it receives a host command to transition to another mode.

6.4.2.5.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-35. TPS99000-Q1 Interface Signal Connection Test Error Codes

| ERROR CODE | DESCRIPTION |
|------------|---|
| 532 | TPS99000-Q1 signal interface BIST failed. |

6.4.2.6 DMD Memory Test (Main)

The main application commands the DMD into a testing mode and the DMD writes known values into the memory cells below its pixels. The DMD then reads back the state of each memory cell and drives a signal to the DLPC230-Q1 to indicate pass or fail for each column of the DMD memory. A column is a top-to-bottom, width 1 array of memory cells (referred to as a DMD row by DMD design convention). A column will be reported as a fail if one or more memory cells in that column reads an incorrect value. The DLPC230-Q1 main application then sums the number of failed columns. Note that results cannot be reported at a per-memory-cell level of detail because the results are only transmitted to the DLPC230-Q1 at column-level granularity.

This process is executed four times and the number of failed columns are summed from each execution. The four executions includes two opposite checkerboard patterns on the two halves of the DMD. The use of two checkerboard patterns ensures that every memory cell is tested at both high and low state. Although the results of these four tests are summed, the data from each test is unique meaning that no memory cell fail should be counted more than once.

The pass/fail criteria are shown in [Table 6-36](#).

Table 6-36. DMD Memory Test Pass/Fail Criteria

| NUMBER OF COLUMN FAILS | TEST RESULT |
|------------------------|-------------|
| 0 or 1 | Pass |
| 2 or more | Fail |

6.4.2.6.1 Configuration

No configuration is required.

6.4.2.6.2 Execution

A flash option determines whether this test is executed during initialization, prior to displaying an image. The value of this flash option is specified in the flash header file that is provided along with the flash data.

[Execute Non-Periodic BIST](#) command can be used to execute this test while in Standby mode.

6.4.2.6.3 Failure Actions

The main application will stay in Standby mode even if it receives a host command to transition to another mode.

6.4.2.6.4 Error Codes

The following error codes indicate a failure was detected. If the test fails, both errors will be received on a single execution of the test. One error is informational to specify the actual number of columns that failed.

Table 6-37. DMD Memory Test Error Codes

| ERROR CODE | DESCRIPTION |
|------------|--|
| 220 | DMD Memory BIST columns failed. The information bits of this error indicate the number of columns that failed. |
| 221 | DMD Memory BIST failed. |

6.4.2.7 Flash Data Verification (Boot/Main)

Both the boot application and main application support flash verification by generating a CRC of flash data blocks and comparing them to the expected values stored with each flash block. This is typically performed immediately after flash programming, but it can also be performed as part of power-up or power-down. Note that this test requires reading the entire flash image so it can add significant time to power-up. The time will increase with the size of the flash image.

6.4.2.7.1 Configuration

No configuration is required.

6.4.2.7.2 Execution

- A flash option determines whether this test is executed during boot application initialization.
- *Flash Verify Data* (Main) command can be used to execute this test while in main application Standby mode.
- *Flash Verify Data* (Boot) command can be used to execute this test while in boot application.

The value of these flash options are specified in the flash header file that is provided along with the flash data.

6.4.2.7.3 Failure Actions

Boot application: The system will stay in boot application execution.

Main application: The system will stay in Standby mode even if it receives a host command to transition to another mode.

6.4.2.7.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-38. Flash Data Verification Error Codes

| ERROR CODE | DESCRIPTION |
|------------|---|
| 134 | A CRC error was detected while verifying the contents of the flash. |
| 762 | Flash data verification CRC failed. |

6.4.2.8 DLPC230-Q1 Boot ROM CRC (Boot)

The boot application runs a CRC on the boot ROM data and compares it to an expected value stored in the boot ROM memory.

6.4.2.8.1 Configuration

No configuration is required.

6.4.2.8.2 Execution

This test is always executed during boot application initialization prior to exercising any boot application functionality.

6.4.2.8.3 Failure Actions

The system stays in boot application execution if this test fails.

6.4.2.8.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-39. DLPC230-Q1 Boot ROM CRC Error Codes

| ERROR CODE | DESCRIPTION |
|------------|--|
| 131 | A CRC error was detected while transferring the boot application to RAM. |

6.4.2.9 DLPC230-Q1 Flash Table CRC (Boot)

The boot application always runs a CRC of the flash table at the top of flash and compares the calculated CRC to the CRC that is stored with the flash table. This flash table points to other addresses in flash that are used during operation. If the CRC values do not match, the boot application will take action.

6.4.2.9.1 Configuration

No configuration is required.

6.4.2.9.2 Execution

This test is always executed by boot application.

6.4.2.9.3 Failure Actions

The system stays in boot application execution if this test fails.

6.4.2.9.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-40. DLPC230-Q1 Flash Table CRC Error Codes

| ERROR CODE | DESCRIPTION |
|------------|---|
| 30 | A CRC error was detected while verifying the Flash table. |

6.4.2.10 DLPC230-Q1 Main Application CRC (Boot)

The DLPC230-Q1 boot application runs a CRC of the main application data by reading it from IRAM after it has been transferred from flash to IRAM. If this test fails, the boot application will take action.

6.4.2.10.1 Configuration

No configuration is required.

6.4.2.10.2 Execution

This test is always executed by boot application.

6.4.2.10.3 Failure Actions

The system stays in boot application execution if this test fails.

6.4.2.10.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-41. DLPC230-Q1 Main Application Transfer CRC Error Codes

| ERROR CODE | DESCRIPTION |
|------------|--|
| 132 | A CRC error was detected while transferring the main application to RAM. |
| 133 | A CRC error was detected after transferring the main application to RAM. |

6.4.2.11 DLPC230-Q1 Command and Flash Interface Memory Test (Boot)

The DLPC230-Q1 boot application can optionally run a memory test on the command interface memories and flash data access memories. These tests are a series of writes, delays, and reads to memory. If any of these tests fails, the boot application will take action.

6.4.2.11.1 Configuration

No configuration is required.

6.4.2.11.2 Execution

A flash option determines whether this test is executed.

6.4.2.11.3 Failure Actions

The system stays in boot application execution if this test fails.

6.4.2.11.4 Error Codes

The following error codes indicate a failure was detected:

Table 6-42. DLPC230-Q1 Command and Flash Interface Tests Error Codes

| ERROR CODE | DESCRIPTION |
|------------|--|
| 534 | DLPC230-Q1 Command and Flash Interface Memory test failed. |

6.4.3 Interface Tests

Interface tests are features built into communication protocols to confirm proper communication between chips.

Figure 6-7 shows a block diagram with numbering on DLPC230-Q1 internal blocks and various system components. The numbering is used in [Table 6-43](#) to identify the coverage of each test.

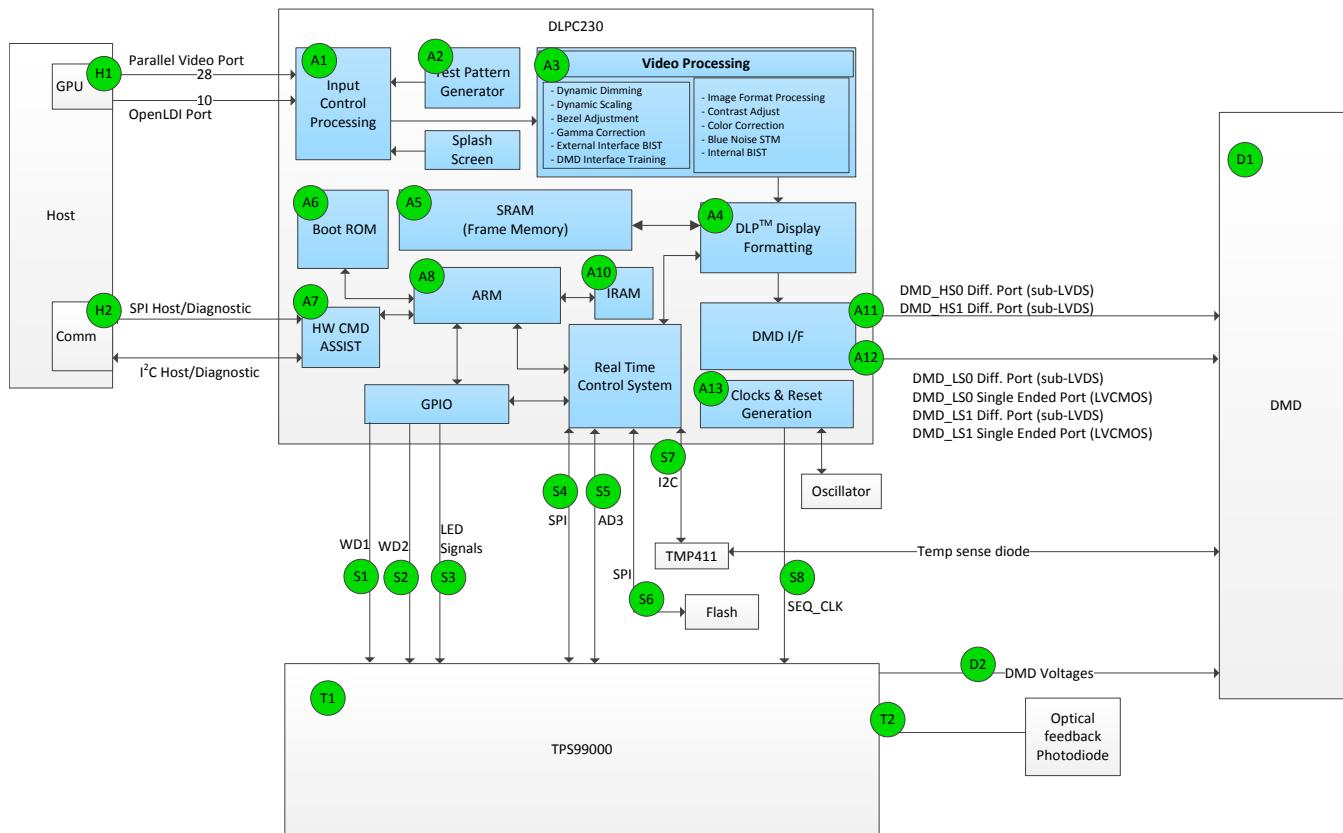


Figure 6-7. Test Coverage System Block Diagram

Table 6-43. Interface Tests Overview

| TEST | COVERAGE | FAIL ACTION | SECTION |
|---|----------|--------------------|---------------------------------|
| Temperature Sensor Interface | S7 | Emergency Shutdown | Section 6.4.3.1 |
| DLPC230-Q1 to TPS99000-Q1 SPI Interface | S4 | DLPC230-Q1 Reset | Section 6.4.3.2 |
| DLPC230-Q1 to TPS99000-Q1 ADC Interface | S5 | Emergency Shutdown | Section 6.4.3.3 |

6.4.3.1 Temperature Sensor Interface

The DLPC230-Q1 communicates with the TMP411 temperature sensor using I²C. If a NAK is received during a communication attempt, the command will be re-attempted up to 3 times. If these attempts fail, the main application will take action.

6.4.3.1.1 Failure Actions

The main application will execute emergency shutdown.

6.4.3.2 DLPC230-Q1 to TPS99000-Q1 SPI Interface

The DLPC230-Q1 is the master of a SPI communication interface with the TPS99000-Q1. This SPI protocol uses 9-bit bytes with one parity bit per byte. Each write and read transaction returns the parity error status from the TPS99000-Q1. The returned parity error status and the parity of the returned bytes must be correct for the command to be considered successful. If 3 consecutive frames of commands fail, the main application will take action.

6.4.3.2.1 Failure Actions

The main application will stop servicing TPS99000-Q1 processor watchdog (WD1) so that the TPS99000-Q1 resets the DLPC230-Q1.

6.4.3.3 DLPC230-Q1 to TPS99000-Q1 ADC Interface

The DLPC230-Q1 receives ADC data from the TPS99000-Q1 over a dedicated SPI-like interface. Each write transaction on this interface includes repeated command bits and an odd parity bit. The two command packets must match and the parity bit must be correct for the write transaction to be considered valid. The return data includes error bit status for the previous transaction, repeated data and error bits, and an odd parity bit. The two copies of the read data and error bits must match, and the parity bit must be correct for the write transaction to be considered valid. If 3 consecutive frames of commands exhibit failure, the main application will take action.

6.4.3.3.1 Failure Actions

The main application will execute emergency shutdown.

Commands - Boot Application

7.1 Command Table

Table 7-1 summarizes the boot application commands.

Table 7-1. Command Summary - Boot Application

| COMMAND | TYPE | OP CODE | SECTION |
|---------------------------|--------------|---------|--------------------------------|
| System Reset | Write | 00h | Section 7.2.1 |
| Read Pre-fetch | Write | 01h | Section 7.2.2 |
| Read Activate | Read | 02h | Section 7.2.3 |
| System Software Version | Read | B0h | Section 7.2.4 |
| Flash Device ID | Read | B1h | Section 7.2.5 |
| Short Status | Read | C0h | Section 7.2.6 |
| Error History | Read | C1h | Section 7.2.7 |
| Clear Short Status Errors | Write | C2h | Section 7.2.8 |
| Clear Error History | Write | C3h | Section 7.2.9 |
| Flash Full Erase | Write | E0h | Section 7.2.10 |
| Flash Write Data | Write (Bulk) | E1h | Section 7.2.11 |
| Flash Verify Data | Read | E2h | Section 7.2.12 |
| Flash Interface Rate | Write | E3h | Section 7.2.13 |
| Flash Interface Rate | Read | E4h | Section 7.2.14 |

7.2 Command Definitions

7.2.1 System Reset - Write (00h)

This command is used to reset the DLPC230-Q1. The proper byte signature must be transmitted to initiate the reset in order to prevent unintended system resets.

When the command is received, the DLPC230-Q1 will perform a full reset except for the main PLL. This will not reset the DMD or the TPS99000-Q1. In order to reset the entire chipset, the external *PROJ_ON* signal should be used.

Write Parameters

Table 7-2. System Reset Write Parameters (Boot)

| BYTE | BITS | DESCRIPTION |
|------|------|---------------------------------|
| 1 | 7:0 | Signature Byte 1 0xAA |
| 2 | 7:0 | Signature Byte 2 0xBB |
| 3 | 7:0 | Signature Byte 3 0xCC |
| 4 | 7:0 | Signature Byte 4 0xDD |

7.2.2 Read Pre-Fetch - Write (01h)

This command is used to send the desired read command op-code and associated command parameters to initiate a read request from embedded software. The desired read data will not be returned during this command transaction. More information on the read procedure can be found in [Section 3.5](#).

Write Parameters

Table 7-3. Read Pre-Fetch Write Parameters (Boot)

| BYTE | BITS | DESCRIPTION |
|---------|------|---|
| 1 | 7:0 | Read command op-code |
| 2 ... n | | Read command parameters Depending on the Read op-code, a specific number of command parameter bytes will be expected. The required byte parameters are documented with each read command. |

7.2.3 Read Activate (02h)

This command is used to activate the read operation in order to retrieve the previously requested read data. This generic command is used to retrieve all requested read data with the exception of the *Short Status* command. More information on the read procedure can be found in [Section 3.5](#).

Command Parameters

No command parameters.

Return Parameters

Table 7-4. Read Activate Return Parameters (Boot)

| BYTE | BITS | DESCRIPTION |
|---------|------|--|
| 1 ... n | | Data Bytes 1...n Read data bytes. The number of bytes will vary depending on the command that is currently being read. |

7.2.4 System Software Version - Read (B0h)

This command is used to read the software version of the boot application.

Command Parameters

No command parameters.

Return Parameters

Table 7-5. System Software Version Return Parameters (Boot)

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 2:1 | 7:0 | DLPC230-Q1 Boot Application Version - Patch LSByte = 1 |
| 3 | 7:0 | DLPC230-Q1 Boot Application Version - Minor |
| 4 | 7:0 | DLPC230-Q1 Boot Application Version - Major |

7.2.5 Flash Device ID - Read (B1h)

This command is used to read flash device information.

Command Parameters

No command parameters.

Return Parameters

Table 7-6. Flash Device ID Return Parameters (Boot)

| BYTE | BITS | DESCRIPTION |
|------|------|------------------------------|
| 1 | 7:0 | Flash Manufacturer ID |
| 2 | 7:0 | Flash Memory Type |
| 3 | 7:0 | Flash Memory Capacity |

The manufacturer ID and memory type can be found from the selected flash device specification.

The flash memory size can be determined from [Table 7-7](#).

Table 7-7. Flash Memory Size Values

| MEMORY CAPACITY (BYTE 3) | ACTUAL SIZE |
|--------------------------|-----------------------|
| 0x15 | 16 Mb |
| 0x16 | 32 Mb |
| 0x17 | 64 Mb |
| 0x18 | 128 Mb |
| 0x19 | 256 Mb ⁽¹⁾ |

⁽¹⁾ Only the first 128Mb of address space is useable.

7.2.6 Short Status - Read (C0h)

This command is used to read the short status from hardware. This is the only read command that does not require the use of *Read Pre-Fetch* and *Read Activate* commands. Refer to [Section 3.5](#) for more information on the *Short Status* protocol.

Command Parameters

No command parameters.

Return Parameters

Table 7-8. Short Status Return Parameters (Boot)

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:6 | Application / Mode 0x0: Boot application 0x1: Main application - Standby 0x2: Main application - Display |
| | | Emergency Shutdown 0x0: Not activated 0x1: Activated |
| | | Reserved |
| | | Read Data Available 0x0: No data available 0x1: Data available |
| | | System Busy 0x0: Not busy 0x1: Busy |
| | | Request in Progress 0x0: Not in progress 0x1: In progress |
| | | System Initialized 0x0: Not initialized 0x1: Initialized |
| 2 | 7:0 | Execution Command Tag |
| 4:3 | 15 | BIST Error 0x0: No error 0x1: Error |
| | 14 | Operational Error 0x0: No error 0x1: Error |
| | 13 | Command Error 0x0: No error 0x1: Error |
| | 12 | Communication Error 0x0: No error 0x1: Error |
| | 11:0 | CMD/COMM Error Code |

A diagram of these short status bits is shown in Figure 7-1.

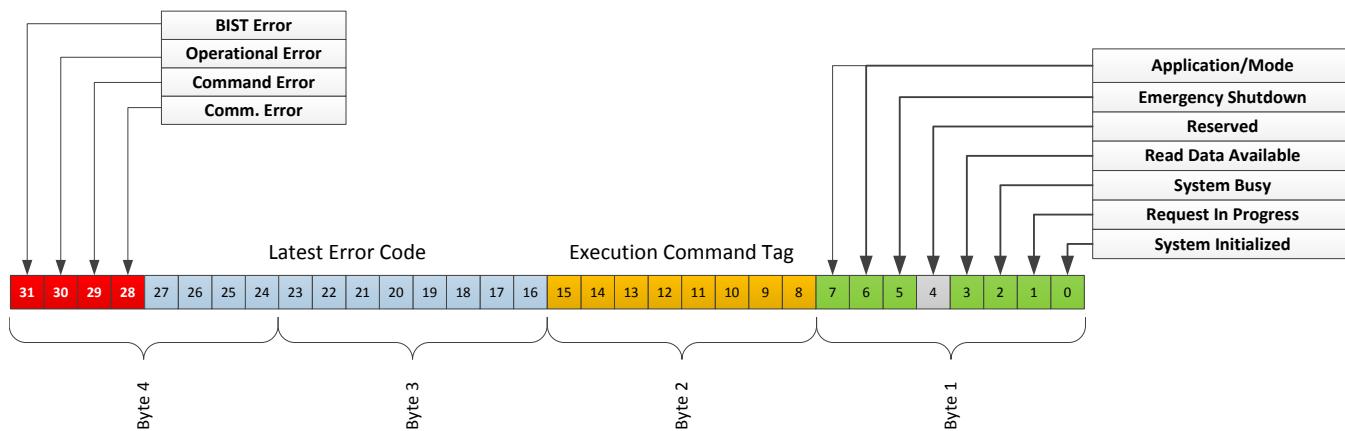


Figure 7-1. Short Status Bit Definition

The bits are described in Table 7-9.

Table 7-9. Short Status Field Descriptions (Boot)

| BIT FIELD | DEFINITION |
|-----------------------|---|
| System Initialized | Indicates that the system software is ready to accept commands for processing. Typically this would be set by the Main Application, except when the system is forced to stay in boot. |
| Request in Progress | This bit is used to inform the host that a commanded task is being performed. When the task is initiated, this bit will be set to 1 and when the operation has completed the bit will be cleared to 0. If the task was a BIST, the results for the requested test will be valid once the bit has been cleared by embedded software. Further requests can be started after this. |
| System Busy | This bit is used to inform the host that the system's receive FIFO is full. The host should not send any more commands when the system is busy, or the commands and associated data may be lost. The Host is free to send commands when the system is not busy. |
| Read Data Available | Indicates when read data is available after the host has sent a Read Prefetch command. When data is available, the Host should send the Read Activate command to fetch the requested data. The Host should always fetch requested data using the Read Activate command before sending another Read Prefetch command. If a Read Prefetch command is sent before the data from a previous Read Prefetch command has been fetched, the previous data will be flushed, and the latest requested data will be made available for fetching by Read Activate. There will be no error indication that this has occurred. |
| Emergency Shutdown | This bit is used to indicate that the system has automatically gone to Standby Mode due to a critical system error. The specifics of the error may be available via the Error History. |
| Application/Mode | These bits indicate whether the boot application or main application is being executed. During main application execution, the current operating mode is also specified. |
| Execution Command Tag | This byte contains the command tag for the last write command received that has been executed, whether successful or not. This tag is used along with the Error Code to determine if the command associated with this tag was executed successfully or not. This byte is continually updated as new commands are received and executed. In the Boot Application, this byte is also used for any system errors. For errors where the command tag is valid, the actual tag will be used. For errors where there is no command tag or the command tag may be invalid, a null (0h) command tag will be provided in this field. In both cases, the appropriate error code will be provided in the error code field. |
| Error Code | The 12-bit error code is used to specify the last error received during system operation. The error code can indicate no error (error code = 0h), or indicate the error code for the most recent error to occur. This error code is continually updated as new errors occur. The Error History command can be used to obtain details about previous errors. For any communication errors, the error code for this error will also be provided in this field. |

Table 7-9. Short Status Field Descriptions (Boot) (continued)

| BIT FIELD | DEFINITION |
|---------------------|---|
| Communication Error | A flag set to indicate a communication error, which is used to indicate a problem with the transmission/reception of a command. Some examples are: <ul style="list-style-type: none"> • RXFIFO overflow • Command transmission terminated early (the host didn't provide enough SPI clock pulses for all requested data). • Command transmission terminated late (the host provided too many SPI clock pulses for requested data). |
| Command Error | A flag set to indicate a command error, or an error in the action requested by the command. Some examples are: <ul style="list-style-type: none"> • Command executed in an invalid operating mode • CRC Error in Command Header • CRC Error in Payload (Bulk Command) • Invalid command op-code • Invalid command parameter (for example, out of range) • Incorrect number of command parameters • Non-periodic BIST failure when BIST started by command • Error erasing, writing, or reading flash when commanded • Flash overflow error |
| Operational Error | A flag set to indicate an operational error, which are any errors that don't fall into one of the other three error categories. Some examples are: <ul style="list-style-type: none"> • Sequence CRC error • CMT CRC error • Sequence / CMT mismatch error • Periodic BIST failure • Unable to communicate with TPS99000-Q1 • Unable to communicate with temperature sensor |
| BIST Error | A flag set to indicate a non-periodic or periodic BIST error. |

7.2.7 Error History - Read (C1h)

This command is used to read the details of the first 62 errors that the system encounters. Subsequent errors beyond the first 62 will not be stored, but the error count will continue to increase to indicate that more errors occurred. Four bytes are allocated for each error. The error history can be cleared using the [Clear Error History](#) command. The command will always return 249 bytes regardless of the number of errors currently contained in the error history.

Boot Application error codes are defined in [Section A.1](#).

Command Parameters

No command parameters.

Return Parameters

Table 7-10. Error History Return Parameters (Boot)

| BYTE | BITS | DESCRIPTION |
|---------|------|---|
| 1 | 7:0 | Error Count Count of errors received since the last power-cycle or clear of the error history. If the error count is greater than 62, some error details are not available since storage is full. |
| 5:2 | 31:0 | Error 1 Details LSByte = 2 |
| 9:6 | 31:0 | Error 2 Details LSByte = 6 |
| ... | ... | Error n Details |
| 249:246 | 31:0 | Error 62 Details LSByte = 246 |

Each set of error details includes a unique error code, category flags, and additional information bits that vary based on the type of error. The bit definition for each error is broken down as follows:

Table 7-11. Error Detail Bit Descriptions (Boot)

| BITS | DESCRIPTION |
|-------|---|
| 31 | BIST Error 0x1: This error is categorized as a BIST error |
| 30 | Operational Error 0x1: Error is categorized as an operational error |
| 29 | Command Error 0x1: Error is categorized as a command error |
| 28 | Communication Error 0x1: Error is categorized as a communication error |
| 27 | Reserved Always 0 |
| 26:16 | Error code Unique error code to identify the error. |
| 15:0 | Informational bits These can vary depending on the category and specific type of error. |

A diagram of the error detail fields is shown in [Figure 7-2](#):

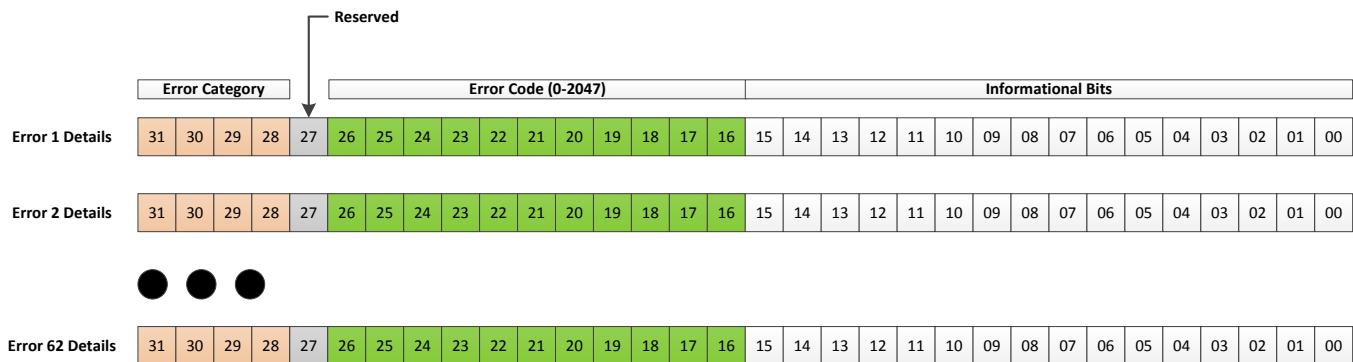


Figure 7-2. Error History Details

7.2.8 Clear Short Status Errors - Write (C2h)

This command is used to clear the Short Status error bits. This includes bytes 3 and 4 of the Short Status.

Write Parameters

Table 7-12. Clear Short Status Errors Write Parameters (Boot)

| BYTE | BITS | DESCRIPTION |
|------|------|---------------------------------|
| 1 | 7:0 | Signature Byte 1 0xAA |
| 2 | 7:0 | Signature Byte 2 0xBB |
| 3 | 7:0 | Signature Byte 3 0xCC |
| 4 | 7:0 | Signature Byte 4 0xDD |

7.2.9 Clear Error History - Write (C3h)

This command is used to clear the Error History, the Error Count, and the Short Status error bits.

Write Parameters

Table 7-13. Clear Error History Write Parameters (Boot)

| BYTE | BITS | DESCRIPTION |
|------|------|---------------------------------|
| 1 | 7:0 | Signature Byte 1 0xAA |
| 2 | 7:0 | Signature Byte 2 0xBB |
| 3 | 7:0 | Signature Byte 3 0xCC |
| 4 | 7:0 | Signature Byte 4 0xDD |

7.2.10 Flash Full Erase - Write (E0h)

This command directs the boot application to erase the entire contents of the flash device.

The *Request in Progress* bit of the Short Status will be set at the start of the flash erase process and will be cleared when the erase process is complete.

The error bits in the Short Status can be used to determine whether an error occurred during the erase process.

More information on flash programming can be found in [Section 5.3.3](#).

Write Parameters

Table 7-14. Flash Full Erase Write Parameters (Boot)

| BYTE | BITS | DESCRIPTION |
|------|------|---------------------------------|
| 1 | 7:0 | Signature Byte 1 0xAA |
| 2 | 7:0 | Signature Byte 2 0xBB |
| 3 | 7:0 | Signature Byte 3 0xCC |
| 4 | 7:0 | Signature Byte 4 0xDD |

7.2.11 Flash Write Data - Write (E1h)

This is a bulk write command that directs the boot application to write the included 256 bytes of payload data to the flash device. The first write transaction after a flash erase will start at the first flash address (0x0). Each subsequent command will write a page of flash data and the flash address will be incremented to the next page. If the amount of data is less than 256 bytes, the host should fill the remaining bytes with 0xFF to pad.

The *Request in Progress* bit of the Short Status will be set at the start of the flash write process and will be cleared when each write transaction is complete. The next flash write should not begin until the *Request in Progress* bit is cleared.

More information on flash programming can be found in [Section 5.3.3](#).

Write Parameters

Table 7-15. Flash Write Data Write Parameters (Boot)

| BYTE | BITS | DESCRIPTION |
|------|------|----------------------|
| 1 | 7:0 | Data Byte 1 |
| 2 | 7:0 | Data Byte 2 |
| ... | ... | Data Byte ... |
| 256 | 7:0 | Data Byte 256 |

7.2.12 Flash Verify Data - Write (E2h)

This command tells the boot application to verify the contents of the flash device.

The *Request in Progress* bit of the Short Status will be set at the start of the flash verify process and will be cleared when the verify process is complete.

Once the process is completed, the error bits in the Short Status can be used to determine whether an error occurred during the verification process.

More information on flash programming can be found in [Section 5.3.3](#).

Write Parameters

No write parameters.

7.2.13 Flash Interface Rate - Write (E3h)

This command is used to specify the maximum supported flash clock rate and to indicate the supported memory read commands. Typically, this information would be stored in the flash information, but in situations when the flash is corrupt or empty, the values are not accessible from flash data. In these situations, this command can significantly reduce flash programming and verification time.

There is a minimum interface bandwidth requirement that is specified in the DLPC230-Q1 Data Sheet. Developers should ensure that the flash device selected can meet these minimum requirements.

Write Parameters

Table 7-16. Flash Interface Rate Write Parameters (Boot)

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 7:5 | Reserved Set to 0x0 |
| | 4 | Quad Input / Output Read 0x0: Not supported 0x1: Supported |
| | 3 | Quad Output Read 0x0: Not supported 0x1: Supported |
| | 2 | Dual Input / Output Read 0x0: Not supported 0x1: Supported |
| | 1 | Dual Output Read 0x0: Not supported 0x: Supported |
| | 0 | Fast Read 0x0: Not supported 0x1: Supported |
| 3:2 | 15:0 | Maximum Flash Clock Rate LSByte = Byte 2 The MHz frequency with two decimals of precision should be multiplied by 100. For example, 50.25 MHz * 100 = 5025 = 0x13A1. |

Because flash instruction names vary between manufacturers, [Table 7-17](#) defines the corresponding flash op-codes for each read instruction.

Table 7-17. Flash Read Instruction Op-Codes

| FLASH INSTRUCTION NAME | FLASH OP-CODE |
|--------------------------|---------------|
| Fast Read | 0x0B |
| Dual Output Read | 0x3B |
| Dual Input / Output Read | 0xBB |
| Quad Output Read | 0x6B |
| Quad Input / Output Read | 0xEB |

7.2.14 Flash Interface Rate - Read (E4h)

This command is used to read the flash interface rate settings.

Command Parameters

No command parameters.

Return Parameters

Table 7-18. Flash Interface Rate Return Parameters (Boot)

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:5 | Reserved Always 0x0 |
| | 4 | Quad Input / Output Read 0x0: Not supported 0x1: Supported |
| | 3 | Quad Output Read 0x0: Not supported 0x1: Supported |
| | 2 | Dual Input / Output Read 0x0: Not supported 0x1: Supported |
| | 1 | Dual Output Read 0x0: Not supported 0x1: Supported |
| | 0 | Fast Read 0x0: Not supported 0x1: Supported |
| | 3:2 | Maximum Flash Clock Rate LSByte = Byte 2 This value should be divided by 100 to read the MHz value. For example, 0x13A1 = 5025 / 100 = 50.25 MHz. |

Commands - Main Application

8.1 Mode Availability

Table 8-1 summarizes the main application commands and indicates the operating modes in which they are available. Embedded software will flag an error if a command is used outside of the proper operating mode.

Mode key:

- **Yes** - Command is available and values will be applied or retrieved as soon as possible
- **No** - Command is not available and an error will be provided if the command is used
- **Hold Mode** - Command values will be held, but not applied until the operating mode is changed to a mode that says "Yes". This can be used to configure certain system parameters before switching modes and applying them.
- **Hold Source** - Command values will be held until the source is changed. This is done to coordinate the application of all source parameters.

Read commands always return the last values that were written, or the values stored in flash if no values have been written since startup. Because of data holds, this value may be different than what is actually being displayed. For example if a new flip value is written to *Display Image Orientation*, but no source change has been commanded, then the value that is read back will not match what is currently being applied. The *Current Source Information* and *Current Display Information* commands allow the host to read back the settings that are currently applied to the displayed image.

Table 8-1. Command Summary - Main Application

| COMMAND | TYPE | OP CODE | STANDBY | DISPLAY | CALIBRATION (Not applicable for headlight) | SECTION |
|---------------------------|-------|---------|-----------|-------------|---|--------------------------------|
| System Reset | Write | 00h | Yes | Yes | Yes | Section 8.2.1 |
| Read Pre-fetch | Write | 01h | Yes | Yes | Yes | Section 8.2.2 |
| Read Activate | Read | 02h | Yes | Yes | Yes | Section 8.2.3 |
| Operating Mode | Write | 03h | Yes | Yes | Yes | Section 8.2.4 |
| Operating Mode | Read | 04h | Yes | Yes | Yes | Section 8.2.5 |
| Source Select | Write | 05h | Hold Mode | Yes | Yes | Section 8.2.6 |
| Source Select | Read | 06h | Yes | Yes | Yes | Section 8.2.7 |
| Prepare for Source Change | Write | 07h | No | Yes | Yes | Section 8.2.8 |
| Display Image Orientation | Write | 18h | Hold Mode | Hold Source | Hold Source | Section 8.2.9 |
| Display Image Orientation | Read | 19h | Yes | Yes | Yes | Section 8.2.10 |
| System Mode Select | Write | 1Ch | Hold Mode | Hold Source | Hold Source | Section 8.2.11 |
| System Mode Select | Read | 1Dh | Yes | Yes | Yes | Section 8.2.12 |
| Execute Batch Command Set | Write | 21h | Yes | Yes | Yes | Section 8.2.13 |
| GPIO Configure | Write | 23h | Yes | Yes | Yes | Section 8.2.15 |
| GPIO Configure | Read | 24h | Yes | Yes | Yes | Section 8.2.16 |
| GPIO Outputs | Write | 25h | Yes | Yes | Yes | Section 8.2.17 |
| GPIO Outputs | Read | 26h | Yes | Yes | Yes | Section 8.2.18 |
| GPIO Reserved | Read | 27h | Yes | Yes | Yes | Section 8.2.19 |
| Execute Non-Periodic BIST | Write | 28h | Yes | No | No | Section 8.2.20 |

Table 8-1. Command Summary - Main Application (continued)

| COMMAND | TYPE | OP CODE | STANDBY | DISPLAY | CALIBRATION (Not applicable for headlight) | SECTION |
|---------------------------------------|-------|---------|------------------|---------|---|--------------------------------|
| External Video Checksum Control | Write | 29h | Hold Mode | Yes | Yes | Section 8.2.21 |
| External Video Checksum Control | Read | 2Ah | Yes | Yes | Yes | Section 8.2.22 |
| External Video Checksum Settings | Write | 2Bh | Hold Mode | Yes | Yes | Section 8.2.23 |
| External Video Checksum Settings | Read | 2Ch | Yes | Yes | Yes | Section 8.2.24 |
| Average Picture Level Control | Write | 2Fh | Hold Mode | Yes | Yes | Section 8.2.25 |
| Average Picture Level Control | Read | 30h | Yes | Yes | Yes | Section 8.2.26 |
| Loss of/Ping Control | Write | 33h | Hold Mode Yes | Yes | Yes | Section 8.2.27 |
| Loss of/Ping Control | Read | 34h | Yes | Yes | Yes | Section 8.2.28 |
| Headlight Ping | Write | 46h | Yes | Yes | Yes | Section 8.2.29 |
| PWM Control | Write | 47h | Yes | Yes | Yes | Section 8.2.30 |
| PWM Control | Read | 48h | Yes | Yes | Yes | Section 8.2.31 |
| Illumination Transition Rate | Write | 49h | Hold Mode | Yes | Yes | Section 8.2.32 |
| Illumination Transition Rate | Read | 4Ah | Yes | Yes | Yes | Section 8.2.33 |
| De-gamma Select | Write | 54h | Hold Mode | Yes | Yes | Section 8.2.34 |
| De-gamma Select | Read | 55h | Yes | Yes | Yes | Section 8.2.35 |
| ADC Measurements | Read | 5Ch | No | Yes | Yes | Section 8.2.36 |
| ADC Single Measurement | Read | 63h | Yes | No | No | Section 8.2.37 |
| Illumination Bin Select | Write | 70h | Hold Mode | Yes | Yes | Section 8.2.38 |
| Illumination Bin Select | Read | 71h | Yes | Yes | Yes | Section 8.2.39 |
| TPS99000-Q1 TIA1 Trims | Write | 86h | No | Yes | Yes | Section 8.2.40 |
| TPS99000-Q1 TIA1 Trims | Read | 87h | Yes | Yes | Yes | Section 8.2.41 |
| TPS99000-Q1 TIA1 Gain | Write | 88h | No | Yes | Yes | Section 8.2.42 |
| TPS99000-Q1 TIA1 Gain | Read | 89h | Yes | Yes | Yes | Section 8.2.43 |
| TPS99000-Q1 TIA1 Capacitance | Write | 8Ah | No | Yes | Yes | Section 8.2.44 |
| TPS99000-Q1 TIA1 Capacitance | Read | 8Bh | Yes | Yes | Yes | Section 8.2.45 |
| TPS99000-Q1 TIA1 Dark Offsets | Write | 8Ch | No | Yes | Yes | Section 8.2.46 |
| TPS99000-Q1 TIA1 Dark Offsets | Read | 8Dh | Yes | Yes | Yes | Section 8.2.47 |
| TPS99000-Q1 TIA1 Input Offsets | Write | 8Eh | No | Yes | Yes | Section 8.2.48 |
| TPS99000-Q1 TIA1 Input Offsets | Read | 8Fh | Yes | Yes | Yes | Section 8.2.49 |
| TPS99000-Q1 Drive Mode | Write | 92h | No | Yes | Yes | |
| TPS99000-Q1 Drive Mode | Read | 93h | Yes | Yes | Yes | Section 8.2.50 |
| TPS99000-Q1 ADC Configuration | Write | 94h | No | Yes | Yes | Section 8.2.51 |
| TPS99000-Q1 ADC Configuration | Read | 95h | Yes | Yes | Yes | Section 8.2.52 |
| TPS99000-Q1 Illumination Sync Control | Write | 96h | No | Yes | Yes | Section 8.2.53 |
| TPS99000-Q1 Illumination Sync Control | Read | 97h | Yes | Yes | Yes | Section 8.2.54 |

Table 8-1. Command Summary - Main Application (continued)

| COMMAND | TYPE | OP CODE | STANDBY | DISPLAY | CALIBRATION (Not applicable for headlight) | SECTION |
|-----------------------------|--------------|---------|---------|---------|--|--------------------------------|
| TPS99000-Q1 TIA2 Control | Write | 98h | Yes | Yes | Yes | Section 8.2.55 |
| TPS99000-Q1 TIA2 Control | Read | 99h | Yes | Yes | Yes | Section 8.2.56 |
| LED Drive Errors | Read | 9Ah | No | Yes | Yes | Section 8.2.57 |
| LED Drive Errors Clear | Write | 9Bh | No | Yes | Yes | Section 8.2.58 |
| TPS99000-Q1 Test Mux Select | Write | 9Ch | Yes | Yes | Yes | Section 8.2.59 |
| TPS99000-Q1 Test Mux Select | Read | 9Dh | Yes | Yes | Yes | Section 8.2.60 |
| Flash Data Type Select | Write | A0h | Yes | No | No | Section 8.2.61 |
| Flash Erase Data | Write | A1h | Yes | No | No | Section 8.2.62 |
| Flash Write Data | Write (Bulk) | A2h | Yes | No | No | Section 8.2.63 |
| Flash Read Data | Read | A3h | Yes | Yes | Yes | Section 8.2.64 |
| Flash Verify Data | Read | A4h | Yes | No | No | Section 8.2.65 |
| Flash Block Count | Read | A5h | Yes | Yes | Yes | Section 8.2.66 |
| Flash Block CRCs | Read | A6h | Yes | Yes | Yes | Section 8.2.67 |
| Flash Structure Version | Read | A7h | Yes | Yes | Yes | Section 8.2.68 |
| Flash Data Size | Read | A9h | Yes | Yes | Yes | Section 8.2.69 |
| System Software Version | Read | B0h | Yes | Yes | Yes | Section 8.2.70 |
| Flash Device ID | Read | B1h | Yes | Yes | Yes | Section 8.2.71 |
| DLPC230-Q1 Device ID | Read | B2h | Yes | Yes | Yes | Section 8.2.72 |
| DMD Device ID | Read | B3h | Yes | Yes | Yes | Section 8.2.73 |
| TPS99000-Q1 Device ID | Read | B4h | Yes | Yes | Yes | Section 8.2.74 |
| System Temperatures | Read | B5h | Yes | Yes | Yes | Section 8.2.75 |
| Current Source Information | Read | B6h | No | Yes | Yes | Section 8.2.76 |
| Current Display Information | Read | B8h | No | Yes | Yes | Section 8.2.77 |
| System Information | Read | BAh | Yes | Yes | Yes | Section 8.2.78 |
| Flash Interface Rate | Read | BBh | Yes | Yes | Yes | Section 8.2.79 |
| Short Status | Read | C0h | Yes | Yes | Yes | Section 8.2.80 |
| Error History | Read | C1h | Yes | Yes | Yes | Section 8.2.81 |
| Clear Short Status Errors | Write | C2h | Yes | Yes | Yes | Section 8.2.82 |
| Clear Error History | Write | C3h | Yes | Yes | Yes | Section 8.2.83 |

8.2 Command Definitions

8.2.1 System Reset - Write (00h)

This command is used to reset the DLPC230-Q1. The proper byte signature must be transmitted to initiate the reset in order to prevent unintended system resets.

When the command is received, the DLPC230-Q1 will perform a full reset except for the main PLL and the diagnostic port memory. This will not reset the DMD or the TPS99000-Q1. In order to reset the entire chipset, the external *PROJ_ON* signal should be used.

Write Parameters

Table 8-2. System Reset Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---------------------------------|
| 1 | 7:0 | Signature Byte 1 0xAA |
| 2 | 7:0 | Signature Byte 2 0xBB |
| 3 | 7:0 | Signature Byte 3 0xCC |
| 4 | 7:0 | Signature Byte 4 0xDD |

8.2.2 Read Pre-Fetch - Write (01h)

This command is used to send the desired read command op-code and associated command parameters to initiate a read request from embedded software. The desired read data will not be returned during this command transaction. More information on the read procedure can be found in [Section 3.5](#).

Write Parameters

Table 8-3. Read Pre-Fetch Write Parameters

| BYTE | BITS | DESCRIPTION |
|---------|------|---|
| 1 | 7:0 | Read command op-code |
| 2 ... n | | Read command parameters Depending on the Read op-code, a specific number of command parameter bytes will be expected. The required byte parameters are documented with each read command. |

8.2.3 Read Activate (02h)

This command is used to activate the read operation in order to retrieve the previously requested read data. This generic command is used to retrieve all requested read data with the exception of the *Short Status* command. More information on the read procedure can be found in [Section 3.5](#).

Command Parameters

No command parameters.

Return Parameters

Table 8-4. Read Activate Return Parameters

| BYTE | BITS | DESCRIPTION |
|---------|------|--|
| 1 ... n | | Data Bytes 1...n Read data bytes. The number of bytes will vary depending on the command that is currently being read. |

8.2.4 Operating Mode - Write (03h)

This command is used to set the embedded software operating mode. Refer to [Section 4.1](#) for descriptions of operating modes.

Write Parameters

Table 8-5. Operating Mode Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:2 | Reserved |
| | 1:0 | Operating Mode 0x0: Standby 0x1: Display 0x3: Reserved |

8.2.5 Operating Mode - Read (04h)

This command is used to read the embedded software operating mode. Refer to [Section 4.1](#) for descriptions of operating modes.

The [Short Status](#) command can also be used to read the current operating mode. Using the Short Status is faster than using this command since the Short Status can be read in one transaction.

Command Parameters

No command parameters.

Return Parameters

Table 8-6. Operating Mode Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:2 | Reserved |
| | 1:0 | Operating Mode 0x0: Standby 0x1: Display 0x3: Reserved |

8.2.6 Source Select - Write (05h)

This command is used to select the display source. Refer to [Section 5.1](#) for instructions on source configuration.

Write Parameters

Table 8-7. Source Select Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 7:2 | Reserved |
| | 1:0 | Display Source Type 0x0: External Video 0x1: Test Pattern Generator 0x2: Splash Screen 0x3: Reserved |

8.2.7 Source Select - Read (06h)

This command is used to read the host-specified value for the display source type.

Command Parameters

No command parameters.

Return Parameters

Table 8-8. Source Select Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 7:2 | Reserved |
| | 1:0 | Display Source Type 0x0: External Video 0x1: Test Pattern Generator 0x2: Splash Screen 0x3: Reserved |

8.2.8 Prepare for Source Change - Write (07h)

This command starts the source change process. It will disable illumination and disable source error-checking until the [Source Select](#) command is sent. Refer to [Section 5.1](#) for instructions on source configuration.

Write Parameters

No write parameters.

8.2.9 Display Image Orientation - Write (18h)

This command sets the image flip orientation of the displayed image. This command is not applied until a source change is requested. Refer to [Section 5.1.5](#) for more information on performing an image flip.

Write Parameters

Table 8-9. Display Image Orientation Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:2 | Reserved |
| | 1 | Short Axis Image Flip 0x0: Image not flipped 0x1: Image flipped |
| | 0 | Long Axis Image Flip 0x0: Image not flipped 0x1: Image flipped |

8.2.10 Display Image Orientation - Read (19h)

This command is used to read the host-specified values for the display image flip orientation. The default image flip settings are specified in the flash header file that is included along with the flash data.

Command Parameters

No command parameters.

Return Parameters

Table 8-10. Display Image Orientation Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:2 | Reserved |
| | 1 | Short Axis Image Flip 0x0: Image not flipped 0x1: Image flipped |
| | 0 | Long Axis Image Flip 0x0: Image not flipped 0x1: Image flipped |

8.2.11 System Mode Select - Write (1Ch)

This command is used to specify the System Mode index. The available System Modes are specified in the flash header file that is included along with the flash data. This command is not applied until a source change is requested. [Section 10.2](#) provides an overview of system modes.

Write Parameters

Table 8-11. System Mode Select Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 7:0 | System Mode Index First index = 0 |

8.2.12 System Mode Select - Read (1Dh)

This command is used to read back the host-specified System Mode index.

Command Parameters

No command parameters.

Return Parameters

Table 8-12. System Mode Select Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 7:0 | System Mode Index First index = 0 |

8.2.13 Execute Batch Command Set - Write (21h)

This command is used to execute a batch command set that is stored in flash. More information of batch command sets can be found in [Section 5.2](#).

Write Parameters

Table 8-13. Execute Batch Command Set Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 7:0 | Batch index Index of the batch command set stored in flash (0-based). |

8.2.14 Execution Delay - Write (22h)

This command is used to specify a minimum time delay in batch command set execution or on the SPI or I2C host communication interface. This is only a minimum delay time and should not be considered an exact delay due to other ongoing software processes and the time taken to process the command.

Write Parameters

Table 8-14. Execution Delay Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 2:1 | 15:0 | Delay Time 0x0 - 0xFFFFE: Time in milliseconds (500 ms = 0x1F4) 0xFFFF: Invalid |

8.2.15 GPIO Configure - Write (23h)

This command is used to configure non-reserved GPIO pins as inputs or outputs. The default GPIO configurations are stored in flash and are set by the DLPC230-Q1 main application at startup. The default GPIO configurations can be found in the flash header file that is delivered along with the flash data or by reading the GPIO Configure command during system operation.

"No change (0x0)" should be specified for all reserved GPIOs. Any other configuration for reserved GPIO will cause a command error and the values will not be set.

Refer to [Section 2.2.2](#) for more details on GPIO usage.

Write Parameters

[Table 8-15](#) indicates the GPIO index for each pair of configuration bits. [Table 8-16](#) shows the configuration options available for each GPIO.

Table 8-15. GPIO Configure Write Parameters

| BYTE | BIT(7:6) | BIT(5:4) | BIT(3:2) | BIT(1:0) |
|------|----------|----------|----------|----------|
| 1 | 03 | 02 | 01 | 00 |
| 2 | 07 | 06 | 05 | 04 |
| 3 | 11 | 10 | 09 | 08 |
| 4 | 15 | 14 | 13 | 12 |
| 5 | 19 | 18 | 17 | 16 |
| 6 | 23 | 22 | 21 | 20 |
| 7 | 27 | 26 | 25 | 24 |
| 8 | 31 | 30 | 29 | 28 |

[Table 8-16](#) shows the configuration options available for each non-reserved GPIO pin.

Table 8-16. GPIO Configuration Write Values

| GPIO CONFIGURATION VALUES | DESCRIPTION |
|---------------------------|---|
| 0x0 | No change. The previous configuration of the GPIO will be retained. |
| 0x1 | Input |
| 0x2 | Output (standard) |
| 0x3 | Output (open drain) |

8.2.16 GPIO Configure - Read (24h)

This command is used to read back the current drive state of the GPIO pins. The default GPIO configurations are stored in flash and are set by the DLPC230-Q1 main application at startup.

Command Parameters

No command parameters.

Return Parameters

Table 8-17 indicates the GPIO index for each pair of configuration bits. **Table 8-18** shows the configuration options available for each GPIO.

Table 8-17. GPIO Configure Return Parameters

| BYTE | BIT(7:6) | BIT(5:4) | BIT(3:2) | BIT(1:0) |
|------|----------|----------|----------|----------|
| 1 | 03 | 02 | 01 | 00 |
| 2 | 07 | 06 | 05 | 04 |
| 3 | 11 | 10 | 09 | 08 |
| 4 | 15 | 14 | 13 | 12 |
| 5 | 19 | 18 | 17 | 16 |
| 6 | 23 | 22 | 21 | 20 |
| 7 | 27 | 26 | 25 | 24 |
| 8 | 31 | 30 | 29 | 28 |

Table 8-18. GPIO Configuration Return Values

| GPIO CONFIGURATION VALUES | DESCRIPTION |
|---------------------------|---|
| 0x0 | Alternative function. No GPIO configuration may be applied. |
| 0x1 | Input |
| 0x2 | Output (standard) |
| 0x3 | Output (open drain) |

8.2.17 GPIO Outputs - Write (25h)

This command is used to set the output values for non-reserved GPIO.

Each of the 32 GPIO pins has a mask bit (byte 4:1) and a value bit (byte 8:5). If the mask bit is set to 0x1, then the value bit will be applied. If the mask bit is not set, then the value will be ignored.

The mask should be set to 0x0 for all reserved GPIOs. Any other mask configuration for reserved GPIO will cause a command error and the values will not be set.

If a value is specified for a GPIO configured as an input, the value will not be applied until the GPIO is configured as an output.

Refer to [Section 2.2.2](#) for more details on GPIO usage.

Write Parameters

[Table 8-19](#) indicates the GPIO index for each write bit. Each byte is noted as either a mask byte or a value byte.

Table 8-19. GPIO Outputs Write Parameters

| BYTE | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|-----------|-------|-------|-------|-------|-------|-------|-------|-------|
| 1 (Mask) | 07 | 06 | 05 | 04 | 03 | 02 | 01 | 00 |
| 2 (Mask) | 15 | 14 | 13 | 12 | 11 | 10 | 09 | 08 |
| 3 (Mask) | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 |
| 4 (Mask) | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 |
| 5 (Value) | 07 | 06 | 05 | 04 | 03 | 02 | 01 | 00 |
| 6 (Value) | 15 | 14 | 13 | 12 | 11 | 10 | 09 | 08 |
| 7 (Value) | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 |
| 8 (Value) | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 |

[Table 8-20](#) defines the mask bit values.

Table 8-20. GPIO Mask Values

| GPIO MASK VALUES | DESCRIPTION |
|------------------|---|
| 0x0 | Not selected - The value written will be ignored. |
| 0x1 | Selected - The value written will be used. |

[Table 8-21](#) defines the GPIO values.

Table 8-21. GPIO Output Values

| GPIO VALUES | DESCRIPTION |
|-------------|-------------|
| 0x0 | Set low. |
| 0x1 | Set high. |

8.2.18 GPIO Outputs - Read (26h)

This command is used to read back the current values of the GPIO pins.

Command Parameters

No command parameters.

Return Parameters

[Table 8-22](#) indicates the GPIO index for each returned bit.

Table 8-22. GPIO Outputs Return Parameters

| BYTE | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|-----------|-------|-------|-------|-------|-------|-------|-------|-------|
| 1 (Value) | 07 | 06 | 05 | 04 | 03 | 02 | 01 | 00 |
| 2 (Value) | 15 | 14 | 13 | 12 | 11 | 10 | 09 | 08 |
| 3 (Value) | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 |
| 4 (Value) | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 |

[Table 8-23](#) defines the GPIO values.

Table 8-23. GPIO Values

| GPIO VALUES | DESCRIPTION |
|-------------|-------------|
| 0x0 | Set low. |
| 0x1 | Set high. |

8.2.19 GPIO Reserved - Read (27h)

This command is used to read which of the 32 GPIO pins are reserved and which are available for host use.

Refer to [Section 2.2.2](#) for more details on GPIO usage.

Command Parameters

No command parameters.

Return Parameters

[Table 8-24](#) indicates the GPIO index for each return bit.

Table 8-24. GPIO Reserved Return Parameters

| BYTE | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|------|-------|-------|-------|-------|-------|-------|-------|-------|
| 1 | 07 | 06 | 05 | 04 | 03 | 02 | 01 | 00 |
| 2 | 15 | 14 | 13 | 12 | 11 | 10 | 09 | 08 |
| 3 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 |
| 4 | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 |

[Table 8-25](#) shows the GPIO reserved state values.

Table 8-25. GPIO Reserved State Values

| GPIO RESERVED STATE | DESCRIPTION |
|---------------------|--------------|
| 0x0 | Not Reserved |
| 0x1 | Reserved |

8.2.20 Execute Non-Periodic BIST - Write (28h)

This command is used to execute a selected non-periodic BIST.

Write Parameters

Table 8-26. Execute Non-Periodic BIST Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 7:0 | Non-Periodic BIST Select Value of the BIST to execute |

Table 8-27 specifies the non-periodic BIST values.

Table 8-27. Non-Periodic BIST Values

| BYTE 1 (HEX) | TEST NAME | TEST DESCRIPTION |
|--------------|---------------------------|---|
| 28 | DMD MBIST | DMD Memory BIST Not supported on 0.55" ES1 DMD samples. |
| 40 | DLPC230-Q1 Memory BISTS | Tests the DLPC230-Q1 internal memories. |
| 41 | Front End Functional BIST | Tests the DLPC230-Q1 video processing block. |
| 42 | Back End Functional BIST | Tests the DLPC230-Q1 formatting block. |

8.2.21 External Video Checksum Control - Write (29h)

This command is used to enable or disable the external video checksum functions: video tell-tale checksum and video frame checksum. These features should only be enabled while external video is being displayed. They should be disabled while displaying internal test patterns or splash images. Additional details on these tests can be found in [Section 6.4.1.2](#) and [Section 6.4.1.3](#).

Write Parameters

Table 8-28. Execute Video Checksum Control Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 7:0 | Enable/Disable 0x0: Disable 0x1: Enable video tell-tale checksum 0x2: Enable video frame counter checksum 0x3: Checksum information only - Updates actual checksum value each frame, but software will never log an error while this mode is selected. |

8.2.22 External Video Checksum Control - Read (2Ah)

This command is used to read back the host-specified state of the external video checksum function.

Command Parameters

No command parameters.

Return Parameters

Table 8-29. Execute Video Checksum Control Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:0 | Enable/Disable 0x0: Disabled 0x1: Video tell-tale checksum enabled 0x2: Video frame counter checksum enabled 0x3: Checksum information only |

8.2.23 External Video Checksum Settings - Write (2Bh)

This command is used to specify the settings for the external video checksum functions: video tell-tale checksum and video frame counter checksum. Additional details on these tests can be found in [Section 6.4.1.2](#) and [Section 6.4.1.3](#).

Write Parameters

Table 8-30. External Video Checksum Settings Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 2:1 | 15:0 | Checksum Start Pixel Starting pixel coordinate in the active video data to checksum. This is 0-based. LSByte = Byte 1 |
| 4:3 | 15:0 | Checksum Start Line Starting line coordinate in the active video data to checksum. This is 0-based. LSByte = Byte 3 |
| 6:5 | 15:0 | Checksum Total Pixels Per Line Number of pixels in each active line to checksum. This is 1-based. LSByte = Byte 5 |
| 8:7 | 15:0 | Checksum Total Lines Per Frame Number of active lines in each frame to checksum. This is 1-based. LSByte = Byte 7 |
| 12:9 | 31:0 | Expected Checksum Expected checksum value for all pixels in the specified range. This value is only used for video tell-tale checksum. It may be set to 0 for video frame counter checksum. LSByte = Byte 9 |

8.2.24 External Video Checksum Settings - Read (2Ch)

This command is used to read back the host-specified values for the external video checksum settings.

Command Parameters

No command parameters.

Return Parameters

Table 8-31. External Video Checksum Settings Return Parameters

| BYTE | BITS | DESCRIPTION |
|-------|------|--|
| 2:1 | 15:0 | Checksum Start Pixel Starting pixel coordinate in the active video data to checksum. LSByte = Byte 1 |
| 4:3 | 15:0 | Checksum Start Line Starting line coordinate in the active video data to checksum. LSByte = Byte 3 |
| 6:5 | 15:0 | Checksum Total Pixels Per Line Number of pixels in each active line to checksum. LSByte = Byte 5 |
| 8:7 | 15:0 | Checksum Total Lines Per Frame Number of active lines in each frame to checksum. LSByte = Byte 7 |
| 12:9 | 31:0 | Expected Checksum Expected checksum value for all pixels in the specified range. LSByte = Byte 9 |
| 16:13 | 31:0 | Actual Checksum Latest measured checksum of input video data. This can be used to compare against the input expected checksum. LSByte = Byte 13 |

8.2.25 Average Picture Level Control - Write (2Fh)

This command is used to control the average picture level function. Additional details on this test can be found in [Section 6.4.1.4](#).

Write Parameters

Table 8-32. Average Picture Level Control Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 7:0 | APL Control 0x0: Disable 0x1: Enable - Log error if threshold is exceeded 0x2: Enable - Log error and execute emergency shutdown if threshold is exceeded |
| 2 | 7:0 | APL Threshold Threshold picture level. If the incoming video exceeds this threshold, a failure action will be taken as specified in the control bits. |

8.2.26 Average Picture Level Control - Read (30h)

This command is used to read back the host-specified values for the average picture level function. It also returns the most recent average picture level value from the function.

Command Parameters

No command parameters.

Return Parameters

Table 8-33. Average Picture Level Control Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 7:0 | APL Control 0x0: Disable 0x1: Enable - Log error if threshold is exceeded 0x2: Enable - Log error and execute emergency shutdown if threshold is exceeded |
| 2 | 7:0 | APL Threshold Host-specified threshold picture level. |
| 3 | 7:0 | APL Value Most recent average picture level value. |

8.2.27 Loss Of Ping Control - Write (33h)

This command is used to enable the loss-of-ping-command test and to specify the maximum allowable time between ping commands. The default value for this function is specified in flash data.

[Section 6.4.1.5](#) describes the loss-of-ping test in more detail.

Write Parameters

Table 8-34. Loss of Ping Control Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:0 | Timeout length Maximum allowed time in milliseconds between ping command transmissions. 0 = Disable For example, 16 = host must continuously send a command within 16 ms time frame. |

8.2.28 Loss Of Ping Control - Read (34h)

This command is used to read back the host-specified values for the loss-of-ping-command function.

Command Parameters

No command parameters.

Return Parameters**Table 8-35. Loss of Ping Control Return Parameters**

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:0 | Timeout length Maximum allowed time in milliseconds between ping command transmissions. 0 = Disable |

8.2.29 Headlight Ping - Write (46h)

This command is used to fulfill the loss-of-ping timeout requirement within the specified timeout window. It does not have any functional purpose other than notifying the DLPC230-Q1 Main Application that the host is still active and able to communicate.

Write Parameters

No write parameters.

8.2.30 PWM Control - Write (47h)

This command is used to control DLPC230-Q1 PWM duty cycles. The default values are specified in flash data. [Section 2.2.3](#) describes the PWM signals.

Write Parameters

Table 8-36. PWM Control Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 2:1 | 15:0 | PWM 0 Duty Cycle LSByte = Byte 1 0 = 0% 1024 = 100% |
| 4:3 | 15:0 | PWM 1 Duty Cycle LSByte = Byte 3 0 = 0% 1024 = 100% |
| 6:5 | 15:0 | PWM 2 Duty Cycle LSByte = Byte 5 0 = 0% 1024 = 100% |

8.2.31 PWM Control - Read (48h)

This command is used to read back the host-specified PWM duty cycles.

Command Parameters

No command parameters.

Return Parameters

Table 8-37. PWM Control Read Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 2:1 | 15:0 | PWM 0 Duty Cycle LSByte = Byte 1 0 = 0% 1024 = 100% |
| 4:3 | 15:0 | PWM 1 Duty Cycle LSByte = Byte 3 0 = 0% 1024 = 100% |
| 6:5 | 15:0 | PWM 2 Duty Cycle LSByte = Byte 5 0 = 0% 1024 = 100% |

8.2.32 Illumination Transition Rate - Write (49h)

This command is used to specify a time in which to smoothly transition between illumination bins. This function is described in [Section 5.5](#).

Write Parameters

Table 8-38. Illumination Transition Rate Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:0 | Transition time Number of frames = Value * 8 0x0 = Immediate transition 0x1 = Transition over 8 frames 0xFF = Transition over 2040 frames |

8.2.33 Illumination Transition Rate - Read (4Ah)

This command is used to specify a time in which to smoothly transition between illumination bins.

Command Parameters

No command parameters.

Return Parameters

Table 8-39. Illumination Transition Rate Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:0 | Transition time Number of frames = Value * 8 |

8.2.34 De-gamma Select - Write (54h)

This command is used to specify the de-gamma curve index that is applied. De-gamma curves are configurable in flash. The available de-gamma curves are specified in the flash header file that is included along with the flash data.

Write Parameters

Table 8-40. De-gamma Select Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:0 | De-gamma curve Index First index = 0 |

8.2.35 De-gamma Select - Read (55h)

This command is used to read back the host-specified de-gamma curve index. De-gamma curves are configurable in flash. The available de-gamma curves are specified in the flash header file that is included along with the flash data.

Command Parameters

No command parameters.

Return Parameters

Table 8-41. De-gamma Select Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:0 | De-gamma curve Index First index = 0 |

8.2.36 ADC Measurements - Read (5Ch)

This command is used to read the latest ADC measurements captured by the TPS99000-Q1 ADC block and reported to the DLPC230-Q1. There are a total of 63 ADC measurement indexes that can be captured each frame. The definition of each ADC index is defined by flash data and this information can be found in the flash header file.

The returned ADC measurements are converted and scaled voltage values in two's complement integer format. The measurement values from all TPS99000-Q1 channels except for channel 0 are represented on a 1mV scale. TPS99000-Q1 channel 0 is represented on a 10µV scale due to its higher gain.

Note: TPS99000-Q1 channel 0 is not the same as index 0 for this command. The mapping of these two values can be found in the flash header file. Refer to [Section 5.7.1](#) for an example of this mapping.

Command Parameters

Table 8-42. ADC Measurements Command Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:0 | Start index Index of first ADC measurement to be returned. 0-62 |
| 2 | 7:0 | Measurement Count Number of measurements to be returned 1-63 Start Index + Measurement Count must be less than or equal to 63. |

Return Parameters

Table 8-43. ADC Measurements Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:0 | Frame Count Incrementing count to allow the host to check the update rate. |
| 3:2 | 15:0 | ADC Measurement 1 First returned ADC measurement. The index of this measurement is specified by the Start Index command parameter. Two's complement integer format. All TPS99000-Q1 ADC channels will be reported on a 1mV scale, except for channel 0 which is reported on a 10µV scale. LSByte = 2 |

Table 8-43. ADC Measurements Return Parameters (continued)

| BYTE | BITS | DESCRIPTION |
|---------------|------|---|
| 4 | 7:5 | Reserved |
| | 4 | Measurement Index Not Used 0x1: ADC measurement index not used. Measurement is not assigned to an ADC channel. Other fields for this measurement, including value and error bits, should be ignored. 0x0: ADC measurement index is used. |
| | 3:0 | ADC Measurement 1 Error Bits b1xxx = Parity error for this measurement. All other bits and measurement value should be considered invalid. b0001 = ADC value saturated at maximum value b0010 = ADC value underflow at minimum value b0011 = ADC timing error (measurements were triggered too close together) b0100 = Previous measurement mismatch error b0101 = Previous measurement parity error b0110 = Previous measurement stop bit error b0111 = Input ADC received mismatch error |
| | ... | ADC Measurement ... |
| n*3 : n*3 - 1 | 15:0 | ADC Measurement n Final ADC measurement. "n" is specified by Measurement Count command parameter. |
| n*3 + 1 | 7:4 | Reserved |
| | 3:0 | ADC Measurement n Error Bits Final ADC measurement error bits. |

8.2.37 ADC Single Measurement - Read (63h)

This command is used to read a single channel of the TPS99000-Q1 ADC. This cannot be performed while video is displaying. While video is displaying, ADC capture is specified by a sequence-aligned look-up table each frame.

The returned ADC measurement is a converted and scaled voltage value in two's complement integer format. The measurement values from all TPS99000-Q1 channels except for channel 0 are represented on a 1mV scale. Channel 0 is represented on a 10 μ V scale due to its higher gain.

Command Parameters

Table 8-44. ADC Single Measurement Command Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|-------------------------------------|
| 1 | 7:0 | TPS99000-Q1 ADC Channel 0-31 |

Return Parameters

Table 8-45. ADC Single Measurement Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 2:1 | 15:0 | ADC Measurement LSByte = Byte 1 Two's complement integer format. All TPS99000-Q1 ADC channels will be reported on a 1mV scale, except for channel 0 which is reported on a 10 μ V scale. |
| 3 | 7:4 | Reserved |
| | 3:0 | ADC Measurement Error Bits b1xxx = Parity error for this measurement. All other bits and measurement value should be considered invalid. b0001 = ADC value saturated at maximum value b0010 = ADC value underflow at minimum value b0011 = ADC timing error (measurements were triggered too close together) b0100 = Previous measurement mismatch error b0101 = Previous measurement parity error b0110 = Previous measurement stop bit error b0111 = Input ADC received mismatch error |

8.2.38 Illumination Bin Select - Write (70h)

This command is used to specify the desired illumination bin. [Section 10.2](#) describes the function of illumination bins.

Write Parameters

Table 8-46. Illumination Bin Select Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|------------------------|
| 1 | 7:0 | Illumination Bin Index |

8.2.39 Illumination Bin Select - Read (71h)

This command is used to read back the last applied illumination bin.

Command Parameters

No command parameters.

Return Parameters

Table 8-47. Illumination Bin Select Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|------------------------|
| 1 | 7:0 | Illumination Bin Index |

8.2.40 TPS99000-Q1 TIA1 Trims - Write (86h)

This command is used to set TPS99000-Q1 TIA1 RGB Trim gain multipliers. The trim values range from 1.0x to 0.2x linearly. These trims may also be auto-calculated by the DLPC230-Q1 main application.

For single-color applications, all trims should be set to the same value.

Write Parameters

Table 8-48. TPS99000-Q1 TIA1 Trims Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 7:0 | Red Trim Trim gain = $1 - N \times (0.8 / 255)$ 0x0: 1.0x 0xFF: 0.2x |
| 2 | 7:0 | Green Trim Trim gain = $1 - N \times (0.8 / 255)$ 0x0: 1.0x 0xFF: 0.2x |
| 3 | 7:0 | Blue Trim Trim gain = $1 - N \times (0.8 / 255)$ 0x0: 1.0x 0xFF: 0.2x |
| 4 | 0 | Auto-Calculate Enable 0x0: Directly apply trim values specified in this command. 0x1: DLPC230-Q1 software will auto-calculate trim values. Other fields in this command will be ignored. |

8.2.41 TPS99000-Q1 TIA1 Trims - Read (87h)

This command is used to read back the last applied TPS99000-Q1 TIA1 trim gains.

Command Parameters

No command parameters.

Return Parameters

Table 8-49. TPS99000-Q1 TIA1 Trims Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|------------------------------|
| 1 | 7:0 | Red Trim |
| 2 | 7:0 | Green Trim |
| 3 | 7:0 | Blue Trim |
| 4 | 0 | Auto-Calculate Enable |

8.2.42 TPS99000-Q1 TIA1 Gain - Write (88h)

This command is used to set the TPS99000-Q1 TIA1 gain level.

Write Parameters

Table 8-50. TPS99000-Q1 TIA1 Gain Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 3:0 | Gain Index <i>Table 8-51</i> defines the gain level settings. |

Refer to the TPS99000-Q1 Data Sheet for detail regarding gain specifications.

Table 8-51. TIA1 Gain Values

| GAIN INDEX | GAIN (kV/A) ⁽¹⁾ |
|------------|----------------------------|
| 0 | 0.75 |
| 1 | 1.5 |
| 2 | 3 |
| 3 | 6 |
| 4 | 9 |
| 5 | 12 |
| 6 | 18 |
| 7 | 24 |
| 8 | 36 |
| 9 | 48 |
| 10 | 72 |
| 11 | 96 |
| 12 | 144 |
| 13 | 288 |

⁽¹⁾ Trim set to 1.0.

8.2.43 TPS99000-Q1 TIA1 Gain - Read (89h)

This command is used to read back the last applied TPS99000-Q1 TIA1 gain level.

Write Parameters

Table 8-52. TPS99000-Q1 TIA1 Gain Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 3:0 | Gain Index <i>Table 8-51</i> defines the gain level settings. |

8.2.44 TPS99000-Q1 TIA1 Capacitance - Write (8Ah)

This command is used to set TPS99000-Q1 TIA1 capacitance for photodiode capacitance compensation.

Write Parameters

Table 8-53. TPS99000-Q1 TIA1 Capacitance Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 5:0 | TIA1 Capacitance Capacitance = N × 0.5 pF 0x0: 0.0 pF 0x3F: 31.5 pF |

8.2.45 TPS99000-Q1 TIA1 Capacitance - Read (8Bh)

This command is used to read back the last applied TPS99000-Q1 TIA1 capacitance.

Command Parameters

No command parameters.

Return Parameters

Table 8-54. TPS99000-Q1 TIA1 Capacitance Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|-------------------------|
| 1 | 5:0 | TIA1 Capacitance |

8.2.46 TPS99000-Q1 TIA1 Dark Offsets - Write (8Ch)

This command is used to set TPS99000-Q1 TIA1 RGB offsets to compensate for photodiode dark current.

For single-color applications, all dark offsets should be set to the same value.

Write Parameters

Table 8-55. TPS99000-Q1 TIA1 Dark Offsets Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:0 | Red Dark Offset Offset = (N+1) × 1.5mV |
| 2 | 7:0 | Green Dark Offset Offset = (N+1) × 1.5mV |
| 3 | 7:0 | Blue Dark Offset Offset = (N+1) × 1.5mV |

8.2.47 TPS99000-Q1 TIA1 Dark Offsets - Read (8Dh)

This command is used to read back the last applied TPS99000-Q1 TIA1 RGB dark offsets to compensate for photodiode dark current.

Command Parameters

No command parameters.

Return Parameters

Table 8-56. TPS99000-Q1 TIA1 Dark Offsets Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--------------------------|
| 1 | 7:0 | Red Dark Offset |
| 2 | 7:0 | Green Dark Offset |
| 3 | 7:0 | Blue Dark Offset |

8.2.48 TPS99000-Q1 TIA1 Input Offsets - Write (8Eh)

This command is used to set TPS99000-Q1 TIA1 RGB input offsets.

For single-color applications, all input offsets should be set to the same value.

Write Parameters

Table 8-57. TPS99000-Q1 TIA1 Input Offsets Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 2:0 | Red Input Offset Offset = $(N+1) \times 20\text{mV}$ 0x7 = 0mV. This value is an exclusion from the formula above and should not be used because the amplifier requires offset. |
| 2 | 2:0 | Green Input Offset Offset = $(N+1) \times 20\text{mV}$ 0x7 = 0mV. This value is an exclusion from the formula above and should not be used because the amplifier requires offset. |
| 3 | 2:0 | Blue Input Offset Offset = $(N+1) \times 20\text{mV}$ 0x7 = 0mV. This value is an exclusion from the formula above and should not be used because the amplifier requires offset. |
| 4 | 2:0 | Default Input Offset This default is used when no illumination enable is active during the sequence time. Offset = $(N+1) \times 20\text{mV}$ 0x7 = 0mV. This value is an exclusion from the formula above and should not be used because the amplifier requires offset. |

8.2.49 TPS99000-Q1 TIA1 Input Offsets - Read (8Fh)

This command is used to read the last applied TPS99000-Q1 TIA1 RGB input offsets.

Command Parameters

No command parameters.

Return Parameters

Table 8-58. TPS99000-Q1 TIA1 Input Offsets Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|----------------------|
| 1 | 2:0 | Red Input Offset |
| 2 | 2:0 | Green Input Offset |
| 3 | 2:0 | Blue Input Offset |
| 4 | 2:0 | Default Input Offset |

8.2.50 TPS99000-Q1 Drive Mode - Read (93h)

This command is used to read back the last applied value of photo feedback mode, minimum COMPOUT low time, and CMODE setting.

Command Parameters

No command parameters.

Return Parameters

Table 8-59. TPS99000-Q1 Drive Mode Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|------------------------------------|
| 1 | 0 | Photo Feedback Mode Enabled |
| 2 | 7:0 | COMPOUT Low |
| 3 | 0 | CMODE Enable |

8.2.51 TPS99000-Q1 ADC Configuration - Write (94h)

This command is used to configure ADC selections for the TIA1 Stage Monitor and low-side current sense gain in the TPS99000-Q1.

Write Parameters

Table 8-60. TPS99000-Q1 ADC Configuration Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:4 | Reserved |
| | 3:2 | Low-side current sense gain Gain for ADC0 input. 0x0: 24x 0x1: 12x 0x2: 9x 0x3: 24x |
| | 1:0 | TIA1 Stage Monitor Select Voltage monitor point within TIA1. Input to ADC30. 0x0: Stage A (Input offset output, Trim input) 0x1: Stage B (Trim output, Dark offset input) 0x2: Stage C (Gain #2 output, Gain #3 input) 0x3: Stage D (Gain #3 output, TIA output) |

8.2.52 TPS99000-Q1 ADC Configuration - Read (95h)

This command is used to read back last applied ADC configuration settings.

Command Parameters

No command parameters.

Return Parameters

Table 8-61. TPS99000-Q1 ADC Configuration Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|------------------------------------|
| 1 | 7:4 | Reserved |
| | 3:2 | Low-side current sense gain |
| | 1:0 | TIA1 Stage Monitor Select |

8.2.53 TPS99000-Q1 Illumination Sync Control - Write (96h)

This command is used to configure TPS99000-Q1 illumination synchronization.

Write Parameters

Table 8-62. TPS99000-Q1 Illumination Sync Control Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 3:0 | DRV_EN Low Time DRV_EN low time = (N+1) * (SEQ_CLK Period) 0x0: 1 SEQ_CLK Period 0x15: 16 SEQ_CLK Period |
| 2 | 3:0 | SYNC Pulse Width SYNC clock pulse high width SYNC Pulse Width = N * (SEQ_CLK Period) 0x0: SYNC pin low 0xF: 15 * SEQ_CLK Period |
| 3 | 7:0 | SYNC Period SYNC clock period 0x0: SYNC pin low 0x1 - 0x8: Invalid, do not use. 0x9 - 0xFF: SYNC Period = (N+1) * (SEQ_CLK Period) |

8.2.54 TPS99000-Q1 Illumination Sync Control - Read (97h)

This command is used to read back the last applied values for TPS99000-Q1 illumination synchronization.

Write Parameters

Table 8-63. TPS99000-Q1 Illumination Sync Control Read Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|-------------------------|
| 1 | 3:0 | DRV_EN Low Time |
| 2 | 3:0 | Sync Pulse Width |
| 3 | 7:0 | Sync Period |

8.2.55 TPS99000-Q1 TIA2 Control - Write (98h)

This command is used to configure TPS99000-Q1 transimpedance amplifier 2 (TIA2).

Write Parameters

Table 8-64. TPS99000-Q1 TIA2 Control Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 0 | Enable Enables TIA2. When disabled, TIA2 enters a low power state. 0x0: Disable 0x1: Enable |
| 2 | 3:0 | Gain Index <i>Table 8-65</i> defines the gain level settings. |
| 3 | 7:0 | Trim Trim gain = 1 - N * (0.8 / 255) 0x0: 1.0x 0xFF: 0.2x |
| 4 | 2:0 | Input Offset Offset = (N+1) * 20mV 0x7 = 0mV. This value is an exclusion from the formula above and should not be used because the amplifier requires offset. |
| 5 | 7:0 | Dark Offset Offset = N * 1.5mV |
| 6 | 5:0 | Capacitance Capacitance = N * 0.5pF 0x0: 0.0 pF 0x3F: 31.5 pF |
| 7 | 1:0 | Stage Monitor Select Voltage monitor point within TIA2. Input to ADC31. 0x0: Stage A (Input offset output, Trim input) 0x1: Stage B (Trim output, Dark offset input) 0x2: Stage C (Gain #2 output, Gain #3 input) 0x3: Stage D (Gain #3 output, TIA output) |

Table 8-65. TIA2 Gain Values

| GAIN INDEX | GAIN (kV/A) ⁽¹⁾ |
|------------|----------------------------|
| 0 | 0.75 |
| 1 | 1.5 |
| 2 | 3 |
| 3 | 6 |
| 4 | 9 |
| 5 | 12 |
| 6 | 18 |
| 7 | 24 |
| 8 | 36 |
| 9 | 48 |
| 10 | 72 |
| 11 | 96 |
| 12 | 144 |
| 13 | 288 |

⁽¹⁾ Trim set to 1.0.

8.2.56 TPS99000-Q1 TIA2 Control - Read (99h)

This command is used to read back the last applied configuration of TPS99000-Q1 transimpedance amplifier 2 (TIA2).

Command Parameters

No command parameters.

Return Parameters

Table 8-66. TPS99000-Q1 TIA2 Control Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|----------------------|
| 1 | 0 | Enable |
| 2 | 3:0 | Gain Index |
| 3 | 7:0 | Trim |
| 4 | 2:0 | Input Offset |
| 5 | 7:0 | Dark Offset |
| 6 | 5:0 | Capacitance |
| 7 | 1:0 | Stage Monitor Select |

8.2.57 LED Drive Errors - Read (9Ah)

This command is used to read back the current illumination pulse error information while operating in discontinuous mode.

Command Parameters

No command parameters.

Return Parameters

Table 8-67. LED Drive Errors Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 7:3 | Reserved |
| | 2 | Pulse Width Error Flag Indicates that the SEN signal was held low longer than the maximum allowable time for a single pulse and was therefore forced high. This typically indicates that a light pulse was unable to achieve the desired photo feedback level within the allocated pulse time. 0x0: No error 0x1: Error |
| | 1 | Pulse Count Error Flag Indicates that too few pulses were generated within a bit slice. 0x0: No error 0x1: Error |
| | 0 | No Compare Error Flag Indicates that COMPOUT never went low within a bit slice. 0x0: No error 0x1: Error |

8.2.58 LED Drive Errors Clear - Write (9Bh)

This command is used to clear illumination pulse error flags. Writing a 1 to any bit will clear the specified flag.

Write Parameters

Table 8-68. LED Drive Errors Clear Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:3 | Reserved |
| | 2 | Pulse Width Error Clear Mask 0x0: Do not clear 0x1: Clear error flag to 0 |
| | 1 | Pulse Count Error Clear Mask 0x0: Do not clear 0x1: Clear error flag to 0 |
| | 0 | No Compare Error Clear Mask 0x0: Do not clear 0x1: Clear error flag to 0 |

8.2.59 TPS99000-Q1 Test Mux Select - Write (9Ch)

This command is used to select TPS99000-Q1 test mux output signals.

Write Parameters

Table 8-69. TPS99000-Q1 Test Mux Select Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:0 | AMUX0 Select 0x0: TIA1 Output Voltage 0x1: TIA1 Filtered Output Voltage 0x2: TIA2 Output Voltage 0x3: TIA2 Filtered Output Voltage 0x1B: Current sense amplifier output |
| 2 | 7:0 | AMUX1 Select 0x0: Photo Feedback DAC 0x1: Current Feedback DAC 0x3: TIA1 Input Offset 0x4: TIA2 Input Offset 0xC: VMAIN |
| 3 | 7:0 | DMUX0 Select 0x0: DLPC230-Q1 to TPS99000-Q1 SPI Parity Error 0x1C: 3.3V Monitor Power Good 0x1E: 1.8V Monitor Power Good 0x20: 1.1V Monitor Power Good 0x40: Over-brightness Fault 0x79: 2MHz Internal Oscillator 0x7A: 15MHz State Machine Clock 0x7B: 2.5MHz ADC Clock 0x7C: SPI1 Clock 0x7D: SPI2 Clock 0x7E: 30MHz Sequencer Clock 0x84: Watchdog 1 Error 0x86: Watchdog 2 Error 0x9C: ADC Interface Parity Error 0xA2: ADC Channel 1 Saturated 0xA3: ADC Channel 1 Underflow 0xAD: ADC End Of Conversion 0xB3: State Machine Change 0xD0: State Machine Index Bit 0 0xD1: State Machine Index Bit 1 0xD2: State Machine Index Bit 2 0xD3: State Machine Index Bit 3 0xD4: State Machine Index Bit 4 |

Table 8-69. TPS99000-Q1 Test Mux Select Write Parameters (continued)

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 4 | 7:0 | DMUX1 Select 0x0: DLPC230-Q1 to TPS99000-Q1 SPI Parity Error 0x1C: 3.3V Monitor Power Good 0x1E: 1.8V Monitor Power Good 0x20: 1.1V Monitor Power Good 0x40: Over-brightness Fault 0x79: 2MHz Internal Oscillator 0x7A: 15MHz State Machine Clock 0x7B: 2.5MHz ADC Clock 0x7C: SPI1 Clock 0x7D: SPI2 Clock 0x7E: 30MHz Sequencer Clock 0x84: Watchdog 1 Error 0x86: Watchdog 2 Error 0x9C: ADC Interface Parity Error 0xA2: ADC Channel 1 Saturated 0xA3: ADC Channel 1 Underflow 0xAD: ADC End Of Conversion 0xB3: State Machine Change 0xD0: State Machine Index Bit 0 0xD1: State Machine Index Bit 1 0xD2: State Machine Index Bit 2 0xD3: State Machine Index Bit 3 0xD4: State Machine Index Bit 4 |

8.2.60 TPS99000-Q1 Test Mux Select - Read (9Dh)

This command is used to read back the last applied TPS99000-Q1 test mux indexes.

Command Parameters

No command parameters.

Return Parameters

Table 8-70. TPS99000-Q1 Test Mux Select Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---------------------|
| 1 | 7:0 | AMUX0 Select |
| 2 | 7:0 | AMUX1 Select |
| 3 | 7:0 | DMUX0 Select |
| 4 | 7:0 | DMUX1 Select |

8.2.61 Flash Data Type Select - Write (A0h)

This command is used to specify the type of data that will be written to flash memory. More information on flash programming can be found in [Section 5.3](#).

Write Parameters

Table 8-71. Flash Data Type Select Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|-------|---|
| 1 | 7:0 | Flash Data Type Refer to Table 8-72 for options. |
| 5:2 | 31:0 | Flash Package Size The number of bytes in the binary file that is to be written to flash. |
| 21:6 | 127:0 | Data Header The first 16 bytes of the flash package that is being written. These header bytes allow embedded software to identify and verify the data stored in the binary. |

The flash data types are described in [Table 8-72](#).

Table 8-72. Flash Data Type Values

| FLASH DATA TYPE VALUE | DESCRIPTION |
|-----------------------|-------------------------------------|
| 0x00 | Entire flash |
| 0x01 | Entire flash except scratchpad data |
| 0x30 | Main Application |
| 0x40 | Configuration Data 0 |
| 0x50 | Configuration Data 1 |
| 0x60 | Batch command sets |
| 0x90 | Splash Data 0 |
| 0x91 | Splash Data 1 |
| 0x92 | Splash Data 2 |
| 0x93 | Splash Data 3 |
| 0x94 | Splash Data 4 |
| 0x95 | Splash Data 5 |
| 0x96 | Splash Data 6 |
| 0x97 | Splash Data 7 |
| 0xA0 | Scratchpad Data 0 |
| 0xA1 | Scratchpad Data 1 |

Table 8-72. Flash Data Type Values (continued)

| FLASH DATA TYPE VALUE | DESCRIPTION |
|-----------------------|-------------------|
| 0xA2 | Scratchpad Data 2 |
| 0xA3 | Scratchpad Data 3 |

8.2.62 Flash Erase Data - Write (A1h)

This command directs software to erase the flash data that was selected using the [Flash Data Type Select](#) command.

The *Request in Progress* bit of the Short Status will be set at the start of the flash erase process and will be cleared when the erase process is complete.

The *Operational Error* bit in the Short Status can be used to determine whether an error occurred during the erase process.

More information on flash programming can be found in [Section 5.3](#).

Write Parameters

Table 8-73. Flash Erase Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---------------------------------|
| 1 | 7:0 | Signature Byte 1 0xAA |
| 2 | 7:0 | Signature Byte 2 0xBB |
| 3 | 7:0 | Signature Byte 3 0xCC |
| 4 | 7:0 | Signature Byte 4 0xDD |

8.2.63 Flash Write Data - Write (A2h)

This is a bulk write command that directs the system to write up to 256 bytes of payload data to the flash device. The number of bytes must be a multiple of 4. The first write transaction after a [Flash Erase Data](#) command will start at the first address of the flash data type that was selected using the [Flash Data Type Select](#) command. Each subsequent command will write a page of flash data and the flash address will be incremented to the next page.

Note that this command is not the same as the boot application flash write command because this command allows a variable number of bytes to be sent.

The *Request in Progress* bit of the Short Status will be set at the start of the flash write process and will be cleared when each write transaction is complete. The next flash write should not begin until the *Request in Progress* bit is cleared.

More information on flash programming can be found in [Section 5.3](#).

Write Parameters

Table 8-74. Flash Write Data Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:0 | Data Byte 1 |
| 2 | 7:0 | Data Byte 2 |
| ... | ... | Data Byte ... |
| n | 7:0 | Data Byte n The number of bytes, n, must be a multiple of 4. |

8.2.64 Flash Read Data - Read (A3h)

This command is used to read data from the flash device. A flash data block is selected for reading and the read will occur relative to that block's location in flash.

For most flash data types, the start address has two possible values: 0x0000 indicates start at the beginning of the selected block type. 0xFFFF indicates start where the last read operation ended for continuous reading.

For scratchpad data types, the start address can be any 32-bit aligned address (0x0, 0x4, 0x8, ...). This unique case allows for partial reading of specific regions of scratchpad data.

Command Parameters

Table 8-75. Flash Read Data Command Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 7:0 | Flash Data Type Refer to Table 8-76 for options. |
| 3:2 | 15:0 | Start Address First byte of flash memory to read Most flash data types: <ul style="list-style-type: none"> • 0x0000: Start at beginning of flash data type • 0x0001 - 0xFFFF: Reserved • 0xFFFF: Start where last read operation ended (continue reading) Scratchpad data types: Relative 32-bit aligned address (0x0, 0x4, 0x8, ...) |
| 4 | 15:0 | Read Data Length 0-based number of bytes to read (0x0 = 1 byte) Must be a multiple of 4 and the maximum is 256 bytes (0xFF) |

The flash data types are described in [Table 8-76](#).

Table 8-76. Flash Data Type Values

| FLASH DATA TYPE VALUE | DESCRIPTION |
|-----------------------|--|
| 0x00 | Entire flash |
| 0x01 | Entire flash except scratchpad data |
| 0x30 | Main Application |
| 0x40 | Configuration Data 0 |
| 0x48 | Configuration Data 0 Flash Information Field |
| 0x50 | Configuration Data 1 |
| 0x58 | Configuration Data 1 Flash Information Field |
| 0x60 | Batch Command Sets |
| 0x68 | Batch Command Sets Flash Information Field |
| 0x78 | System Data Flash Information Field |
| 0x90 | Splash Data 0 |
| 0x91 | Splash Data 1 |
| 0x92 | Splash Data 2 |
| 0x93 | Splash Data 3 |
| 0x94 | Splash Data 4 |
| 0x95 | Splash Data 5 |
| 0x96 | Splash Data 6 |
| 0x97 | Splash Data 7 |
| 0x98 | Splash Data 0 Flash Information Field |
| 0x99 | Splash Data 1 Flash Information Field |
| 0x9A | Splash Data 2 Flash Information Field |
| 0x9B | Splash Data 3 Flash Information Field |

Table 8-76. Flash Data Type Values (continued)

| FLASH DATA TYPE VALUE | DESCRIPTION |
|-----------------------|--|
| 0x9C | Splash Data 4 Flash Information Field |
| 0x9D | Splash Data 5 Flash Information Field |
| 0x9E | Splash Data 6 Flash Information Field |
| 0x9F | Splash Data 7 Flash Information Field |
| 0xA0 | Scratchpad Data 0 |
| 0xA1 | Scratchpad Data 1 |
| 0xA2 | Scratchpad Data 2 |
| 0xA3 | Scratchpad Data 3 |
| 0xB8 | Calibration Data Flash Information Field |

Return Parameters**Table 8-77. Flash Read Data Return Parameters**

| BYTE | BITS | DESCRIPTION |
|---------|------|--|
| 1 ... n | | Read Data Bytes Data bytes read from flash beginning at the commanded start address. The number of bytes, n, is determined by the commanded read data length. |

8.2.65 Flash Verify Data - Write (A4h)

This command is used to verify the contents of the flash device.

The *Request in Progress* bit of the Short Status will be set at the start of the flash verify process and will be cleared when the verify process is complete. The error bits of the Short Status can be read to determine if an error occurred during the flash verify.

More information on flash programming can be found in [Section 5.3](#).

Write Parameters

Table 8-78. Flash Verify Data Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:0 | Flash Data Type Refer to Table 8-79 for options. |

The flash data types are described in [Table 8-79](#).

Table 8-79. Flash Data Type Values

| FLASH DATA TYPE VALUE | DESCRIPTION |
|-----------------------|-------------------------------------|
| 0x00 | Entire flash |
| 0x01 | Entire flash except scratchpad data |
| 0x30 | Main Application |
| 0x40 | Configuration Data 0 |
| 0x50 | Configuration Data 1 |
| 0x60 | Batch command sets |
| 0x90 | Splash Data 0 |
| 0x91 | Splash Data 1 |
| 0x92 | Splash Data 2 |
| 0x93 | Splash Data 3 |
| 0x94 | Splash Data 4 |
| 0x95 | Splash Data 5 |
| 0x96 | Splash Data 6 |
| 0x97 | Splash Data 7 |
| 0xA0 | Scratchpad Data 0 |
| 0xA1 | Scratchpad Data 1 |
| 0xA2 | Scratchpad Data 2 |
| 0xA3 | Scratchpad Data 3 |

8.2.66 Flash Block Count - Read (A5h)

This command is used to read the number of flash blocks stored in flash memory and EEPROM memory.

Command Parameters

No command parameters.

Return Parameters

Table 8-80. Flash Block Count Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 7:0 | Block count Number of flash blocks. |

8.2.67 Flash Block CRCs - Read (A6h)

This command is used to read the CRC values for all of the flash blocks stored in flash memory. These CRC values are used by the DLPC230-Q1 software to verify the contents of the flash blocks, but they can also be used as a tracking identifier for flash content. The expected CRC values for the flash data can be found in the flash header file that is delivered along with the flash data.

The return data length is variable based on the number of flash blocks. For each flash block, the command will return eight bytes of data. The number of flash blocks can be determined using the [Flash Block Count](#) command.

Command Parameters

No command parameters.

Return Parameters

Table 8-81. Flash Block CRCs Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 4:1 | 31:0 | Flash Block 1 Identifier 7-bit ASCII code identifier of the flash block LSByte = Byte 1 |
| 8:5 | 31:0 | Flash Block 1 CRC CRC value of the flash block LSByte = Byte 5 |
| 9:n | | Flash Block Identifier and CRC for remaining blocks Each block receives 8 bytes for identifier and CRC. These bytes are in the same format as bytes 8:1 for Flash Block 1. |

8.2.68 Flash Structure Version - Read (A7h)

This command is used to read the flash structure version of the current flash build. Each main application expects a certain flash structure version. Flash programming will fail if the flash structure version of the incoming data does not match the version that the main application expects. Note that this is different than data-dependent versioning. Data-dependent versioning is performed with flash block CRCs.

Command Parameters

No command parameters.

Return Parameters

Table 8-82. Flash Structure Version Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 2:1 | 15:0 | Flash Structure Version - Patch LSByte = Byte 1 |
| 3 | 7:0 | Flash Structure Version - Minor |
| 4 | 7:0 | Flash Structure Version - Major |

8.2.69 Flash Data Size - Read (A9h)

This command is used to read the size of the specified flash block. This size returned is the maximum size available for the specified block. This can be used during partial flash programming to confirm whether the new flash block can fit within the previously allocated size. Refer to [Section 5.3](#) for more information on flash programming.

Command Parameters

Table 8-83. Flash Data Size Command Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:0 | Flash Data Type Refer to Table 8-84 for options. |

The flash data types are described in [Table 8-84](#).

Table 8-84. Flash Data Type Values

| FLASH DATA TYPE VALUE | DESCRIPTION |
|-----------------------|--|
| 0x00 | Entire flash |
| 0x01 | Entire flash except scratchpad data |
| 0x30 | Main Application (Build 0) |
| 0x40 | Configuration Data 0 |
| 0x48 | Configuration Data 0 Flash Information Field |
| 0x50 | Configuration Data 1 |
| 0x58 | Configuration Data 1 Flash Information Field |
| 0x60 | Batch Command Sets |
| 0x90 | Splash Data 0 |
| 0x91 | Splash Data 1 |
| 0x92 | Splash Data 2 |
| 0x93 | Splash Data 3 |
| 0x94 | Splash Data 4 |
| 0x95 | Splash Data 5 |
| 0x96 | Splash Data 6 |
| 0x97 | Splash Data 7 |
| 0xA0 | Scratchpad Data 0 |
| 0xA1 | Scratchpad Data 1 |
| 0xA2 | Scratchpad Data 2 |
| 0xA3 | Scratchpad Data 3 |

Return Parameters

Table 8-85. Flash Data Size Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 4:1 | 31:0 | Block Size Number of bytes in the selected flash block. LSByte = Byte 1 |

8.2.70 System Software Version - Read (B0h)

This command is used to read the software version of the main application. This command is identical to the boot application command, but the boot application and main application will not have the same version number.

Command Parameters

No command parameters.

Return Parameters

Table 8-86. System Software Version Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:0 | DLPC230-Q1 Main Application Version - Patch |
| 2 | 7:0 | DLPC230-Q1 Main Application Version - Branch |
| 3 | 7:0 | DLPC230-Q1 Main Application Version - Minor |
| 4 | 7:0 | DLPC230-Q1 Main Application Version - Major |

8.2.71 Flash Device ID - Read (B1h)

This command is used to read flash device information.

Command Parameters

No command parameters.

Return Parameters

Table 8-87. Flash Device ID Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|-----------------------|
| 1 | 7:0 | Flash Manufacturer ID |
| 2 | 7:0 | Flash Memory Type |
| 3 | 7:0 | Flash Memory Capacity |

The manufacturer ID and memory type can be found from the selected flash device specification.

The flash memory size can be determined from [Table 8-88](#).

Table 8-88. Flash Memory Size Values

| MEMORY CAPACITY (BYTE 3) | ACTUAL SIZE |
|--------------------------|-----------------------|
| 0x15 | 16 Mb |
| 0x16 | 32 Mb |
| 0x17 | 64 Mb |
| 0x18 | 128 Mb |
| 0x19 | 256 Mb ⁽¹⁾ |

⁽¹⁾ Only the first 128Mb of address space is useable.

8.2.72 DLPC230-Q1 Device ID - Read (B2h)

This command is used to read the DLPC230-Q1 device ID. This command can return two sets of bytes depending on the byte parameter that is sent with the command.

Command Parameters

Table 8-89. DLPC230-Q1 Device ID Command Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:0 | DLPC230-Q1 Data Selection 0x0: Read DLPC230-Q1 device ID and Product Configuration ID 0x1: Read DLPC230-Q1 fuse data 0x02 - 0xFF: Reserved |

Return Parameters (0x0)

The return parameters in [Table 8-90](#) are returned if the command parameter is 0x0.

Table 8-90. DLPC230-Q1 Device ID Return Parameters 0x0

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:0 | DLPC230-Q1 Device ID |
| 2 | 7:4 | Reserved |
| | 3:0 | DLPC230-Q1 Product Configuration ID |

[Table 8-91](#) shows the possible DLPC230-Q1 Device ID values.

Table 8-91. DLPC230-Q1 Device IDs

| Device ID Value | DLPC230-Q1 Architecture | DLPC230-Q1 Turn | DLPC230-Q1 Pass |
|-----------------|-------------------------|-----------------|-----------------|
| 0x98 | b10011 | b00 | b0 |

Return Parameters (0x1)

The return parameters in [Table 8-92](#) are returned if the command parameter is 0x1.

Table 8-92. DLPC230-Q1 Device ID Return Parameters 0x1

| BYTE | BITS | DESCRIPTION |
|------|------|---------------------------|
| 8:1 | 63:0 | DLPC230-Q1 Fuse ID |

Table 8-93. DLPC230-Q1 Fuse ID Definition

| BITS | LENGTH (BITS) | DESCRIPTION |
|-------|---------------|---|
| 0:29 | 30 | Product Lot ID Device manufacturer tracking data |
| 30:31 | 2 | TI Device ID |
| 32:36 | 5 | Wafer ID Device manufacturer tracking data |
| 37:50 | 14 | Die X/Y Device manufacturer tracking data |
| 51 | 1 | Fab ID Device manufacturer tracking data |
| 52:55 | 4 | TI Product Cfg ID |
| 56:63 | 8 | CRC8 ⁽¹⁾ |

⁽¹⁾ CRC uses CRC-8 CCITT (x^8+x^2+x+1) on each byte of data beginning with the least significant byte. The initial value is 0xFF.

8.2.73 DMD Device ID - Read (B3h)

This command is used to read the DMD device ID. This command can return two sets of bytes depending on the byte parameter that is sent with the command.

Command Parameters

Table 8-94. DMD Device ID Command Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:0 | DMD Data Selection 0x0: Read DMD Device ID 0x1 - 0xFF: Reserved |

Return Parameters

The return parameters below are returned if the command parameter is 0x0.

Table 8-95. DMD Device ID Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|----------------------|
| 4:1 | 31:0 | DMD Device ID |

Table 8-96. DMD Device IDs

| DEVICE DESCRIPTION | DEVICE ID (HEX) |
|--------------------|-----------------|
| 0.55" ES1 | 60 0D 00 7E |
| 0.55" ES1.1 | 60 0D 00 82 |
| 0.55" ES2 | 60 0D 00 81 |

8.2.74 TPS99000-Q1 Device ID - Read (B4h)

This command is used to read the TPS99000-Q1 device information.

Command Parameters

No command parameters.

Return Parameters

Table 8-97. TPS99000-Q1 Device ID Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|------------------------------------|
| 1 | 7:4 | TPS99000-Q1 Device ID Major |
| | 3:0 | TPS99000-Q1 Device ID Minor |

8.2.75 System Temperatures - Read (B5h)

This command is used to read system temperatures. The reporting range is -40°C to 128°C. The reported temperature includes an integer component and a fractional component. The fractional component is always added to the integer component. Temperature filtering averages multiple raw measurements in order to reduce noise from the temperature measurements.

Command Parameters

Table 8-98. System Temperatures Command Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 7:0 | Temperature Source Selection 0x0: DMD raw temperature 0x1: DMD filtered temperature 0x2: Temperature sensor local raw temperature 0x3: Temperature sensor local filtered temperature 0x4 - 0xFF: Reserved |

Return Parameters

Table 8-99. System Temperatures Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 2:1 | 15:8 | Temperature Integer Celsius Two's complement integer portion of temperature 127 = 127 Celsius 255 = -1 Celsius |
| | 7:4 | Temperature Fraction Celsius 1/16 Celsius steps always added to the integer portion. Note that this fraction is still added even if the integer portion is negative. 1 = 0.0625 Celsius 2 = 0.125 Celsius |
| 3 | 3:0 | Reserved |
| 3 | 7:0 | Reserved |

8.2.76 Current Source Information - Read (B6h)

This command is used to read information about the currently active image source. The first byte specifies the type of source and subsequent bytes describe the settings for the source type. Each source type has different description parameters, but the length of the return bytes from this command is always 15 bytes.

Command Parameters

No command parameters.

Return Parameters (External Video)

Table 8-100. Current Source Information Return Parameters (External Video)

| BYTE | BITS | DESCRIPTION |
|-------|------|--|
| 1 | 7:0 | Input Source Type 0x0: External Video 0x1: Test Pattern 0x2: Splash Screen 0x3: System in Standby or source is invalid |
| 3:2 | 15:0 | External VSync Rate LSByte = Byte 2 Specified in Hz with a resolution of 0.125 Hz. For example, 0x1E5 = 60.625 Hz. |
| 4 | 7:0 | External Video Format 0x00: OpenLDI 0x40: Parallel |
| 5 | 7:4 | Reserved |
| | 3 | External Data Enable Polarity Polarity of the parallel video DATEN signal. This parameter is unused for OpenLDI. 0x0: Active Low 0x1: Active High |
| | 2 | External Clock Polarity Polarity of the parallel video PCLK signal. This parameter is unused for OpenLDI. 0x0: Falling Edge Sample 0x1: Rising Edge Sample |
| | 1 | External HSync Polarity 0x0: Falling Edge Active (Negative Pulse) 0x1: Rising Edge Active (Positive Pulse) |
| | 0 | External VSync Polarity 0x0: Falling Edge Active (Negative Pulse) 0x1: Rising Edge Active (Positive Pulse) |
| 7:6 | 15:0 | External Pixel Clock Rate LSByte = Byte 6 Specified in MHz with a resolution of 0.125 MHz. For example, 0x1E1 = 60.125 MHz. |
| 9:8 | 15:0 | Input Total Pixels Per Line LSByte = Byte 8 |
| 11:10 | 15:0 | Input Total Lines Per Frame LSByte = Byte 10 |
| 13:12 | 15:0 | Input Active Pixels Per Line LSByte = Byte 12 |
| 15:14 | 15:0 | Input Active Lines Per Frame LSByte = Byte 14 |

Return Parameters (Test Pattern)

Table 8-101. Current Source Information Return Parameters (Test Pattern)

| BYTE | BITS | DESCRIPTION |
|-------|------|--|
| 1 | 7:0 | Input Source Type 0x0: External Video 0x1: Test Pattern 0x2: Splash Screen 0x3: Not applicable (System in Standby) |
| 3:2 | 15:0 | Internal VSync Rate LSByte = Byte 2 Specified in Hz with a resolution of 0.125 Hz. For example, 0x1E5 = 60.625 Hz. |
| 4 | 7:0 | Test Pattern Type 0x00: Solid 0x01: Horizontal Ramp (Fixed step) 0x02: Vertical Ramp (Fixed step) 0x03: Horizontal Lines 0x04: Diagonal Lines 0x05: Vertical Lines 0x06: Grid Lines (Horizontal and Vertical) 0x07: Checkerboard 0x08 Color Bars 0x09 - 0x0F: Reserved |
| 5 | 7:4 | Foreground Color Foreground color is not used when certain test pattern types are displayed. Refer to Table 8-102 . This value should be ignored if the test pattern type does not use this value. 0x0: Black 0x1: Red 0x2: Green 0x3: Blue 0x4: Cyan 0x5: Magenta 0x6: Yellow 0x7: White 0x8 - 0xF: Reserved |
| | 3:0 | Background Color Background color is not used when certain test pattern types are displayed. Refer to Table 8-102 . This value should be ignored if the test pattern type does not use this value. 0x0: Black 0x1: Red 0x2: Green 0x3: Blue 0x4: Cyan 0x5: Magenta 0x6: Yellow 0x7: White 0x8 - 0xF: Reserved |
| 9:6 | 39:0 | Test Pattern Parameters <i>Reserved</i> |
| 15:10 | 47:0 | Pad Bytes Extra bytes to keep the command's return length 15 bytes for any source type Value = 0x0 |

Table 8-102. Test Pattern Foreground / Background Color Usage

| PATTERN | FOREGROUND COLOR USED | BACKGROUND COLOR USED |
|------------------|-----------------------|-----------------------|
| Solid | Yes | No |
| Horizontal Ramp | Yes | No |
| Vertical Ramp | Yes | No |
| Horizontal Lines | Yes | Yes |
| Vertical Lines | Yes | Yes |
| Diagonal Lines | Yes | Yes |
| Grid Lines | Yes | Yes |
| Checkerboard | Yes | Yes |
| Color Bars | No | No |

Return Parameters (Splash)**Table 8-103. Current Source Information Return Parameters (Splash)**

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 7:0 | Input Source Type 0x0: External Video 0x1: Test Pattern 0x2: Splash Screen 0x3: Not applicable (System in Standby) |
| 3:2 | 15:0 | Internal VSync Rate LSByte = Byte 2 Specified in Hz with a resolution of 0.125 Hz. For example, 0x1E5 = 60.625 Hz. |
| 4 | 7:0 | Splash Screen Index Reference number of the splash screen stored in flash (0-7). |
| 15:5 | 87:0 | Pad Bytes Extra bytes to keep the command's return length 15 bytes for any source type Value = 0x0 |

8.2.77 Current Display Information - Read (B8h)

This command is used to read information about the currently active display settings.

Command Parameters

No command parameters.

Return Parameters

Table 8-104. Current Display Information Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:1 | Reserved |
| | 0 | LED Status 0x0: LEDs disabled 0x1: LEDs enabled |
| 2 | 7:2 | Reserved |
| | 1 | Short Axis Image Flip 0x0: Image not flipped 0x1: Image flipped |
| | 0 | Long Axis Image Flip 0x0: Image not flipped 0x1: Image flipped |
| 8:3 | 47:0 | Reserved |
| 9 | 7:0 | System Mode Index |
| 10 | 7:0 | Illumination Bin Index |
| 11 | 7:0 | De-gamma LUT Index |
| 12 | 7:0 | Sequence Index |

8.2.78 System Information - Read (BAh)

This command is used to read the last reset cause and the product configuration.

Command Parameters

No command parameters.

Return Parameters

Table 8-105. System Information Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---|
| 1 | 7:0 | Reset Cause 0x00: ASIC Power-Up 0x01: PROJ_ON 0x02: TPS99000-Q1 Watchdog Software Error 0x03: TPS99000-Q1 Watchdog Sequence Error 0x02 - 0x03: <i>Reserved</i> 0x04: TPS99000-Q1 Die Temperature Exceeded 0x05: Software Commanded Power Cycle 0x06: <i>Reserved</i> 0x07: Host Commanded Reset 0x08: Software commanded DLPC230-Q1-Only Reset 0x09 - 0xFF: <i>Reserved</i> |
| 2 | 7:0 | Product Configuration 0x00: HUD 0x01: Headlight 0x02 - 0xFF: <i>Reserved</i> |

8.2.79 Flash Interface Rate - Read (BBh)

This command is used to read the flash interface rate settings.

Command Parameters

No command parameters.

Return Parameters

Table 8-106. Flash Interface Rate Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:5 | Reserved Always 0x0 |
| | 4 | Quad Input / Output Read 0x0: Not supported 0x1: Supported |
| | 3 | Quad Output Read 0x0: Not supported 0x1: Supported |
| | 2 | Dual Input / Output Read 0x0: Not supported 0x1: Supported |
| | 1 | Dual Output Read 0x0: Not supported 0x1: Supported |
| | 0 | Fast Read 0x0: Not supported 0x1: Supported |
| 3:2 | 15:0 | Maximum Flash Clock Rate LSByte = Byte 2 This value should be divided by 100 to read the MHz value. For example, 0x134D = 4941 / 100 = 49.41 MHz. |

Table 8-107. Flash Read Instruction Op-Codes

| FLASH INSTRUCTION NAME | FLASH OP-CODE |
|--------------------------|---------------|
| Fast Read | 0x0B |
| Dual Output Read | 0x3B |
| Dual Input / Output Read | 0xBB |
| Quad Output Read | 0x6B |
| Quad Input / Output Read | 0xEB |

8.2.80 Short Status - Read (C0h)

This command is used to read the short status from hardware. This is the only read command that does not require the use of *Read Pre-Fetch* and *Read Activate* commands. Refer to the [Communication Protocol](#) section for more information on the Short Status protocol.

Command Parameters

No command parameters.

Return Parameters

Table 8-108. Short Status Return Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 1 | 7:6 | Application / Mode 0x0: Boot application 0x1: Main application - Standby 0x2: Main application - Display |
| | | Emergency Shutdown 0x0: Not activated 0x1: Activated |
| | | Reserved |
| | 3 | Read Data Available 0x0: No data available 0x1: Data available |
| | | System Busy 0x0: Not busy 0x1: Busy |
| | 2 | Request in Progress 0x0: Not in progress 0x1: In progress |
| | | System Initialized 0x0: Not initialized 0x1: Initialized |
| 2 | 7:0 | Execution Command Tag |
| 4:3 | 15 | BIST Error 0x0: No error 0x1: Error |
| | 14 | Operational Error 0x0: No error 0x1: Error |
| | 13 | Command Error 0x0: No error 0x1: Error |
| | 12 | Communication Error 0x0: No error 0x1: Error |
| | 11:0 | Error Code |

A diagram of these short status bits is shown in Figure 8-1.

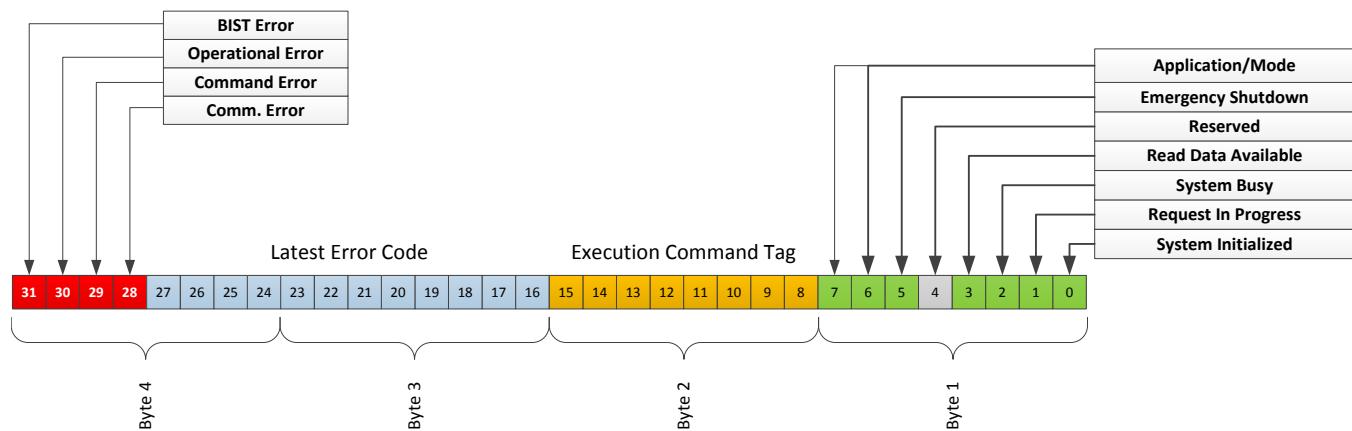


Figure 8-1. Short Status Bit Definition

The bits are described in Table 8-109.

Table 8-109. Short Status Field Descriptions

| BIT FIELD | DEFINITION |
|-----------------------|--|
| System Initialized | Indicates that the system software is ready to accept commands for processing. Typically this would be set by the Main Application, except when the system is forced to stay in boot. |
| Request in Progress | This bit is used to inform the host that a commanded task is being performed. When the task is initiated, this bit will be set to "Yes" and when the operation has completed the bit will be cleared to "No". If the task was a BIST, the results for the requested test will be valid once the bit has been cleared by embedded software. Further requests can be started after this. |
| System Busy | This bit is used to inform the host that the system's receive FIFO is full. The host should not send any more commands when the system is busy, or the commands and associated data may be lost. The Host is free to send commands when the system is not busy. |
| Read Data Available | Indicates when read data is available after the host has sent a Read Prefetch command. When data is available, the host should send the Read Activate command to fetch the requested data. The host should always fetch requested data using the Read Activate command before sending another Read Prefetch command. If a Read Prefetch command is sent before the data from a previous Read Prefetch command has been fetched, the previous data will be flushed, and the latest requested data will be made available for fetching by Read Activate. There will be no error indication that this has occurred. |
| Emergency Shutdown | This bit is used to indicate that the system has automatically gone to Standby Mode due to a critical system error. More information on emergency shutdown can be found in Section 6.2 . |
| Application/Mode | These bits indicate which software application is currently running, and when in the Main Application, they indicate the current operational mode of the system. |
| Execution Command Tag | The command tag for the last write command that has completed software execution, whether successful or not. This byte is continually updated as new commands are received and executed. |
| Error Code | The 12-bit error code is used to specify the last communication or command error received during system operation. The error code can indicate no error (error code = 0h), or indicate a specific code for the most recent error to occur. The Error History command can be used to obtain details about previous errors. |
| Communication Error | A flag set to indicate the occurrence of any communication error, which is used to indicate a problem with the transmission/reception of a command. Some examples are: <ul style="list-style-type: none"> • RXFIFO overflow • Command transmission terminated early (the host didn't provide enough SPI clock pulses for all requested data). • Command transmission terminated late (the host provided too many SPI clock pulses for requested data). |

Table 8-109. Short Status Field Descriptions (continued)

| BIT FIELD | DEFINITION |
|-------------------|---|
| Command Error | A flag set to indicate a command error, or an error in the action requested by the command. Some examples are: <ul style="list-style-type: none"> • Command executed in an invalid operating mode • CRC Error in Command Header • CRC Error in Payload (Bulk Command) • Invalid command op-code • Invalid command parameter (for example, out of range) • Incorrect number of command parameters • Non-periodic BIST failure when BIST started by command • Error erasing, writing, or reading flash when commanded • Flash overflow error |
| Operational Error | A flag set to indicate an operational error, which are any errors that don't fall into one of the other three error categories. Some examples are: <ul style="list-style-type: none"> • Sequence CRC error • CMT CRC error • Sequence / CMT mismatch error • Periodic BIST failure • Unable to communicate with TPS99000-Q1 • Unable to communicate with temperature sensor |
| BIST Error | A flag set to indicate a non-periodic or periodic BIST error. |

8.2.81 Error History - Read (C1h)

This command is used to read the details of the first 62 errors that the system encounters. Subsequent errors beyond the first 62 will not be stored, but the error count will continue to increase to indicate that more errors occurred. Four bytes are allocated for each error. The *Clear Error History* command should be used periodically after reading the error history in order to clear errors and to avoid losing any future error debug information. The command will always return 249 bytes regardless of the number of errors currently contained in the error history.

Command Parameters

No command parameters.

Return Parameters

Table 8-110. Error History Return Parameters

| BYTE | BITS | DESCRIPTION |
|---------|------|---|
| 1 | 7:0 | Error Count Count of errors received since the last power-cycle or clear of the error history. If the error count is greater than 62, some error details are not available since storage is full. |
| 5:2 | 31:0 | Error 1 Details LSByte = 2 |
| 9:6 | 31:0 | Error 2 Details LSByte = 6 |
| ... | ... | Error n Details |
| 249:246 | 31:0 | Error 62 Details LSByte = 246 |

Each set of error bits includes a unique error code, category flags, and additional information bits that vary based on the type of error. The bit definition for each error is broken down as follows:

Table 8-111. Error Detail Bit Descriptions

| BITS | DESCRIPTION |
|-------|---|
| 31 | BIST Error 0x1: This error is categorized as a BIST error |
| 30 | Operational Error 0x1: Error is categorized as an operational error |
| 29 | Command Error 0x1: Error is categorized as a command error |
| 28 | Communication Error 0x1: Error is categorized as a communication error |
| 27 | Reserved Always 0 |
| 26:16 | Error code Unique error code to identify the error. |
| 15:0 | Informational bits These can vary depending on the category and specific type of error. |

A diagram of the error detail fields is shown in [Figure 8-2](#):

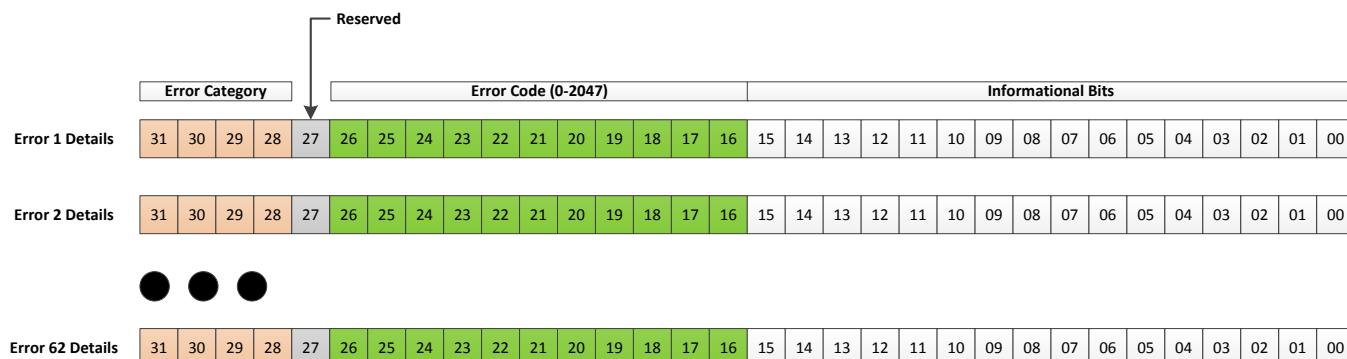


Figure 8-2. Error History Details

8.2.81.1 Information Bits - Command or Communication

If the Command Error or Communication Error bits are set in the error, then the information bits will provide the following information.

Table 8-112. Information Bit Definition Command or Communication

| BITS | DESCRIPTION |
|------|---|
| 15:8 | Command tag Tag of the command that received the error. |
| 7:0 | Command Op-Code Op-code of the command that received the error. |

8.2.81.2 Information Bits - System Voltage

If the error is a system voltage error, then the information bits will provide the value of the invalid voltage that was detected.

These errors include 843, 844, 845, 846, 847, 848, 849, 1008, 1015.

Table 8-113. Information Bit Definition System Voltage

| BITS | DESCRIPTION |
|------|---|
| 15:0 | Error voltage level Absolute value of the measured floating point value converted to u8.8 format. |

8.2.81.3 Information Bits - DMD High Speed Interface Training

If the error is related to DMD high speed interface training, then the information bits will provide the channel and pin that received the error.

These errors include 555, 556, 559.

Table 8-114. Information Bit Definition DMD HS Interface Training

| BITS | DESCRIPTION |
|------|--|
| 15:8 | Training Channel From the DLPC230-Q1 hardware perspective. Due to channel swapping options, Channel 0 on the DLPC230-Q1 can sometimes connect to Channel 1 on the DMD. 0x0: Channel 0 0x1: Channel 1 0x2: Both channels |
| 7:0 | Signal number From the DLPC230-Q1 hardware perspective. Due to pin swapping options, a pin on the DLPC230-Q1 may be connected to a different pin on the DMD. 0-7 corresponding to the 8 differential signals on each channel. |

8.2.81.4 Information Bits - DMD Memory Test

Error 220 includes the number of CMOS columns that failed the DMD memory test. Refer to [Section 6.4.2.6](#) for more information on the DMD memory test.

| BITS | DESCRIPTION |
|------|---------------------------------|
| 15:0 | Number of failed columns |

8.2.82 Clear Short Status Errors - Write (C2h)

This command is used to clear the Short Status error bits. This includes bytes 3 and 4 of the Short Status.

Write Parameters

Table 8-115. Clear Short Status Errors Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---------------------------------|
| 1 | 7:0 | Signature Byte 1 0xAA |
| 2 | 7:0 | Signature Byte 2 0xBB |
| 3 | 7:0 | Signature Byte 3 0xCC |
| 4 | 7:0 | Signature Byte 4 0xDD |

8.2.83 Clear Error History - Write (C3h)

This command is used to clear the Error History, the Error Count, and the Short Status error bits.

Write Parameters

Table 8-116. Clear Error History Write Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|---------------------------------|
| 1 | 7:0 | Signature Byte 1 0xAA |
| 2 | 7:0 | Signature Byte 2 0xBB |
| 3 | 7:0 | Signature Byte 3 0xCC |
| 4 | 7:0 | Signature Byte 4 0xDD |

Commands - Diagnostic Interface

9.1 Diagnostic Command Read Procedure

The diagnostic interface is hardware controlled, meaning that there is no delay time to fetch requested data. The read pre-fetch and read-activate command flow is still used, but there is no short status to determine when read data is available. Read activate can occur immediately following read pre-fetch.

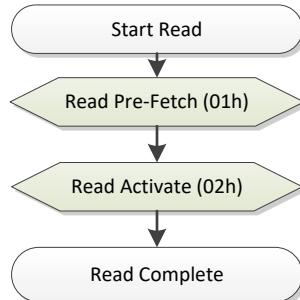


Figure 9-1. Read Procedure for Diagnostic Interface

9.2 Command Table

[Table 9-1](#) summarizes the diagnostic interface commands.

Table 9-1. Command Summary - Diagnostic Interface

| COMMAND | TYPE | OP CODE | SECTION |
|-----------------------------------|-------|---------|-------------------------------|
| Read Pre-fetch | Write | 01h | Section 9.3.1 |
| Read Activate | Read | 02h | Section 9.3.2 |
| Diagnostic Interface Status | Read | F0h | Section 9.3.3 |
| Diagnostic Interface Status Clear | Write | F1h | Section 9.3.4 |

9.3 Command Definitions

9.3.1 Read Pre-Fetch - Write (01h)

This command is used to send the desired read command op-code and associated command parameters to initiate a read request. The desired read data will not be returned during this command transaction. More information on the read procedure can be found in [Section 3.5](#).

Write Parameters

Table 9-2. Read Pre-Fetch Write Parameters

| BYTE | BITS | DESCRIPTION |
|---------|------|---|
| 1 | 7:0 | Read command op-code |
| 2 ... n | | Read command parameters Depending on the Read op-code, a specific number of command parameter bytes will be expected. The required byte parameters are documented with each read command. |

9.3.2 Read Activate (02h)

This command is used to activate the read operation in order to retrieve the previously requested read data. This generic command is used to retrieve all requested read data with the exception of the *Short Status* command. More information on the read procedure can be found in [Section 3.5](#).

Command Parameters

No command parameters.

Return Parameters

Table 9-3. Read Activate Return Parameters

| BYTE | BITS | DESCRIPTION |
|---------|------|--|
| 1 ... n | | Data Bytes 1...n Read data bytes. The number of bytes will vary depending on the command that is currently being read. |

9.3.3 Diagnostic Interface Status - Read (F0h)

This command is used to read status information from the diagnostic interface.

Command Parameters

Table 9-4. Diagnostic Interface Status Command Parameters

| BYTE | BITS | DESCRIPTION |
|------|------|--|
| 2:1 | 15:0 | Start Index 0-based index of the first desired byte value to be returned. 0 - 63 LSByte = Byte 1 |
| 4:3 | 15:0 | Number of Bytes 1-based number of data bytes to be returned. 1 - 64 Start Index + Number of Bytes must be less than or equal to 64. LSByte = Byte 3 |

Return Parameters

Table 9-5. Diagnostic Interface Status Return Parameters

| BYTE | BITS | DESCRIPTION |
|---------|------|---|
| 1 ... n | | Data Bytes Data values to return. The number of bytes is determined by the "Number of Bytes" field specified in the command parameters. |

9.3.4 Diagnostic Interface Status Clear - Write (F1h)

This command is used to clear the diagnostic interface status data. There is a mask bit for each byte to indicate which bytes will be cleared by the command.

Write Parameters

Table 9-6 indicates the byte index for each write bit. *Table 9-7* describes the value options for each bit.

Table 9-6. Diagnostic Interface Status Clear Write Parameters

| BYTE | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|------|-------|-------|-------|-------|-------|-------|-------|-------|
| 1 | 07 | 06 | 05 | 04 | 03 | 02 | 01 | 00 |
| 2 | 15 | 14 | 13 | 12 | 11 | 10 | 09 | 08 |
| 3 | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 |
| 4 | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 |
| 5 | 39 | 38 | 37 | 36 | 35 | 34 | 33 | 32 |
| 6 | 47 | 46 | 45 | 44 | 43 | 42 | 41 | 40 |
| 7 | 55 | 54 | 53 | 52 | 51 | 50 | 49 | 48 |
| 8 | 63 | 62 | 61 | 60 | 59 | 58 | 57 | 56 |

Table 9-7. Diagnostic Interface Clear Values

| DIAGNOSTIC CLEAR VALUES | DESCRIPTION |
|-------------------------|--|
| 0x0 | Not selected - The byte will not be cleared. |
| 0x1 | Selected - The byte will be cleared. |

Flash Configuration

10.1 Overview

Flash memory is used to store the main application and operational data that is used by the main application. The flash data blocks consist of:

- **Main Application** - The embedded software binary that is executed by the DLPC230-Q1 ARM processor.
- **Configuration Data** - Data read by the main application and boot application to configure system functionality.
- **Sequence Data** - Includes sequencing information that dictates how the DMD and illumination are driven during a frame.
- **Batch Command Sets** - Contains all of the available batch command sets. More detail about batch command sets can be found in [Section 5.2](#).
- **Splash Image Data** - Stores all of the available splash image binaries. More detail about splash images can be found in [Section 5.1.4](#).
- **Scratchpad Data** - Stores any miscellaneous data that the end-user requires. Embedded software does not use this data for any reason. It can be read back during system operation using *Flash Read* commands.

10.2 System Mode Overview

The following terms are commonly used when referring to illumination and display settings:

- **System Mode** - A flash structure that maps several types of look-up tables that are intended to be used together in order to achieve a desired image appearance. The tables within a System Mode are all designed for a specific:
 - Frame Rate - The sequences are designed to match a specific input video frame rate
 - RGB Duty Cycle - Percentage of sequence time allocated for red, green, and blue illumination
- **Sequence** - A table that controls the synchronization of DMD timing and illumination enable signals throughout a video frame time. Every sequence within a System Mode is designed for the same frame rate and RGB duty cycle. Each sequence is characterized by a specific DMD duty cycle. For example, one sequence may use a 70% (70/30) DMD duty cycle and another may use 50%, 50% (50/50) DMD duty cycle. This percentage is related to the maximum light output that the system can output.
- **Illumination Bin** - A table that controls the amount of time that illumination drive signals are active for a given sequence. This is used to provide coarse step control over the amount of light output in dimming use-cases. For applications that do not use dimming, illumination bins are designed to provide maximum sequence intensity.
- **De-gamma Table** - A de-gamma curve that controls the mapping of input pixel levels to output pixel brightness levels. These are generally used to compensate for gamma curves that are inherent to video content or to accentuate specific regions of pixel levels. The same de-gamma curves are used for each sequence so that every system brightness can use the same de-gamma curves.

The available sequences, illumination bins, and de-gamma tables are specified in the flash header file provided along with the flash binary file.

The host specifies a System Mode index, an Illumination Bin index, and a De-gamma index. The host never directly specifies a sequence index. This is explained by the example below.

uses an example indexing to show the relationship between these tables. A System Mode contains a set of Illumination Bins. The host specifies the system brightness by selecting the desired illumination bin index within a System Mode. Each Illumination Bin is designed for a specific sequence. When the host selects an illumination bin, the main application will automatically select the one sequence that the illumination bin is mapped to. The host never directly sets the sequence. Different Illumination Bins can be mapped to the same sequence. This indicates the use of different illumination percentages with the same DMD duty cycle to achieve a different total brightness level. Each sequence maps to one or more de-gamma curves. The same set of de-gamma curves is applied to all sequences. For example, de-gamma curve 0 could be a simple linear mapping from input pixel to output pixel level (128 in = 128 out). In that example, de-gamma 0 will be linear for all sequences.

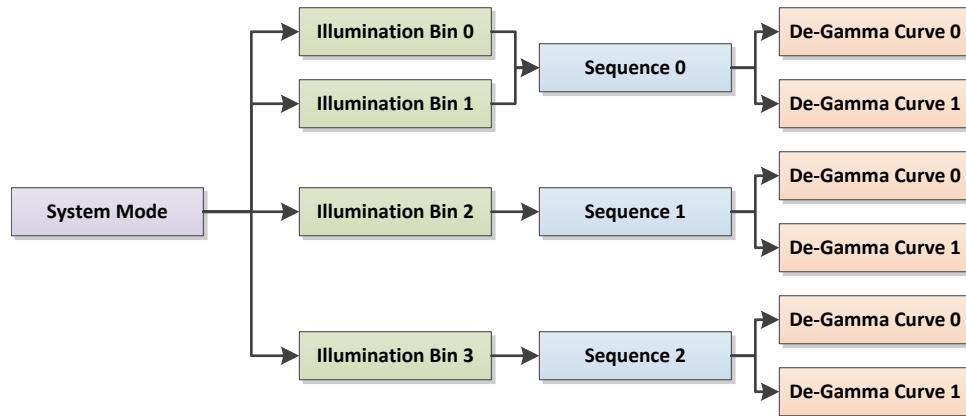


Figure 10-1. System Mode Example

10.3 Scratchpad Data

There are four flash scratchpad blocks that may be used to store any desired data. The data within these blocks are not used for DLPC230-Q1 software configuration in any way. The data structure for each of these individual blocks is shown in [Table 10-1](#).

Multi-byte values use little endian format (LSB first).

The size of each block is one flash sector (4096 bytes) and the block data must fill the flash sector. Padding bytes should be 0xFF.

Table 10-1. Scratchpad Data

| BYTE ADDRESS (HEX) | 0 | 1 | 2 | 3 |
|--------------------|---------------------|---------------------|----------------------------|----------------------------|
| 0000 | 'O' _c | 'E' _c | 'M' _c | Block Number _{U8} |
| 0004 | | | CRC _{U32} | |
| 0008 | | | SIZE _{U32} = 4084 | |
| 000C | Major _{U8} | Minor _{U8} | | Patch _{U16} |
| 0010 | | | Custom Data | |
| ... | | | | |
| 0FFC | | | | |

10.3.1 CRC

The 32-bit CRC is implemented as follows:

- Polynomial $x^{32} + x^{26} + x^{23} + x^{22} + x^{16} + x^{12} + x^{11} + x^{10} + x^8 + x^7 + x^5 + x^4 + x^2 + x + 1$ (normal polynomial representation = 0x04C11DB7)
- Initial value is 0xFFFFFFFF

The bytes within each word (4 bytes) of data must be reversed prior to the CRC calculation. For example, using the data word 0xAABBCCDD, the value to be used in the CRC is 0xDDCCBAA.

The CRC must include all words in the scratchpad block starting after the "Size" field and including all padding bytes up to the flash sector size.

10.3.2 Block Number

The block number distinguishes between the four scratchpad blocks for partial flash programming and partial flash reading. Valid values are 0, 1, 2, 3.

10.3.3 Version (Major, Minor, Patch)

The version fields must match the expected flash structure version. This value may change with new software releases, but can be read back using the [Flash Structure Version - Read](#) command.

10.3.4 Custom Data

This field may include any desired content. It will not be used by DLPC230-Q1 software.

Error Codes

A.1 Boot Application

The following table describes the error codes that may be received during boot application execution.

Table A-1. Boot Application Error Codes

| CODE | NAME | DESCRIPTION |
|---------|----------------------------------|--|
| 03 | Flash Out Of Range | Set during Flash Write command if the flash image is larger than 128 Mb. |
| 04 | Flash Read Timeout | Set during startup if the flash device ID cannot be read. |
| 05 | Flash Busy | Set during any flash read, erase, or write operation if another operation is already accessing flash memory. |
| 06 - 09 | Internal Error | Internal system error. Contact TI for more information. |
| 10 | Invalid Command Type | Set if the next byte from the command interface is not the correct type. An example of this is if a data byte is read when an op-code byte is expected. This can occur if the host sends too many or too few bytes for a particular command. |
| 11 | Invalid Command Format | Set if the op-code sent using a Read Pre-fetch command is actually a "write" op-code, or the Read Pre-fetch command did not contain an op-code parameter. It can also be set during a Flash Write if the data payload length was not provided. |
| 13 | Invalid Flash Write Sequence | Set during the flash write command if the flash has not been erased. |
| 14 | Internal Error | Internal system error. Contact TI for more information. |
| 15 | Invalid Command Op-Code | The requested command op-code does not exist. |
| 16 | Invalid Command Signature | Set if the signature bytes are invalid for the following commands: System Reset, Flash Erase, Clear Error History, or Clear Short Status. |
| 17 | Internal Error | Internal system error. Contact TI for more information. |
| 18 | Mismatch Command CRC / Checksum | A CRC or checksum in the command is invalid. |
| 19 | Mismatch Command Payload Size | The command payload size didn't match the number of bytes transmitted. |
| 20 | Internal Error | Internal system error. Contact TI for more information. |
| 22 | Software FIFO Full | The software command FIFO is full and cannot accept more commands. This error can be prevented by waiting for the <i>System Busy</i> Short Status bit to be set low between command transactions so that the FIFO does not overrun. |
| 24 | Flash Application Block ID Error | Set during startup if the flash image detects an error in the application binary data. |
| 25 | Internal Error | Internal system error. Contact TI for more information. |
| 26 | Flash Invalid Device | Set if the flash device is not found during startup, an unknown flash device is found during startup, a flash device is not found and a Flash Erase is requested, or a flash device is not found and a Flash Write command is requested. |
| 28 - 29 | Internal Error | Internal system error. Contact TI for more information. |
| 30 | Flash Table CRC Error | A CRC error was detected while verifying the Flash table. |
| 31 - 33 | Internal Error | Internal system error. Contact TI for more information. |
| 34 | Flash Table ID Error | Flash table signature is not located at the correct address. If the first 4 bytes of flash are erased or corrupt, this error will occur when a flash verify or transition to main application are attempted. |
| 35 - 58 | Internal Error | Internal system error. Contact TI for more information. |
| 70 | Incorrect Command Header Format | The host command header format is invalid. |

Table A-1. Boot Application Error Codes (continued)

| CODE | NAME | DESCRIPTION |
|-----------|--|---|
| 71 | Read Activate Invalid CRC / Checksum | The host command had an invalid CRC or checksum during a Read Activate command. |
| 72 | Read Activate Header Early Termination | The host terminated a Read Activate transaction before the entire header data was sent. |
| 73 | Read Activate Response Early Termination | The host terminated a Read Activate transaction before the entire read payload was sent. |
| 74 | Read Activate Late Termination | The host terminated a Read Activate transaction later than expected based on the read payload length. |
| 75 | Read Activate Data Unavailable | Set if there is no read data available when the host sends a Read Activate command. |
| 76 | Host RX FIFO Overflow | A received host command caused the read FIFO to overflow, resulting in the loss of data from the previous read command. |
| 77 | Internal Error | Internal system error. Contact TI for more information. |
| 78 | Short Status Invalid CRC / Checksum | The host command had an invalid CRC or checksum during a Short Status command. |
| 79 | Short Status Header Early Termination | The host terminated a short status transaction before the entire short status header was sent. |
| 80 | Short Status Response Early Termination | The host terminated a short status transaction before the entire short status response was sent. |
| 81 | Short Status Late Termination | The host terminated a short status transaction later than expected. |
| 82 | Host TX FIFO Overflow | Software attempted to write to a full host interface FIFO. |
| 85 - 121 | Internal Error | Internal system error. Contact TI for more information. |
| 123 | Flash FIFO Timeout | Set during Flash Write command if software times out waiting for the serial flash controller. Also possibly set during startup if the serial flash controller times out while retrieving the flash device ID. |
| 124 - 128 | Internal Error | Internal system error. Contact TI for more information. |
| 129 | Invalid Read Prefetch Op Code | An invalid read op-code was sent using a Read Pre-Fetch command. |
| 130 | Internal Error | Internal system error. Contact TI for more information. |
| 131 | Boot Application Load CRC Error | A CRC error was detected while transferring the boot application to RAM. |
| 132 | Main Application Load CRC Error | A CRC error was detected while transferring the main application to RAM. |
| 133 | Main Application CRC Error in RAM | A CRC error was detected after transferring the main application to RAM. |
| 134 | Flash Block Verify CRC Error | A CRC error was detected while verifying the contents of the flash. |
| 136 | Internal Error | Internal system error. Contact TI for more information. |
| 137 | Internal Error | Internal system error. Contact TI for more information. |

A.2 Main Application

The following table describes the error codes that may be received during main application execution. This preliminary list does not define every error code and will be updated during main application development.

Table A-2. Main Application Error Codes

| CODE | NAME | DESCRIPTION |
|----------|--|--|
| 03 | Flash Out Of Range | Set during Flash Write command if the flash image is larger than 128Mb. |
| 04 | Flash Read Timeout | Set during startup if the flash device ID cannot be read. |
| 05 | Flash Busy | Set during any flash read, erase, or write operation if another operation is already accessing flash memory. |
| 06 - 09 | Internal Error | Internal system error. Contact TI for more information. |
| 10 | Invalid Command Type | Set if the next byte from the command interface is not the correct type. For example, if a data byte is read when an op-code byte is expected. This can occur if the host sends too many or too few bytes for a particular command. |
| 13 | Invalid Flash Write Sequence | Set during the flash write command if the flash has not been erased. |
| 15 | Invalid Command Op-Code | The requested command op-code does not exist. |
| 16 | Invalid Command Signature | Set if the signature bytes are invalid for the following commands: System Reset, Flash Erase, Clear Error History, or Clear Short Status. |
| 17 | Internal Error | Internal system error. Contact TI for more information. |
| 18 | Mismatch Command CRC / Checksum | A CRC or checksum in the command is invalid. |
| 19 | Mismatch Command Payload Size | The command payload size didn't match the number of bytes transmitted. |
| 20 | Internal Error | Internal system error. Contact TI for more information. |
| 22 | Software FIFO Full | The software command FIFO is full and cannot accept more commands. This error can be prevented by waiting for the <i>System Busy</i> Short Status bit to be set low between command transactions so that the FIFO does not overrun. |
| 26 | Flash Invalid Device | Set if the flash device is not found during startup, an unknown flash device is found during startup, a flash device is not found and a Flash Erase is requested, or a flash device is not found and a Flash Write command is requested. |
| 33 - 46 | Internal Error | Internal system error. Contact TI for more information. |
| 70 | Incorrect Command Header Format | The host command header format is invalid. |
| 71 | Read Activate Invalid CRC / Checksum | The host command had an invalid CRC or checksum during a Read Activate command. |
| 72 | Read Activate Header Early Termination | The host terminated a Read Activate transaction before the entire header data was sent. |
| 73 | Read Activate Response Early Termination | The host terminated a Read Activate transaction before the entire read payload was sent. |
| 74 | Read Activate Late Termination | The host terminated a Read Activate transaction later than expected based on the read payload length. |
| 75 | Read Activate Data Unavailable | Set if there is no read data available when the host sends a Read Activate command. |
| 76 | Host RX FIFO Overflow | A received host command caused the read FIFO to overflow, resulting in the loss of data from the previous read command. |
| 77 | Internal Error | Internal system error. Contact TI for more information. |
| 78 | Short Status Invalid CRC / Checksum | The host command had an invalid CRC or checksum during a Short Status command. |
| 79 | Short Status Header Early Termination | The host terminated a short status transaction before the entire short status header was sent. |
| 80 | Short Status Response Early Termination | The host terminated a short status transaction before the entire short status response was sent. |
| 81 | Short Status Late Termination | The host terminated a short status transaction later than expected. |
| 82 | Host TX FIFO Overflow | Software attempted to write to a full host interface FIFO. |
| 94 - 121 | Internal Error | Internal system error. Contact TI for more information. |

Table A-2. Main Application Error Codes (continued)

| CODE | NAME | DESCRIPTION |
|-----------|-------------------------------|---|
| 123 | Flash FIFO Timeout | Set during Flash Write command if software times out waiting for the serial flash controller. Also possibly set during startup if the serial flash controller times out while retrieving the flash device ID. |
| 125 - 128 | Internal Error | Internal system error. Contact TI for more information. |
| 129 | Invalid Read Prefetch Op Code | An invalid read op-code was sent using a Read Pre-Fetch command. |
| 139 | Command Error | Bezel horizontal offset exceeds -10% limit. |
| 140 | Command Error | Bezel horizontal offset exceeds +10% limit. |
| 141 | Command Error | Bezel vertical offset exceeds -50% limit. |
| 142 | Command Error | Bezel vertical offset exceeds +50% limit. |
| 143 - 147 | Internal Error | Internal system error. Contact TI for more information. |
| 148 | Command Error | Bezel horizontal offset is not a multiple of 2. |
| 149 | Command Error | Image orientation (flip) is invalid. |
| 150 - 153 | Internal Error | Internal system error. Contact TI for more information. |
| 157 - 161 | Internal Error | Internal system error. Contact TI for more information. |
| 162 | Command Error | Bezel vertical offset is not a multiple of 4. |
| 163 | Command Error | Execution delay error. |
| 164 | Command Error | GPIO invalid owner. |
| 165 | Command Error | GPIO wrong direction. |
| 166 | Command Error | Illumination Bin not found. |
| 167 | Command Error | System Mode not found. |
| 168 | Command Error | Contrast Parameter error. |
| 169 | Internal Error | Internal system error. Contact TI for more information. |
| 170 | Command Error | Flash invalid block type. |
| 171 | Command Error | Flash invalid block size. |
| 172 | Command Error | Flash invalid block version. |
| 173 | Command Error | Flash invalid data type. |
| 174 | Command Error | Invalid batch command. |
| 175 | Command Error | Batch command set invalid index. |
| 176 | Command Error | Flash invalid command sequence. |
| 177 | Command Error | Invalid payload length. |
| 179 | Command Error | ADC Measurement start or length parameter out of range. |
| 180 | Command Error | Command is not allowed in current operating mode. |
| 181 | Command Error | Temperature compensation source selection invalid. |
| 182 | Command Error | Reset is required after flash update. |
| 183 | Command Error | PWM duty cycle command parameter is greater than maximum allowed. |
| 184 | Command Error | De-gamma selection cannot be changed while illumination transition is in progress. |
| 185 - 200 | Internal Error | Internal system error. Contact TI for more information. |
| 201 | Command Error | Invalid source type selected. |
| 202 - 205 | Internal Error | Internal system error. Contact TI for more information. |
| 206 | Command Error | No splash screen at requested index. |
| 207 - 213 | Internal Error | Internal system error. Contact TI for more information. |
| 214 | Command Error | ASIC Device ID not yet available. |
| 215 | Command Error | System must stay in Standby mode until reset has occurred. |
| 216 | Command Error | ASIC Device ID invalid selection. |
| 217 | Command Error | Operating Mode Select invalid mode. |
| 218 | Command Error | Temperature compensation parameter invalid. |
| 219 | Internal Error | Internal system error. Contact TI for more information. |

Table A-2. Main Application Error Codes (continued)

| CODE | NAME | DESCRIPTION |
|---------|----------------|--|
| 220 | Command Error | DMD Memory BIST columns failed. |
| 221 | Command Error | DMD Memory BIST failed. |
| 222 | BIST Error | Loss of dimming / ping BIST failed. No dimming / ping command was received within the configured time frame. |
| 223 | Command Error | Start index for diagnostic memory is out of range. |
| 224 | Command Error | Number of bytes for diagnostic memory is out of range. |
| 229 | Command Error | External video checksum start column invalid. |
| 230 | Command Error | External video checksum number of pixels per line invalid. |
| 231 | Command Error | External video checksum start row invalid. |
| 232 | Command Error | External video checksum number of lines per frame invalid. |
| 233 | Command Error | No settings provided for external video checksum. Write External Video Checksum Settings command prior to enabling the test. |
| 234 | Internal Error | Internal system error. Contact TI for more information. |
| 237 | Internal Error | Internal system error. Contact TI for more information. |
| 238 | Command Error | Attempted to change external video checksum settings, but external video checksum is enabled. |
| 239 | Command Error | Average Picture Level command parameter is out of range. |
| 240 | Command Error | Command not available for this product type. |
| 241 | Command Error | TPS99000-Q1 RGB Limits parameter is out of range. |
| 242 | Command Error | TPS99000-Q1 TIA2 parameter error. |
| 244 | Command Error | Commanded periodic BIST is disabled by flash setting and cannot be enabled by host command. |
| 245 | Command Error | CMODE value out of range. |
| 512 | BIST Error | Back End BIST 1 failed. |
| 513-516 | Internal Error | Internal system error. Contact TI for more information. |
| 517 | BIST Error | Diagnostics emergency shutdown. |
| 518 | Internal Error | Internal system error. Contact TI for more information. |
| 519 | BIST Error | Memory BIST 17 failed. |
| 520 | BIST Error | Memory BIST 18 failed. |
| 521 | BIST Error | Memory BIST 19 failed. |
| 522 | BIST Error | Memory BIST 20 failed. |
| 523 | BIST Error | Memory BIST 21 failed. |
| 524 | BIST Error | Front End BIST 1 failed. |
| 525 | BIST Error | Internal system error. Contact TI for more information. |
| 526 | BIST Error | Flash Table Transport CRC failed. |
| 527 | BIST Error | Internal system error. Contact TI for more information. |
| 528 | BIST Error | External video checksum control invalid. |
| 529 | BIST Error | Non-Periodic test invalid. |
| 530 | BIST Error | Memory BIST 1 failed. |
| 531 | BIST Error | Memory BIST 2 failed. |
| 532 | BIST Error | TPS99000-Q1 signal interface BIST failed. |
| 533 | BIST Error | Memory BIST 22 failed. |
| 534 | BIST Error | DLPC230-Q1 Command and Flash Interface Memory test failed. |
| 535 | BIST Error | External Video Checksum failed due to checksum mismatch. |
| 536 | BIST Error | Memory BIST 23 failed. |
| 537 | BIST Error | Memory BIST 24 failed. |
| 538 | BIST Error | Memory BIST 26 failed. |
| 539 | BIST Error | Memory BIST 25 failed. |
| 540 | BIST Error | Memory BIST 3 failed. |

Table A-2. Main Application Error Codes (continued)

| CODE | NAME | DESCRIPTION |
|-----------|-----------------------------|---|
| 541 | BIST Error | Memory BIST 12 failed. |
| 542 | BIST Error | Memory BIST 13 failed. |
| 543 | BIST Error | Memory BIST 14 failed. |
| 544 | BIST Error | Memory BIST 15 failed. |
| 545 | BIST Error | Memory BIST 16 failed. |
| 546 | BIST Error | Memory BIST 4 failed. |
| 547 | BIST Error | Memory BIST 5 failed. |
| 548 | BIST Error | Memory BIST 6 failed. |
| 549 | BIST Error | Memory BIST 7 failed. |
| 550 | BIST Error | Memory BIST 8 failed. |
| 551 | BIST Error | Memory BIST 9 failed. |
| 552 | BIST Error | Memory BIST 10 failed. |
| 553 | BIST Error | Memory BIST 11 failed. |
| 554 - 555 | Internal Error | Internal system error. Contact TI for more information. |
| 556 | DMD Training Error | DMD HS training failed: returned invalid results. |
| 557 | Internal Error | Internal system error. Contact TI for more information. |
| 558 | BIST Error | External video frame count out of sequence. |
| 559 | DMD Training Error | DMD HS Training failed: Insufficient DLL window. |
| 560 - 563 | Internal Error | Internal system error. Contact TI for more information. |
| 564 | DMD Compatibility Error | TPS99000-Q1 pixel type configuration is not compatible with the DMD used in the system. |
| 565 | DMD LS Error | Unexpected data was received during a transaction on the DMD low speed interface. |
| 566 | Flash Configuration Error | Invalid external video checksum fail action. |
| 567 - 572 | Internal Error | Internal system error. Contact TI for more information. |
| 573 | DMD Training Error | DMD HS training failed: real-time test controller HS training error 1. |
| 574 | DMD Training Error | DMD HS training failed: real-time test controller HS training error 2. |
| 575 | DMD Training Error | DMD HS training failed: real-time test controller HS training error 3. |
| 576 | DMD Training Error | DMD HS training failed: real-time test controller HS training processing error. |
| 577 | DMD LS Error | DMD Low Speed validation failed: processing error. |
| 578 - 586 | Internal Error | Internal system error. Contact TI for more information. |
| 587 | Flash Error | Serial flash device is locked. |
| 588 | System Mode Error | The currently selected system mode is not compatible with the source frame rate. |
| 589 | De-gamma Error | The requested de-gamma table was not found in the flash data. |
| 590 | Internal Error | Internal system error. Contact TI for more information. |
| 591 | ADC Error | An attempt to manually read an ADC channel measurement requested an invalid channel (-1). |
| 592 - 595 | Internal Error | Internal system error. Contact TI for more information. |
| 596 | ADC Error | ADC measurement error: retry count exceeded. |
| 597 | ADC Error | ADC interface communication error. Data, parity, or stop-bit error occurred during transaction. |
| 598 - 600 | Internal Error | Internal system error. Contact TI for more information. |
| 601 | ADC Error | Attempted to manually read ADC measurement, but channel selection was invalid (>=64). |
| 602 | ADC Error | ADC measurement error: value saturated at minimum or maximum. |
| 603 - 625 | Internal Error | Internal system error. Contact TI for more information. |
| 626 | TPS99000-Q1 Interface Error | TPS99000-Q1 parity error during read. |

Table A-2. Main Application Error Codes (continued)

| CODE | NAME | DESCRIPTION |
|-----------|-----------------------------|--|
| 627 | TPS99000-Q1 Interface Error | TPS99000-Q1 parity error during write. |
| 628 - 632 | Internal Error | Internal system error. Contact TI for more information. |
| 634 | Thread Monitor Error | Thread is non-responsive within timeout. |
| 636 | DMD Access Error | DMD low speed interface communication failed. The ASIC did not receive an ACK from the DMD. This can occur if there is a DMD connection issue, or if the flash low speed port configuration does not match hardware connections. |
| 637 - 652 | Internal Error | Internal system error. Contact TI for more information. |
| 653 | Flash Table Error | Flash Table Type 1 CRC failed. |
| 654 | Flash Table Error | Flash Table Type 2 CRC failed. |
| 655 | Flash Table Error | Flash Table Type 3 transport CRC failed. |
| 656 | Flash Table Error | Flash Table Type 3 CRC failed. |
| 657 | Flash Table Error | Flash Table Type 4 CRC failed. |
| 658 | Flash Table Error | Flash Table Type 5 memory access failed. |
| 659 | Flash Table Error | Flash Table Type 5 CRC failed. |
| 660 | Flash Table Error | Flash Table Type 6 memory CRC failed. |
| 661 | Flash Table Error | Flash Table Type 7 memory CRC failed. |
| 662 | Internal Error | Internal error. Contact TI for more information. |
| 663 | Flash Table Error | Flash Table Type 8 memory CRC failed. |
| 664 | Flash Table Error | Flash Table Type 9 memory access failed. |
| 665 | Source Error | External source measured active lines per frame does not match source definition. |
| 666 | Source Error | External source measured active pixels per line does not match source definition. |
| 667 - 668 | Internal Error | Internal system error. Contact TI for more information. |
| 669 | Source Error | External source Open LDI DLL could not lock to pixel clock. |
| 670 | Internal Error | Internal system error. Contact TI for more information. |
| 671 | Source Error | External source Open LDI port pixel clock frequency is not within the allowable range. |
| 672 | Source Error | External source Open LDI total pixels per line are unstable. |
| 673 | Internal Error | Internal system error. Contact TI for more information. |
| 674 | Source Error | External source parallel port pixel clock frequency is not within the allowable range. |
| 675 | Source Error | External source parallel port total pixels per line are unstable. |
| 676 | Source Error | External source pixel clock above the allowable range. |
| 677 | Source Error | External source pixel clock below the allowable range. |
| 678 | Source Error | External source VSYNC frequency greater than defined maximum. |
| 679 | Source Error | External source VSYNC frequency less than defined minimum. |
| 680 - 687 | Internal Error | Internal system error. Contact TI for more information. |
| 688 | Source Error | Source selected is invalid (not external source, test pattern, or splash screen). |
| 689 - 712 | Internal Error | Internal system error. Contact TI for more information. |
| 713 | Clock Configuration Error | Attempted to enable spread spectrum on the DMD interface, but the spread spectrum enable signal is configured to keep it disabled. |
| 714 - 733 | Internal Error | Internal system error. Contact TI for more information. |
| 734 | Clock Configuration Error | Attempted to enable spread spectrum on the master clock generator, but the spread spectrum enable signal is configured to keep it disabled. |
| 735 - 742 | Internal Error | Internal system error. Contact TI for more information. |
| 743 | Flash Configuration Error | Flash structure version does not match the structure version required by the main application. |
| 744 | Flash Configuration Error | Flash block type is not supported. |

Table A-2. Main Application Error Codes (continued)

| CODE | NAME | DESCRIPTION |
|-----------|-----------------------------|---|
| 745 | Flash Configuration Error | Flash table address is outside of valid range. |
| 746 | Flash Configuration Error | Flash block does not exist. |
| 747 - 758 | Internal Error | Internal system error. Contact TI for more information. |
| 760 | BIST Error | Video frame counter failed to lock due to value out of range. |
| 761 | Internal Error | Internal system error. Contact TI for more information. |
| 762 | Flash Error | Flash data verification CRC failed. |
| 763 - 777 | Internal Error | Internal system error. Contact TI for more information. |
| 778 | GPIO Error | Invalid pin access. |
| 779 | GPIO Error | Invalid pin direction. |
| 780 | GPIO Error | Invalid polarity type. |
| 781 - 836 | Internal Error | Internal system error. Contact TI for more information. |
| 843 | System Voltage Error | System 1.1V rail out of range. |
| 844 | System Voltage Error | System 1.8V rail out of range. |
| 845 | System Voltage Error | System 3.3V rail out of range. |
| 846 | System Voltage Error | ADC external VREF voltage out of range. |
| 847 | System Voltage Error | DVDD voltage out of range. |
| 848 | System Voltage Error | LDOT_M8 voltage out of range. |
| 849 | System Voltage Error | VMAIN voltage out of range. |
| 850 - 868 | Internal Error | Internal system error. Contact TI for more information. |
| 869 | Temperature Error | The temperature sensor remote channel is open. This is determined by a bit read from the temperature sensor status. This could be caused by a faulty connection between the DMD temperature sensing diode and the temperature sensor. |
| 870-871 | Internal Error | Internal system error. Contact TI for more information. |
| 872 | Temperature Error | Temperature sensor not present. |
| 873 - 874 | Internal Error | Internal system error. Contact TI for more information. |
| 875 | Temperature Error | Errors occurred during temperature read. |
| 876 | Temperature Error | Unknown temperature sensor device. |
| 877 - 881 | Internal Error | Internal system error. Contact TI for more information. |
| 887 | ADC Error | TPS99000-Q1 ADC interface measurement read error: A TPS99000-Q1 Data Reception error, or an ADC command control timeline violation error, or a TPS99000-Q1 input all HIGH, or TPS99000-Q1 disabled error detected. |
| 888 | DMD Interface Error | Attempt to park the DMD failed. |
| 889 | DMD Interface Error | Attempt to unpark the DMD failed. |
| 890 | BIST Error | TPS99000-Q1 thermal conditions on chip have reached the warning level. If temperature continues to rise, system will reach die over-temp error temperature and emergency actions will be taken by TPS99000-Q1. |
| 891 | TPS99000-Q1 Interface Error | TPS99000-Q1 parity error on a main SPI port transaction occurred (command or write data) on previous command. |
| 892 | TPS99000-Q1 Error | TPS99000-Q1 top level state machine has changed states unexpectedly. Can be used to indicate to processor that TPS99000-Q1 has exited DISPLAY state due to a fault. |
| 893 | ADC Error | TPS99000-Q1 ADC error bit was set. This can occur due to ADC measurement saturation, measurement underflow, or parity errors on the ADC interface. |
| 894 | DMD Device ID Error | DMD device ID does not match flash project setting. |
| 895 | Temperature Error | Temperature is lower than the minimum DMD park temperature. |
| 896 | Temperature Error | Temperature is higher than the maximum DMD park temperature. |
| 897 | Internal Error | Internal system error. Contact TI for more information. |
| 898 | BIST Error | DMD clock out of range. |

Table A-2. Main Application Error Codes (continued)

| CODE | NAME | DESCRIPTION |
|-----------|---------------------------|--|
| 899 | Internal Error | Internal system error. Contact TI for more information. |
| 900 | Temperature Error | DMD is parked and temperature function indicates that DMD is not allowed to unpark. |
| 901 | Flash Configuration Error | TPS99000-Q1 product ID does not match value in flash. Note that the product ID is different than the TPS99000-Q1 version number. |
| 908 - 910 | Internal Error | Internal system error. Contact TI for more information. |
| 911 | Flash Read Error | Attempted to read flash data, but the flash block has been erased. |
| 912 | Internal Error | Internal system error. Contact TI for more information. |
| 913 | Source Error | External source has been lost. This may occur as a result of source-lost monitoring, or may be triggered due to other external source test failures such as video checksums. |
| 914 | Source Error | External source has been lost and attempt to transition to alternate source failed. |
| 915 | BIST Error | Average Picture Level exceeded its specified limit. |
| 916 | Internal Error | Internal system error. Contact TI for more information. |
| 917 | BIST Error | Excessive brightness detector indicates an over-bright fault condition. |
| 918-919 | Internal Error | Internal system error. Contact TI for more information. |
| 920 | Command Error | TPS99000-Q1 illumination sync control setting is out of range. |
| 934 | Command Error | TPS99000-Q1 drive mode setting write parameter out of range. |
| 935 | Command Error | TPS99000-Q1 ADC configuration setting write parameter out of range. |
| 936 | Command Error | TPS99000-Q1 illumination sync control setting write parameter out of range. |
| 938 | BIST Error | TPS99000-Q1 checksum error in group 1 register set. |
| 939 | BIST Error | TPS99000-Q1 checksum error in group 2 register set. |
| 940 | BIST Error | TPS99000-Q1 checksum error in group 3 register set. |
| 941 | BIST Error | Either no ACK was received from DMD after sending requested transfer for DMD low-speed interface validation or a DMD register compare error was detected. |
| 942 - 945 | Internal Error | Internal system error. Contact TI for more information. |
| 946 | Source Error | Expected VSYNC signal did not arrive in the time allocated. |
| 947-948 | Internal Error | Internal system error. Contact TI for more information. |
| 949 | BIST Error | DMD VRESET voltage reading is out of range. |
| 950 | BIST Error | DMD VOFFSET voltage reading is out of range. |
| 951 | BIST Error | DMD VBIAS voltage reading is out of range. |
| 952 | ADC Error | Sequence aborted so the ADC measurement data could not be read. |
| 953 | Source Error | The flash data defining the source to be displayed when the external source is lost contains invalid settings (test pattern, splash, system mode, or VSYNC frequency). |
| 954 | BIST Error | Multi-bit ECC memory error detected. |
| 955 | BIST Error | Single-bit ECC memory error detected. |
| 956 - 960 | Internal Error | Internal system error. Contact TI for more information. |
| 961 | BIST Error | Sequence clock ratio is not within the specified limits. |
| 962 - 966 | Internal Error | Internal system error. Contact TI for more information. |
| 967 | BIST Error | DMD reset instruction watchdog error. |
| 968 | BIST Error | Sequencer instruction watchdog error. |
| 969 | BIST Error | Frame memory buffer swap watchdog error. |
| 970 - 971 | Internal Error | Internal system error. Contact TI for more information. |
| 972 | BIST Error | Register CRC mismatched. |
| 973 - 974 | Internal Error | Internal system error. Contact TI for more information. |
| 983 - 999 | Internal Error | Internal system error. Contact TI for more information. |

Table A-2. Main Application Error Codes (continued)

| CODE | NAME | DESCRIPTION |
|-------------|-----------------------------|--|
| 1000 | Source Error | Vertical blanking error. Most likely caused by insufficient vertical front porch. |
| 1001 - 1006 | Internal Error | Internal system error. Contact TI for more information. |
| 1007 | BIST Error | DMD low speed interface parity error. |
| 1008 | System Voltage Error | ADC external bandgap voltage out of range. |
| 1009 - 1010 | Internal Error | Internal system error. Contact TI for more information. |
| 1011 | BIST Error | TPS99000-Q1 watchdog 1 did not detect a rising edge within the expected trigger window. |
| 1012 | BIST Error | TPS99000-Q1 watchdog 2 did not detect a rising edge within the expected trigger window. |
| 1013 - 1014 | Internal Error | Internal system error. Contact TI for more information. |
| 1015 | System Voltage Error | Driver power voltage is out of range. |
| 1016 | Internal Error | Internal system error. Contact TI for more information. |
| 1017 - 1022 | Internal Error | Internal system error. Contact TI for more information. |
| 1023 | Internal Error | Splash thread has terminated on an error. |
| 1024 - 1025 | Internal Error | Internal system error. Contact TI for more information. |
| 1026 | Flash Configuration Error | TPS99000-Q1 version does not match value in flash. |
| 1027 - 1067 | Internal Error | Internal system error. Contact TI for more information. |
| 1068 | Command Error | Diagnostic memory interface received an invalid command |
| 1069 | Command Error | Excessive brightness BIST cannot be command because the functionality is set to internal mode in flash |
| 1070 | BIST Error | DAC ADC Loop BIST: Current Control DAC error |
| 1071 | BIST Error | DAC ADC Loop BIST: Photo Feedback DAC error |
| 1072 | BIST Error | DAC ADC Loop BIST: Overbright DAC error |
| 1073 | Internal Error | Internal system error. Contact TI for more information. |
| 1077 - 1078 | Internal Error | Internal system error. Contact TI for more information. |
| 1079 | BIST Error | The provided current limit percentage threshold was not within 0-100. |
| 1080 | BIST Error | Photo feedback BIST failed. |
| 1081 | TPS99000-Q1 Interface Error | TPS99000-Q1 SPI transaction detected a read of swapped bytes. |
| 1082 | Internal Error | Internal system error. Contact TI for more information. |
| 2011 - 2043 | Internal Error | Internal system error. Contact TI for more information. |

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